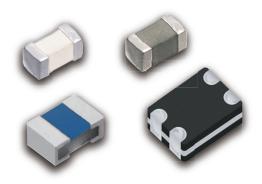


# Products Catalog

# **EMC/ESD Components**

- Common mode Noise Filters
- ESD Suppressor
- Multilayer Varistor



# IN Your Future





# EMC components / ESD components contents INDEX

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# Guidelines and precautions regarding the technical information and use of our products described in this online catalog.

- If you want to use our products described in this online catalog for applications requiring special qualities or reliability, or for applications where the failure or malfunction of the products may directly jeopardize human life or potentially cause personal injury (e.g. aircraft and aerospace equipment, traffic and transportation equipment, combustion equipment, medical equipment, accident prevention, anti-crime equipment, and/or safety equipment), it is necessary to verify whether the specifications of our products fit to such applications. Please ensure that you will ask and check with our inquiry desk as to whether the specifications of our products fit to such applications use before you use our products.
- The quality and performance of our products as described in this online catalog only apply to our products when used in isolation. Therefore, please ensure you evaluate and verify our products under the specific circumstances in which our products are assembled in your own products and in which our products will actually be used.
- If you use our products in equipment that requires a high degree of reliability, regardless of the application, it is recommended that you set up protection circuits and redundancy circuits in order to ensure safety of your equipment.
- The products and product specifications described in this online catalog are subject to change for improvement without prior notice. Therefore, please be sure to request and confirm the latest product specifications which explain the specifications of our products in detail, before you finalize the design of your applications, purchase, or use our products.
- The technical information in this online catalog provides examples of our products' typical operations and application circuits. We do not guarantee the non-infringement of third party's intellectual property rights and we do not grant any license, right, or interest in our intellectual property.
- If any of our products, product specifications and/or technical information in this online catalog is to be exported or provided to non-residents, the laws and regulations of the exporting country, especially with regard to security and export control, shall be observed.

# <Regarding the Certificate of Compliance with the EU RoHS Directive/REACH Regulations>

- The switchover date for compliance with the RoHS Directive/REACH Regulations varies depending on the part number or series of our products.
- When you use the inventory of our products for which it is unclear whether those products are compliant with the RoHS Directive/REACH Regulation, please select "Sales Inquiry" in the website inquiry form and contact us.

We do not take any responsibility for the use of our products outside the scope of the specifications, descriptions, guidelines and precautions described in this online catalog.



# Application Guidelines

(Common Mode Noise Filters/Array,

Common Mode Noise Filters/Array with ESD Suppressor, 2 Mode Noise Filters)

#### Safety precautions

- When using our products, no matter what sort of equipment they might be used for, be sure to make a written agreement on the specifications with us in advance. The design and specifications in this catalog are subject to change without prior notice.
- Do not use the products beyond the specifications described in this catalog.
- This catalog explains the quality and performance of the products as individual components. Before use, check and evaluate their operations when installed in your products under the actual conditions for use.
- Install the following systems for a failsafe design to ensure safety if these products are to be used in equipment
  where a defect in these products may cause the loss of human life or other significant damage, such as
  damage to vehicles (automobile, train, vessel), traffic lights, medical equipment, aerospace equipment,
  electric heating appliances, combustion/gas equipment, rotating equipment, and disaster/crime prevention
  equipment.
  - \* Systems equipped with a protection circuit and a protection device.
  - \* Systems equipped with a redundant circuit or other system to prevent an unsafe status in the event of a single fault.
  - \* Systems equipped with an arresting the spread of fire or preventing glitch.

#### Precautions for use

- These products are designed and manufactured for general and standard use in general electronic equipment. (e.g. AV equipment, home electric appliances, office equipment, information and communication equipment) For applications in which special quality and reliability are required, or if the failure or malfunction of the products may directly jeopardize life or cause threat of personal injury (such as for aircraft and aerospace equipment, traffic and transport equipment, combustion equipment, medical equipment, accident prevention and anti-theft devices, and safety equipment), please be sure to consult with our sales representative in advance and to exchange product specifications which conform to such applications.
- These products are not intended for use in the following special conditions. Before using the products, carefully check the effects on their quality and performance, and determine whether or not they can be used.
  - 1. In liquid, such as water, oil, chemicals, or organic solvent.
  - 2. In direct sunlight, outdoors, or in dust.
  - 3. In salty air or air with a high concentration of corrosive gas, such as Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, or NO<sub>x</sub>.
  - 4. Electric Static Discharge (ESD) Environment.
    - These components are sensitive to static electricity and can be damaged under static shock (ESD). Please take measures to avoid any of these environments.
    - Smaller components are more sensitive to ESD environment.
  - 5. Electromagnetic and Radioactive Environment.
    - Avoid any environment where strong electromagnetic waves and radiation exist.
  - 6. In an environment where these products cause dew condensation.
  - 7. Sealing or coating of these products or a printed circuit board on which these products are mounted, with resin or other materials.
- These products generate Joule heat when energized. Carefully position these products so that their heat will not affect the other components.
- Carefully position these products so that their temperatures will not exceed the category temperature range due to the effects of neighboring heat-generating components. Do not mount or place heat-generating components or inflammables, such as vinyl-coated wires, near these products.
- Note that non-cleaning solder, halogen-based highly active flux, or water-soluble flux may deteriorate the performance or reliability of the products.
- Carefully select a flux cleaning agent for use after soldering. An unsuitable agent may deteriorate the performance or reliability. In particular, when using water or a water-soluble cleaning agent, be careful not to leave water residues. Otherwise, the insulation performance may be deteriorated.
- Do not apply flux to these products after soldering. The activity of flux may be a cause of failures in these products.
- Refer to the recommended soldering conditions and set the soldering condition. High peak temperature or long heating time may impair the performance or the reliability of these products.



- Recommended soldering condition is for the guideline for ensuring the basic characteristics of the products, not for the stable soldering conditions. Conditions for proper soldering should be set up according to individual conditions.
- Do not reuse any products after removal from mounting boards.
- Do not drop these products. If these products are dropped, do not use them. Such products may have received mechanical or electrical damage.
- If any doubt or concern to the safety on these products arise, make sure to inform us immediately and conduct technical examinations at your side.

#### **Precautions for storage**

The performance of these products, including the solderability, is guaranteed for a year from the date of arrival at your company, provided that they remain packed as they were when delivered and stored at a temperature of -5 °C to +40 °C and a relative humidity of 15 % to 75 %.

Even within the above guarantee periods, do not store these products in the following conditions. Otherwise, their electrical performance and/or solderability may be deteriorated, and the packaging materials (e.g. taping materials) may be deformed or deteriorated, resulting in mounting failures.

- 1. In salty air or in air with a high concentration of corrosive gas, such as Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, or NO<sub>X</sub>.
- 2. In direct sunlight.

<Package markings>

Package markings include the product number, quantity, and country of origin.

In principle, the country of origin should be indicated in English.

#### **Precaution specific to this product**

- 1. Use rosin-based flux or halogen-free flux.
- 2. For cleaning, use an alcohol-based cleaning agent. Before using any other type, consult with our sales person in advance.
- 3. Mounting of the suppressors with excessive or insufficient wetting amount of solder may affect the connection reliability or the performance of the suppressors. Carefully check the effects and apply a proper amount of solder for use
- 4. Do not apply shock to Filters or pinch them with a hard tool (e.g. pliers and tweezers). Otherwise, their bodies may be chipped, affecting their performance. Excessive mechanical stress may damage the filters. Handle with care.
- 7. Avoid excessive bending of printed circuit boards in order to protect the suppressors from abnormal stress.
- 8. Do not immerse the suppressors in solvent for a long time. Before using solvent, carefully check the effects of immersion.
- 9. Do not apply excessive tension to the terminals.

# **Panasonic**

**INDUSTRY** 

#### **Common Mode Noise Filters**

# EXCX4CZ type



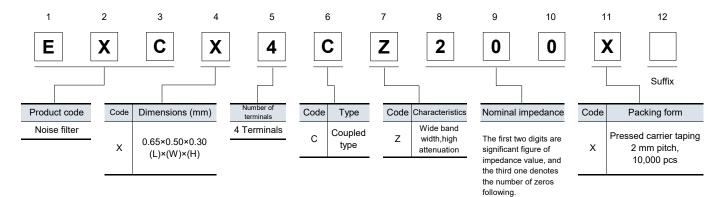
#### **Features**

- Small and thin (L 0.65 mm×W 0.50 mm×H 0.30 mm)
- High-common mode attenuation at 2.4GHz, Suitable for noise suppression at Wi-Fi band
- Strong multilayer/sintered structure, excellent reflow resistance and high mounting reliability
- Lead, halogen and antimony-free
- RoHS compliant

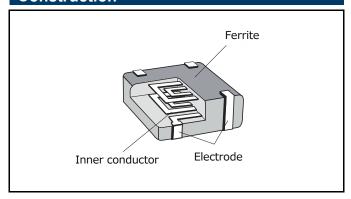
#### **Recommended applications**

- Smartphones, Tablet PCs and DSC
- Suppresses noise radiation to Wi-Fi Equipment

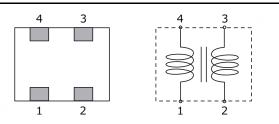
# **Explanation of part numbers**



#### Construction

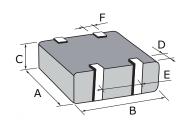


# Circuit configuration (No polarity)



X The pin numbers shown here are for reference purposes only. Confirm the actual pin number arrangement with the exchanged specification documents.

#### **Dimensions in mm (not to scale)**



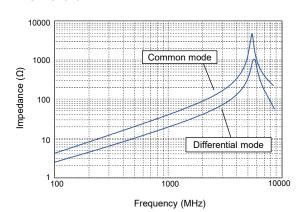
| Part No.       |                 | Dimensions      |                 |                 |                 |                 |           |
|----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------|
| (inch size)    | A               | A B C D E F     |                 |                 |                 |                 | (mg/ pc.) |
| EXCX4CZ (0202) | $0.50 \pm 0.05$ | $0.65 \pm 0.05$ | $0.30 \pm 0.05$ | $0.12 \pm 0.10$ | $0.40 \pm 0.10$ | $0.15 \pm 0.10$ | 0.28      |

| Part number | Impedance (Ω) at 100 MHz  Common mode | Rated voltage<br>(V) DC | Rated current<br>(mA) DC | DC resistance<br>(Ω) max. |
|-------------|---------------------------------------|-------------------------|--------------------------|---------------------------|
| EXCX4CZ040X | 4 Ω ± 2 Ω                             | 5                       | 100                      | 1.0 ± 30 %                |
| EXCX4CZ090X | 9 Ω ± 3 Ω                             | 5                       | 100                      | 1.9 ± 30 %                |
| EXCX4CZ200X | 20 Ω ± 30 %                           | 5                       | 100                      | 3.0 ± 30 %                |

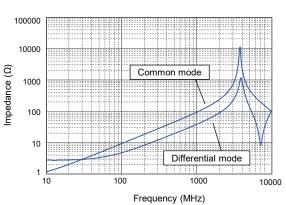
● Category temperature range -40 °C to +85 °C

# Impedance characteristics (Typical)

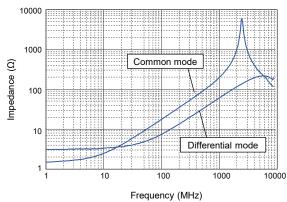




#### ● EXCX4CZ090X



#### • EXCX4CZ200X

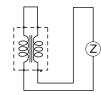


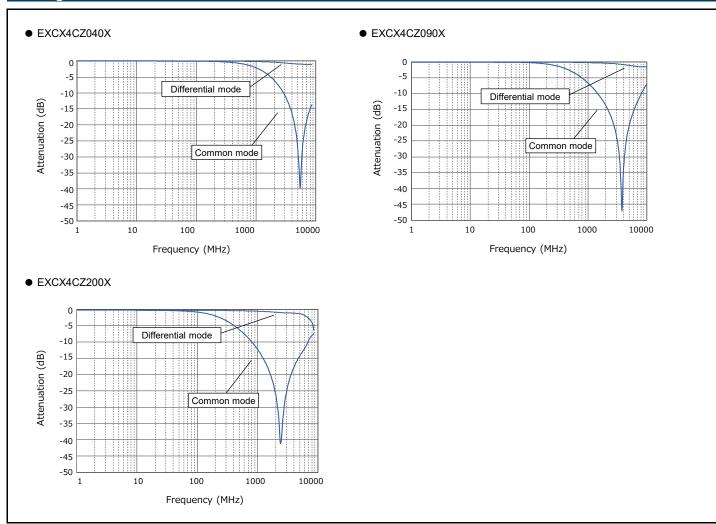
- -/.0/1.02200/1

Measurement circuit



(B) Differential mode







# **EXCX4CH** type



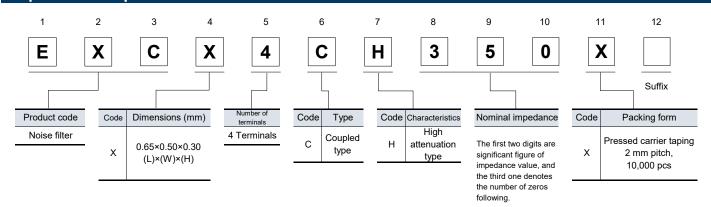
#### **Features**

- Small and thin (L 0.65 mm×W 0.50 mm×H 0.30 mm)
- High common mode attenuation in high-speed differential transmission lines, Cut-off frequency is more than 8.5 GHz, and an influence to differential transmission signal quality is little
- Strong multilayer/sintered structure, excellent reflow resistance and high mounting reliability
- Lead, halogen and antimony-free
- RoHS compliant

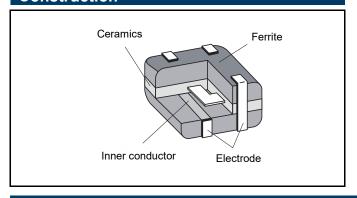
#### **Recommended applications**

- Smartphones, Tablet PCs and DSC
- Noise suppression of high-speed differential data lines such as USB, LVDS and HDMI

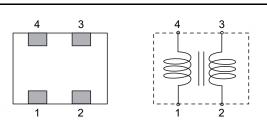
#### **Explanation of part numbers**



#### Construction

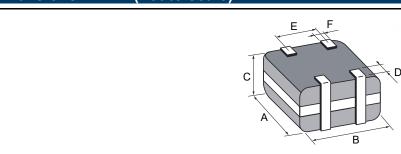


# Circuit configuration (No polarity)



※ The pin numbers shown here are for reference purposes only. Confirm the actual pin number arrangement with the exchanged specification documents.

#### **Dimensions in mm (not to scale)**

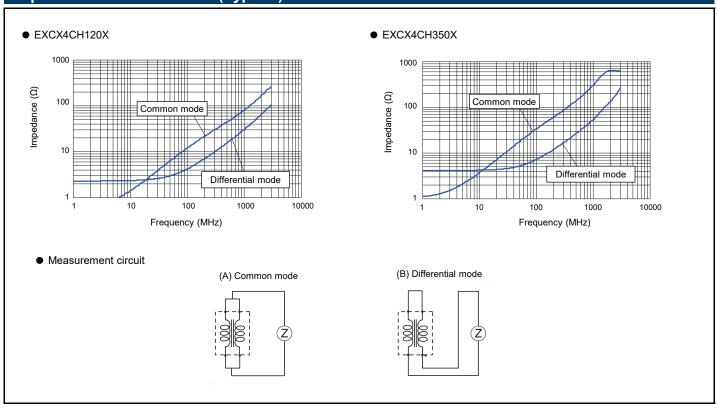


| Part No.       | Dimensions |             |           |           |           |           | Mass (Weight) |
|----------------|------------|-------------|-----------|-----------|-----------|-----------|---------------|
| (inch size)    | Α          | A B C D E F |           |           |           |           |               |
| EXCX4CH (0202) | 0.50±0.05  | 0.65±0.05   | 0.30±0.05 | 0.12±0.10 | 0.40±0.10 | 0.15±0.10 | 0.43          |

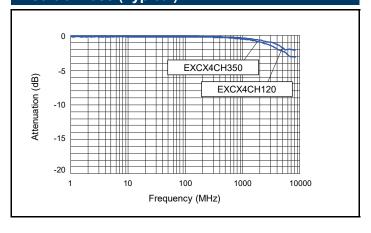
| Ratings        |                          |               |               |               |  |  |  |
|----------------|--------------------------|---------------|---------------|---------------|--|--|--|
| Part number    | Impedance (Ω) at 100 MHz | Rated voltage | Rated current | DC resistance |  |  |  |
| rait liullibei | Common mode              | (V) DC        | (mA) DC       | (Ω) max.      |  |  |  |
| EXCX4CH120X    | 12 Ω±5 Ω                 | 5             | 100           | 2.0           |  |  |  |
| EXCX4CH350X    | 35 Ω±30 %                | 5             | 100           | 2.7           |  |  |  |

Category temperature range −40 °C to +85 °C

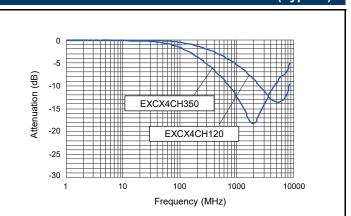
#### Impedance characteristics (Typical)



#### **Insertion loss (Typical)**



#### **Common mode attenuation characteristics (Typical)**





# **EXCX4CE** type



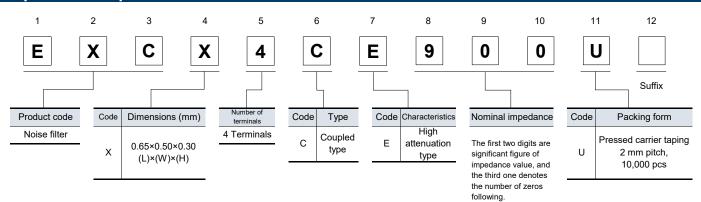
#### **Features**

- Small and thin (L 0.65 mm×W 0.50 mm×H 0.30 mm)
- Noise suppression of high-speed differential transmission lines with little influence of waveform rounding on signal transmission
- Strong multilayer/sintered structure, excellent reflow resistance and high mounting reliability
- Lead, halogen and antimony-free
- RoHS compliant

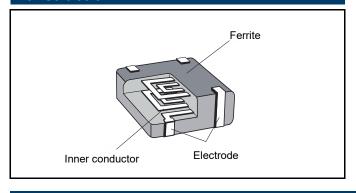
#### **Recommended applications**

- Smartphones, Tablet PCs and DSC
- Noise suppression of high-speed differential data lines such as MIPI, USB and LVDS

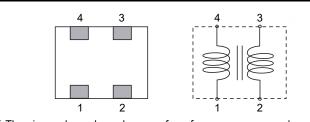
#### **Explanation of part numbers**



#### Construction

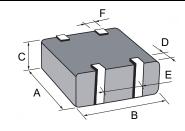


#### Circuit configuration (No polarity)



※ The pin numbers shown here are for reference purposes only. Confirm the actual pin number arrangement with the exchanged specification documents.

#### **Dimensions in mm (not to scale)**

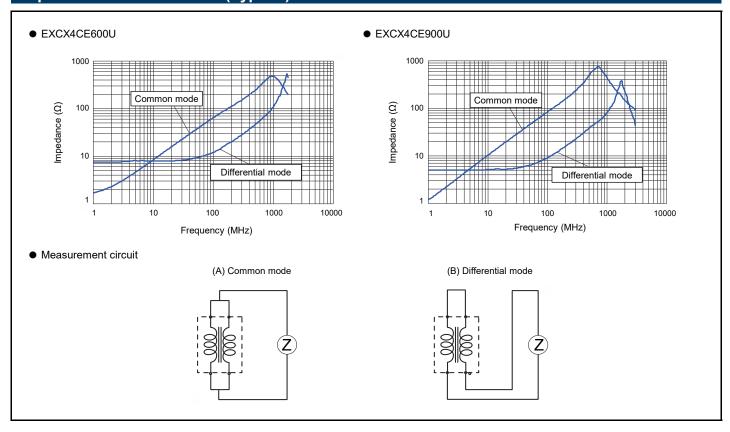


| Part No.       |             | Dimensions  |                 |             |             |             |      |
|----------------|-------------|-------------|-----------------|-------------|-------------|-------------|------|
| (inch size)    | А           | A B C D E F |                 |             |             |             |      |
| EXCX4CE (0202) | 0.50 ± 0.05 | 0.65 ± 0.05 | $0.30 \pm 0.05$ | 0.12 ± 0.10 | 0.40 ± 0.10 | 0.15 ± 0.10 | 0.56 |

| Part number | Impedance (Ω) at 100 MHz |                   | Rated voltage | Rated current | DC resistance |
|-------------|--------------------------|-------------------|---------------|---------------|---------------|
|             | Common mode              | Differential mode | (V) DC        | (mA) DC       | (Ω) max.      |
| EXCX4CE600U | 60 Ω ± 20 %              | 18 Ω max.         | 5             | 100           | 2.4 ± 30 %    |
| EXCX4CE900U | 90 Ω ± 20 %              | 20 Ω max.         | 5             | 100           | 3.0 ± 30 %    |

● Category temperature range -40 °C to +85 °C

# Impedance characteristics (Typical)



# **EXCX4CT** type



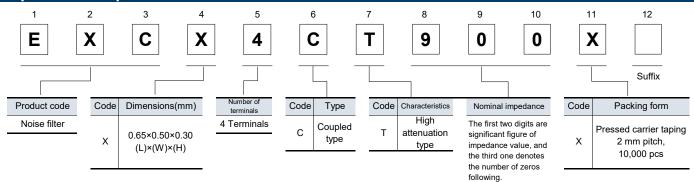
#### **Features**

- Small and thin (L 0.65 mm×W 0.50 mm×H 0.30 mm)
- High attenuation at common-mode for noise suppression of harmonic signal components and cellular frequency
- Cut-off frequency is more than 3 GHz, the insertion loss is low in differential transmission line
- Strong multilayer/sintered structure, excellent reflow resistance and high mounting reliability
- RoHS compliant

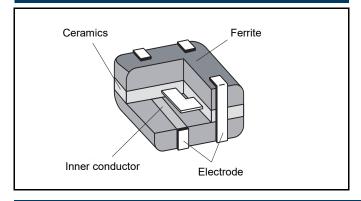
#### **Recommended applications**

- Smartphones, Tablet PCs and DSC
- Noise suppression of high-speed differential data lines such as MIPI, USB and LVDS

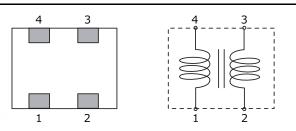
#### **Explanation of part numbers**



#### Construction

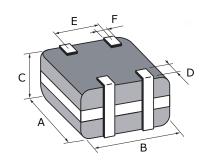


# Circuit configuration (No polarity)



※ The pin numbers shown here are for reference purposes only. Confirm the actual pin number arrangement with the exchanged specification documents.

#### **Dimensions in mm (not to scale)**

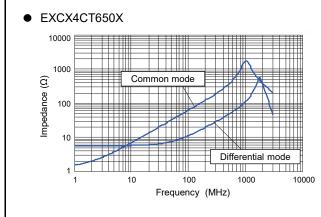


| Part No.       |             | Dimensions  |             |             |             |             |           |
|----------------|-------------|-------------|-------------|-------------|-------------|-------------|-----------|
| (inch size)    | Α           | B C D E F   |             |             |             |             | (mg/ pc.) |
| EXCX4CT (0202) | 0.50 ± 0.05 | 0.65 ± 0.05 | 0.30 ± 0.05 | 0.12 ± 0.10 | 0.40 ± 0.10 | 0.15 ± 0.10 | 0.43      |

| Part number | Impedance (Ω) at 100 MHz Common mode | Rated voltage<br>(V) DC | Rated current<br>(mA) DC | DC resistance<br>(Ω) max. |
|-------------|--------------------------------------|-------------------------|--------------------------|---------------------------|
| EXCX4CT650X | 65 Ω ± 20 %                          | 10                      | 100                      | 2.7 Ω ± 30 %              |
| EXCX4CT900X | 90 Ω ± 20 %                          | 10                      | 100                      | 3.0 Ω ± 30 %              |

Category temperature range −40 °C to +85 °C

#### Impedance characteristics (Typical)



EXCX4CT900X 10000 1000 Common mode Impedance (Ω) 100 10

100

Frequency (MHz)

Differential mode

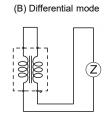
1000

10000

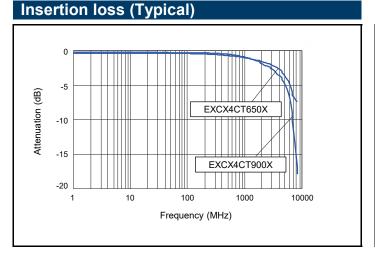
Measurement circuit

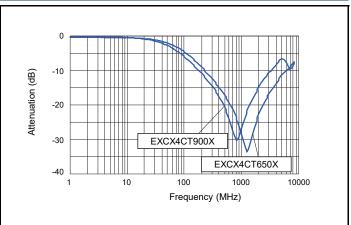






#### **Common mode attenuation characteristics (Typical)**







# EXC14CH type



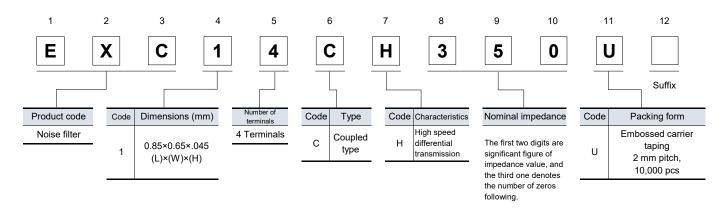
#### **Features**

- Small and thin (L 0.85 mm×W 0.65 mm×H 0.45 mm)
- High common mode attenuation in high-speed differential transmission lines, Cut-off frequency is more than 8.5 GHz, and an influence to differential transmission signal quality is little
- Strong multilayer/sintered structure, excellent reflow resistance and high mounting reliability
- RoHS compliant

#### **Recommended applications**

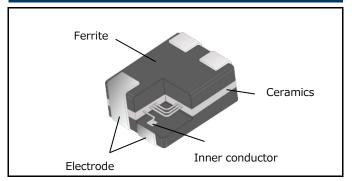
- Smartphones, Tablet PCs and DSC
- Noise suppression of high-speed differential data lines such as USB, LVDS and HDMI

#### **Explanation of part numbers**

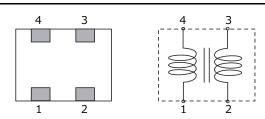


#### Construction

EXC14CH (0302)



#### Circuit configuration (No polarity)



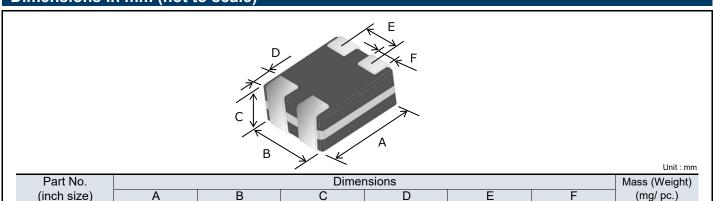
X The pin numbers shown here are for reference purposes only. Confirm the actual pin number arrangement with the exchanged specification documents.

 $0.50 \pm 0.10$ 

 $0.27 \pm 0.10$ 

#### **Dimensions in mm (not to scale)**

 $0.65 \pm 0.05$ 



 $0.85 \pm 0.05$ 

 $0.45 \pm 0.05$ 

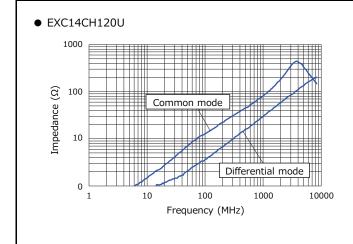
1.0

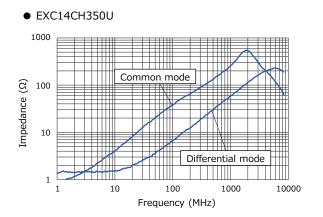
0.10 min.

| Ratings        |                          |                   |               |               |               |  |  |
|----------------|--------------------------|-------------------|---------------|---------------|---------------|--|--|
| Part number    | Impedance (Ω) at 100 MHz |                   | Rated voltage | Rated current | DC resistance |  |  |
| rait ilullibei | Common mode              | Differential mode | (V) DC        | (mA) DC       | (Ω) max.      |  |  |
| EXC14CH120U    | 12 Ω ± 25 %              | 10 Ω max.         | 5             | 100           | 1.0           |  |  |
| EXC14CH350U    | 35 Ω ± 30 %              | 15 Ω max.         | 5             | 100           | 1.5           |  |  |

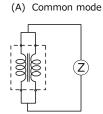
● Category temperature range -40 °C to +85 °C

#### Impedance characteristics (Typical)

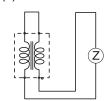




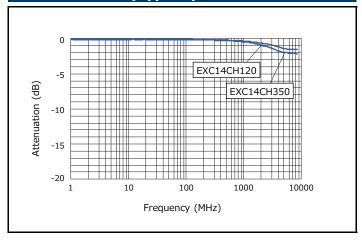
Measurement circuit



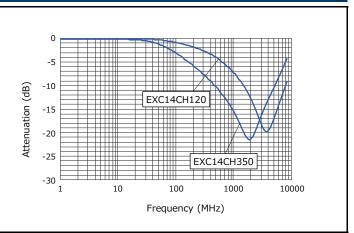
(B) Differential mode



# **Insertion loss (Typical)**



#### **Common mode attenuation characteristics (Typical)**





# EXC14CG/CE type



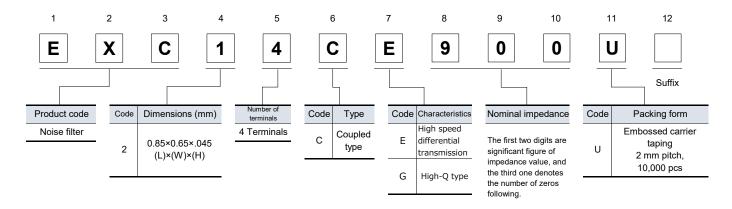
#### **Features**

- Small and thin (L 0.85 mm×W 0.65 mm×H 0.45 mm)
- Noise suppression of high-speed differential transmission lines with little influence of waveform rounding on signal transmission
- Low DC resistance and low insertion loss
- High-Q value and high impedance of GHz zone : EXC14CG type
- Strong multilayer/sintered structure, excellent reflow resistance and high mounting reliability
- RoHS compliant

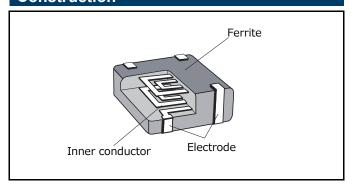
#### **Recommended applications**

- Smartphones, Tablet PCs and DSC
- Noise suppression of high-speed differential data lines such as USB, LVDS and MHL

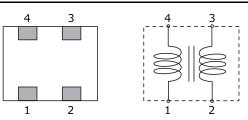
#### **Explanation of part numbers**



#### Construction

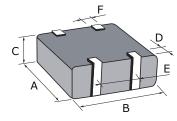


# Circuit configuration (No polarity)



X The pin numbers shown here are for reference purposes only. Confirm the actual pin number arrangement with the exchanged specification documents.

#### **Dimensions in mm (not to scale)**

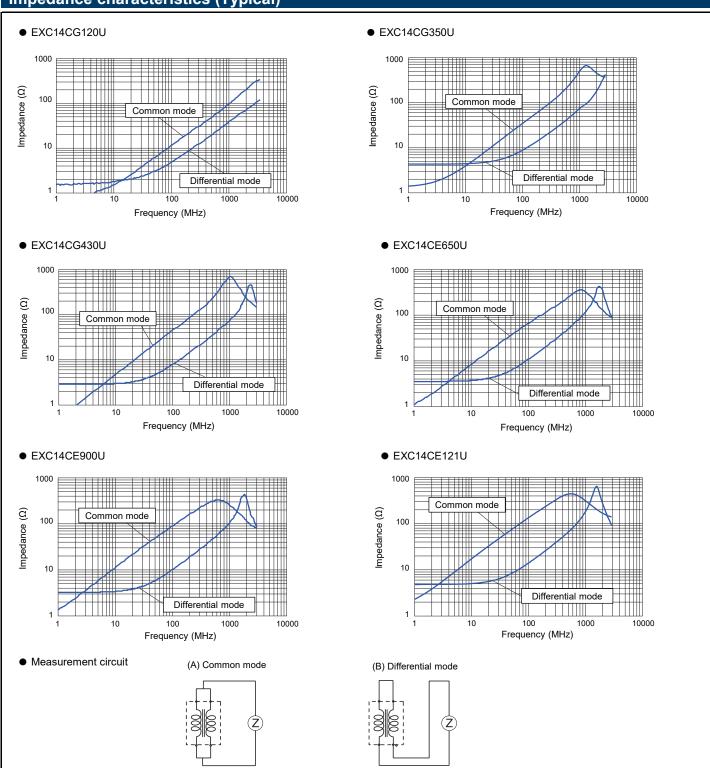


| Part No.      |             | Dimensions  |             |              |             |             |           |
|---------------|-------------|-------------|-------------|--------------|-------------|-------------|-----------|
| (inch size)   | Α           | В           | С           | D            | Е           | F           | (mg/ pc.) |
| EXC14CG(0302) | 0.65 ± 0.05 | 0.85 ± 0.05 | 0.45 ± 0.05 | 0.10 min.    | 0.50 ± 0.10 | 0.27 ± 0.10 | 1.4       |
| EXC14CE(0302) | 0.00 ± 0.00 | 0.00 ± 0.00 | 0.10 ± 0.00 | 0.10 111111. | 0.00 ± 0.10 | 0.27 ± 0.10 | 1         |

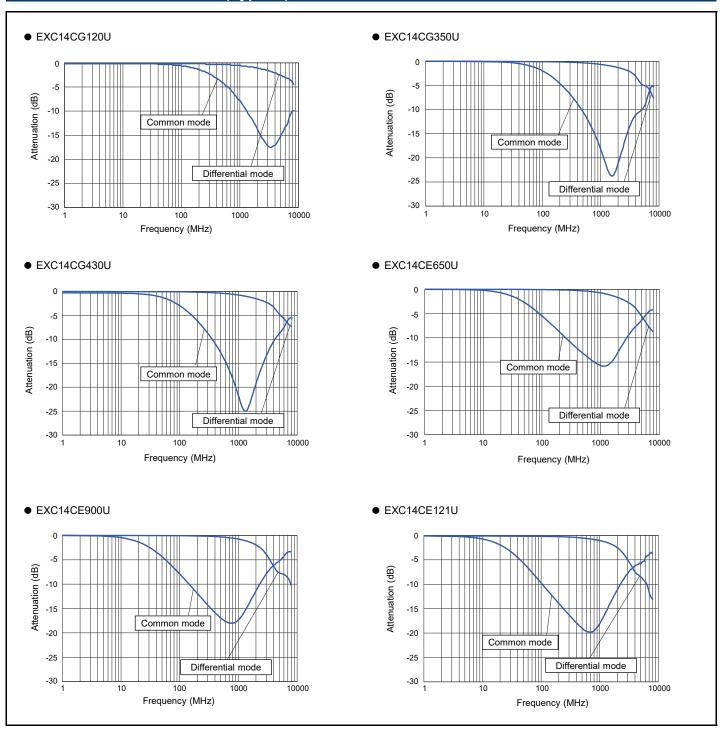
| Ratings        |              |                          |        |               |               |
|----------------|--------------|--------------------------|--------|---------------|---------------|
| Part number    | Impedance (9 | Impedance (Ω) at 100 MHz |        | Rated current | DC resistance |
| rait ilullibei | Common mode  | Differential mode        | (V) DC | (mA) DC       | (Ω) max.      |
| EXC14CG120U    | 12 Ω ± 30 %  | 10 Ω max.                | 5      | 130           | 2.0           |
| EXC14CG350U    | 35 Ω ± 30 %  | 15 Ω max.                | 5      | 100           | 2.0           |
| EXC14CG430U    | 43 Ω ± 25 %  | 15 Ω max.                | 5      | 100           | 2.7           |
| EXC14CE650U    | 65 Ω ± 20 %  | 20 Ω max.                | 5      | 130           | 2.5           |
| EXC14CE900U    | 90 Ω ± 20 %  | 20 Ω max.                | 5      | 130           | 2.5           |
| EXC14CE121U    | 120 Ω ± 20 % | 20 Ω max.                | 5      | 100           | 3.8           |

● Category temperature range -40 °C to +85 °C

#### Impedance characteristics (Typical)



# **Attenuation characteristics (Typical)**



■ As for packaging methods, soldering conditions and safety precautions, please see data files



# **EXC14CT** type



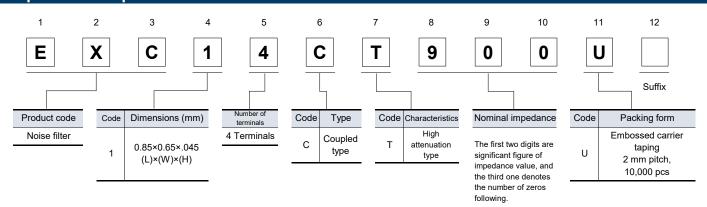
#### **Features**

- Small and thin (L 0.85 mm×W 0.65 mm×H 0.45 mm)
- High attenuation at common-mode for noise suppression of harmonic signal components and cellular frequency
- High cut-off frequency and capability of coping with high-speed signals (USB and HDMI)
- Strong multilayer/sintered structure, excellent reflow resistance and high mounting reliability
- RoHS compliant

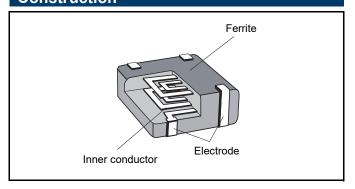
#### **Recommended applications**

- Smartphones, Tablet PCs and DSC
- Noise suppression of high-speed differential data lines such as MIPI, USB and LVDS

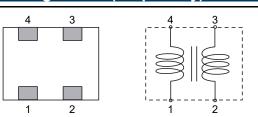
#### **Explanation of part numbers**



#### Construction

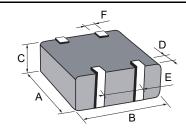


#### **Circuit configuration (No polarity)**



※ The pin numbers shown here are for reference purposes only. Confirm the actual pin number arrangement with the exchanged specification documents.

#### **Dimensions in mm (not to scale)**

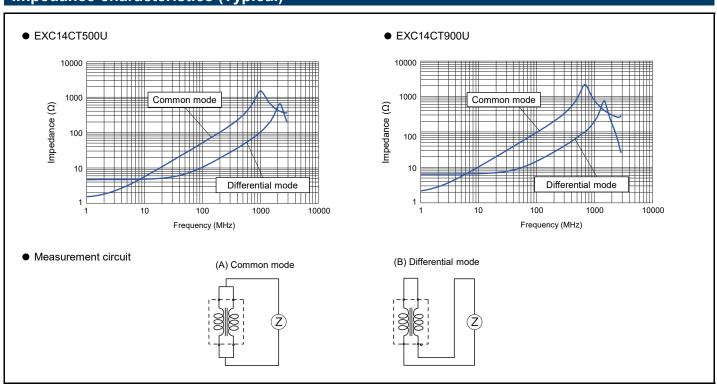


| Part No.       | Dimensions  |             |             |           |             |             |           |
|----------------|-------------|-------------|-------------|-----------|-------------|-------------|-----------|
| (inch size)    | Α           | В           | С           | D         | Е           | F           | (mg/ pc.) |
| EXC14CT (0302) | 0.65 ± 0.05 | 0.85 ± 0.05 | 0.45 ± 0.05 | 0.10 min. | 0.50 ± 0.10 | 0.27 ± 0.10 | 1.0       |

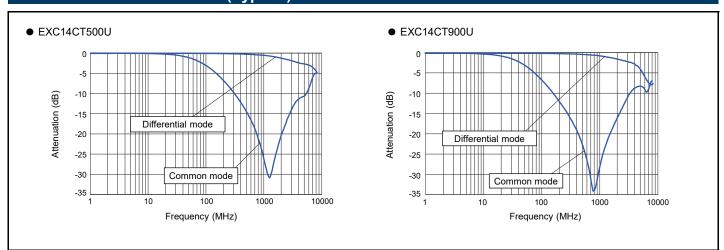
| Part number | Impedance (9 | Ω) at 100 MHz     | Rated voltage | Rated current | DC resistance |
|-------------|--------------|-------------------|---------------|---------------|---------------|
|             | Common mode  | Differential mode | (V) DC        | (mA) DC       | (Ω) max.      |
| EXC14CT500U | 50 Ω ± 25 %  | 17 Ω max.         | 5             | 100           | 2.3 Ω ± 30 %  |
| EXC14CT900U | 90 Ω ± 20 %  | 20 Ω max.         | 5             | 100           | 3.3 Ω ± 30 %  |

Category temperature range −40 °C to +85 °C

#### Impedance characteristics (Typical)



#### **Attenuation characteristics (Typical)**





# EXC14CX type



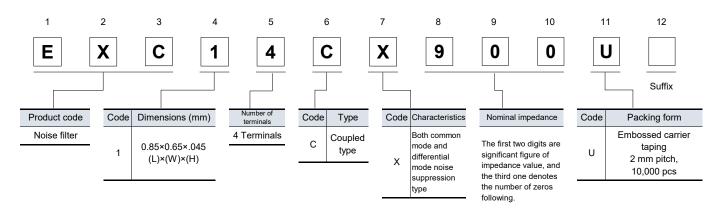
#### **Features**

- Small and thin (L 0.85 mm×W 0.65 mm×H 0.45 mm)
- Effective noise suppression of smartphones by eliminating common mode noises and removing differential signal components
- Strong multilayer/sintered structure, excellent reflow resistance and high mounting reliability
- RoHS compliant

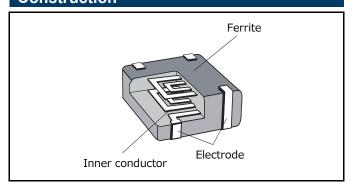
#### **Recommended applications**

- Smartphones, Tablet PCs and DSC
- Noise suppression of high-speed differential data lines such as MIPI, USB and LVDS

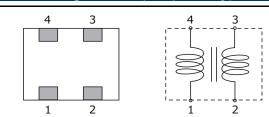
#### **Explanation of part numbers**



#### Construction

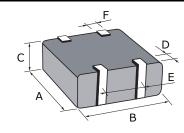


#### **Circuit configuration (No polarity)**



X The pin numbers shown here are for reference purposes only. Confirm the actual pin number arrangement with the exchanged specification documents.

#### **Dimensions in mm (not to scale)**

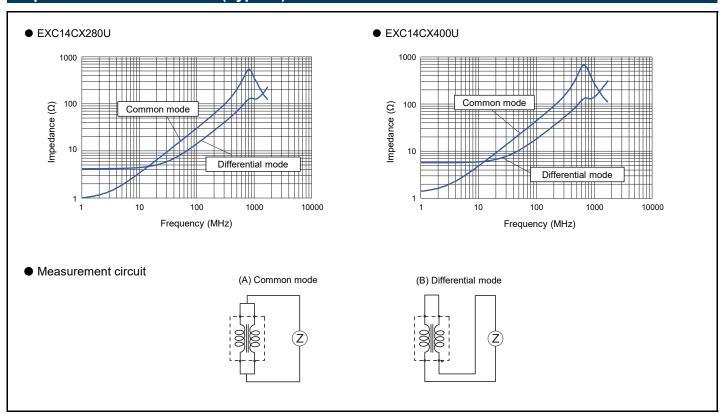


| Part No.       |             | Dimensions  |             |           |             |             |           |
|----------------|-------------|-------------|-------------|-----------|-------------|-------------|-----------|
| (inch size)    | А           | В           | С           | D         | E           | F           | (mg/ pc.) |
| EXC14CX (0302) | 0.65 ± 0.05 | 0.85 ± 0.05 | 0.45 ± 0.05 | 0.10 min. | 0.50 ± 0.10 | 0.27 ± 0.10 | 1.4       |

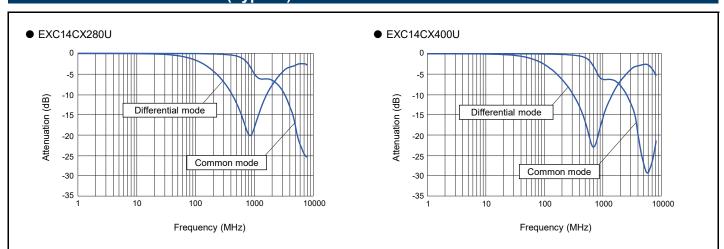
| Part number | Impedance (0 | Ω) at 100 MHz     | Rated voltage | Rated current | DC resistance |
|-------------|--------------|-------------------|---------------|---------------|---------------|
|             | Common mode  | Differential mode | (V) DC        | (mA) DC       | (Ω) max.      |
| EXC14CX280U | 28 Ω ± 25 %  | 25 Ω max.         | 5             | 100           | 3.0           |
| EXC14CX400U | 40 Ω ± 25 %  | 30 Ω max.         | 5             | 100           | 4.0           |

● Category temperature range -40 °C to +85 °C

#### Impedance characteristics (Typical)



# **Attenuation characteristics (Typical)**



# **Panasonic**

**INDUSTRY** 

# **Common Mode Noise Filters**

# **EXC16CT** type



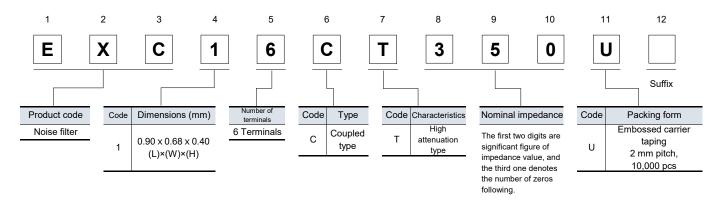
#### **Features**

- Corresponding to new high-speed differential interface (MIPI C-PHY)
   Corresponding to 3-line transmission, transmission rate up to 2.5 Gsps
- Unique plating fine coil process and ceramic multilayer process enable compact size (L 0.90 × W 0.68 × H 0.40 mm) around 40% reduction of mounting area (comparing with MIPI D-PHY)
- Strong multilayer/sintered structure, excellent reflow resistance and high mounting reliability
- Lead, halogen and antimony-free
- RoHS compliant

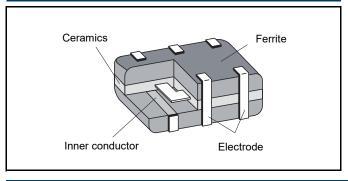
#### **Recommended applications**

- High resolution camera and display equipped mobile devices (Smartphones, Tablet PCs and wearable)
- Noise suppression of high-speed differential data lines such as MIPI C-PHY

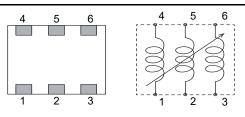
#### **Explanation of part numbers**



#### Construction

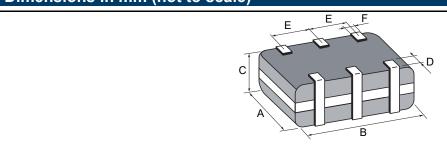


#### Circuit configuration (No polarity)



※ The pin numbers shown here are for reference purposes only. Confirm the actual pin number arrangement with the exchanged specification documents.

#### **Dimensions in mm (not to scale)**



| Part No.       | Dimensions      |                 |                 |               |                 |               |           |
|----------------|-----------------|-----------------|-----------------|---------------|-----------------|---------------|-----------|
| (inch size)    | А               | В               | С               | D             | E               | F             | (mg/ pc.) |
| EXC16CT (0403) | $0.68 \pm 0.05$ | $0.90 \pm 0.05$ | $0.40 \pm 0.05$ | 0.125 ± 0.075 | $0.35 \pm 0.05$ | 0.165 ± 0.065 | 1.1       |

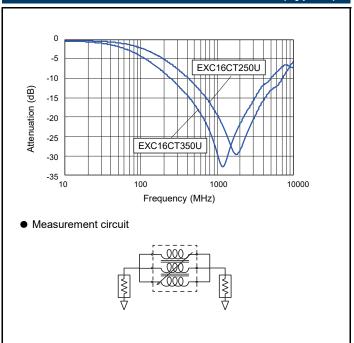
| Part number | Impedance (Ω) at 100 MHz  Common mode | Rated voltage<br>(V) DC | Rated current<br>(mA) DC | DC resistance (Ω) max. |
|-------------|---------------------------------------|-------------------------|--------------------------|------------------------|
| EXC16CT250U | 25 Ω ± 25 %                           | 5                       | 100                      | 3.0                    |
| EXC16CT350U | 35 Ω ± 30 %                           | 5                       | 100                      | 4.0                    |

● Category temperature range -40 °C to +85 °C

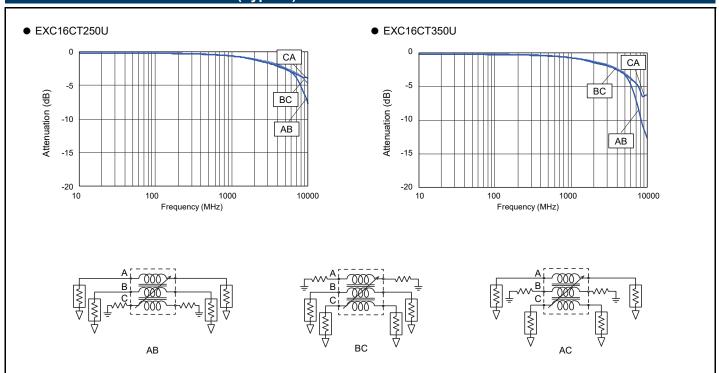
#### **Common mode impedance characteristics (Typical)**

# 10000 EXC16CT350U 100 EXC16CT250U Frequency (MHz) Measurement circuit Common mode Common mode

#### **Common mode attenuation characteristics (Typical)**



#### **Differential mode Insertion loss (Typical)**





# EXC24CK type



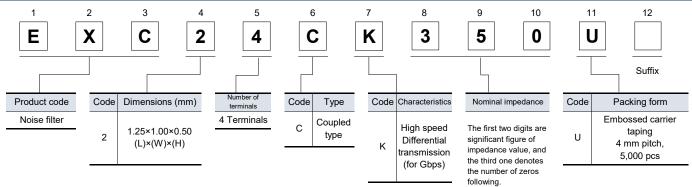
#### **Features**

- Small and thin type, built-in filter circuit (L 1.25 mm×W 1.00 mm×H 0.50 mm)
- Since the cut-off frequency (of the CMNF) is so high, high frequency noise are suppressed without signal integrity degradation.
- Strong multilayer/sintered structure, excellent reflow resistance and high mounting reliability
- RoHS compliant

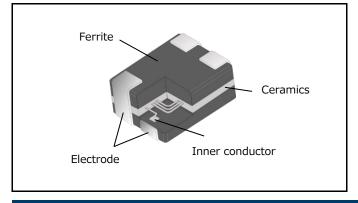
#### **Recommended applications**

- AV equipment (LCD-TV, DVD/Blu-ray drives), Information equipment (PCs, HDD), Communications equipment (Mobile phones, Smartphones)
- Noise suppression for high-speed differential data lines of information devices such as PCs equipped with USB3.2, HDMI, SATA, Display Port, etc.

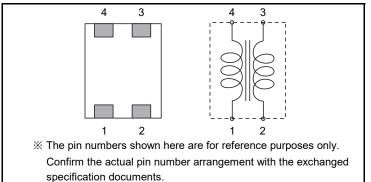




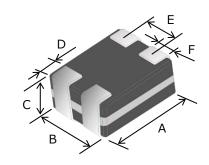
#### Construction



#### **Circuit configuration (No polarity)**



#### **Dimensions in mm (not to scale)**

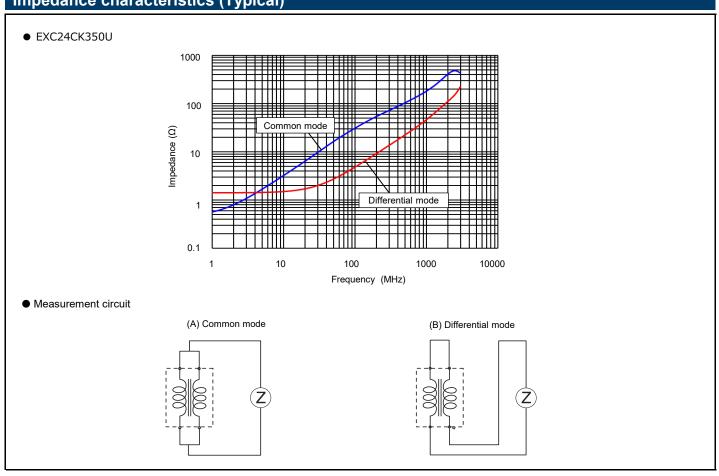


| Part No.       |             | Dimensions  |             |             |             |             |           |  |
|----------------|-------------|-------------|-------------|-------------|-------------|-------------|-----------|--|
| (inch size)    | Α           | В           | С           | D           | E           | F           | (mg/ pc.) |  |
| EXC24CK (0504) | 1.25 ± 0.15 | 1.00 ± 0.15 | 0.50 ± 0.10 | 0.20 ± 0.15 | 0.55 ± 0.10 | 0.30 ± 0.10 | 2.1       |  |

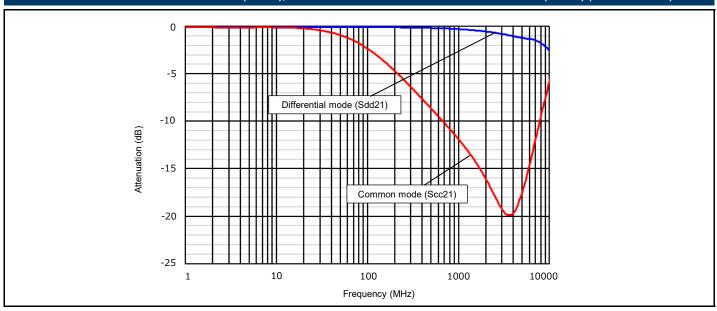
| Ratings     |                          |                   |                     |               |               |               |  |  |  |
|-------------|--------------------------|-------------------|---------------------|---------------|---------------|---------------|--|--|--|
| Part number | Impedance (Ω) at 100 MHz |                   | Cutoff<br>frequency | Rated voltage | Rated current | DC resistance |  |  |  |
|             | Common mode              | Differential mode | (GHz)               | (V) DC        | (mA) DC       | (Ω) max.      |  |  |  |
| EXC24CK350U | 35 Ω ± 30 %              | 13 Ω max.         | 10 Typ.             | 5             | 160           | 1.5           |  |  |  |

Category temperature range −40 °C to +85 °C

#### **Impedance characteristics (Typical)**



#### Common mode attenuation characteristics (Scc21), differential mode insertion loss characteristics (Sdd21) (reference data)





# EXC24CH type



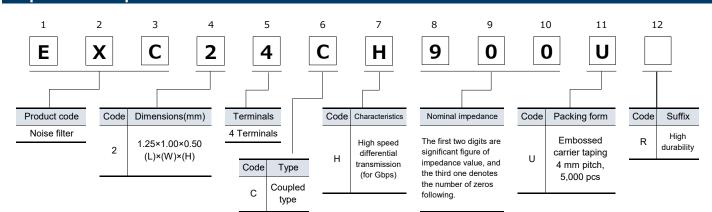
#### **Features**

- Small and thin type, built-in filter circuit(L 1.25 mm×W 1.00 mm×H 0.50 mm)
- Since the cut-off frequency (of the CMNF) is so high, high frequency noise are suppressed without signal integrity degradation.
- Strong multilayer/sintered structure, excellent reflow resistance and high mounting reliability
- RoHS compliant

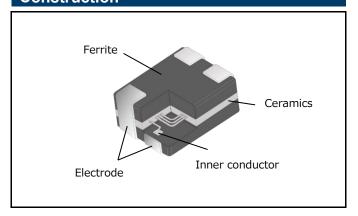
#### **Recommended applications**

- AV equipment (LCD-TV, DVD/Blu-ray drives), Information equipment (PCs, HDD), Communications equipment (Mobile phones, Smartphones)
- Noise suppression of high-speed differential data lines such as USB 3.2, HDMI and Display Port

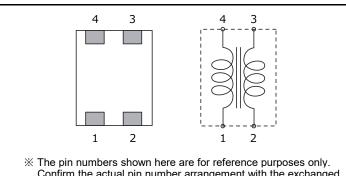
#### **Explanation of part numbers**



#### Construction

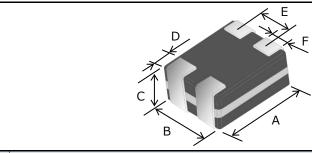


#### **Circuit configuration (No polarity)**



Confirm the actual pin number arrangement with the exchanged specification documents.

#### **Dimensions in mm (not to scale)**

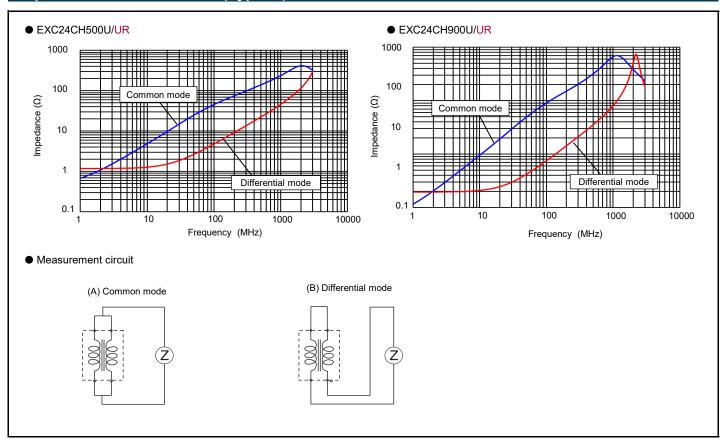


| Part No.       | Dimensions  |             |                 |             |             |                 |           |
|----------------|-------------|-------------|-----------------|-------------|-------------|-----------------|-----------|
| (inch size)    | Α           | В           | С               | D           | E           | F               | (mg/ pc.) |
| EXC24CH (0504) | 1.25 ± 0.15 | 1.00 ± 0.15 | $0.50 \pm 0.10$ | 0.20 ± 0.15 | 0.55 ± 0.10 | $0.30 \pm 0.10$ | 2.4       |

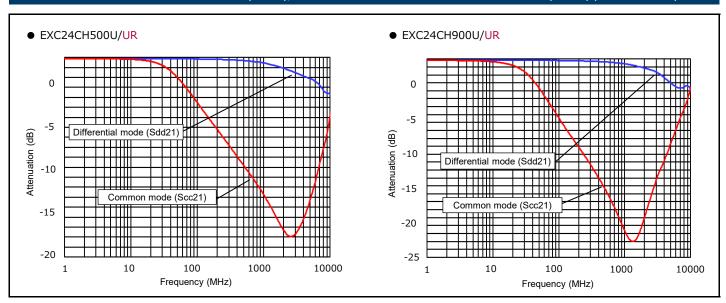
| Part number        | Impedance (0 | Ω) at 100 MHz     | Cutoff<br>frequency | Rated voltage<br>(V) DC | Rated current<br>(mA) DC | DC resistance (Ω) max. |
|--------------------|--------------|-------------------|---------------------|-------------------------|--------------------------|------------------------|
|                    | Common mode  | Differential mode | (GHz)               |                         |                          |                        |
| EXC24CH500U/UR     | 50 Ω ± 25 %  | 13 Ω max.         | 8 Тур.              | 5                       | 160                      | 1.5                    |
| NEW EXC24CH900U/UR | 90 Ω ± 20 %  | 15 Ω max.         | 5 Typ.              | 5                       | 130                      | 2.5                    |

● Category temperature range -40 °C to +85 °C

#### Impedance characteristics (Typical)



#### Common mode attenuation characteristics (Scc21), differential mode insertion loss characteristics (Sdd21) (reference data)



**INDUSTRY** 

#### **Common Mode Noise Filters**

# EXC24CG type



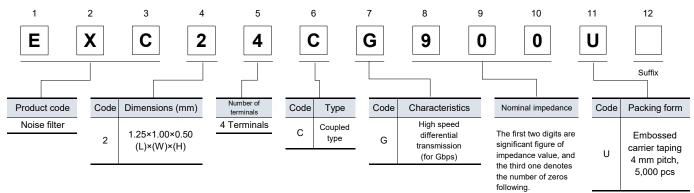
#### **Features**

- Elimination of radiation noises from high-speed differential transmissions
- ullet Prevention of reflection of transmission signals and noise radiation by controlling TDR characteristic impedance as 100  $\Omega$
- Satisfaction of eye pattern standards of HDMI waveforms with capability to improve waveform fluctuations of skew and overshoot
- Simple multilayer structure, excellent mass productivity and high reliability
- Small and thin (L 1.25 mm×W 1.00 mm×H 0.50 mm)
- RoHS compliant

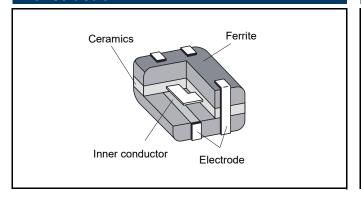
#### **Recommended applications**

- AV equipment (LCD-TV, DVD/Blu-ray drives), Information equipment (PCs, HDD), Communications equipment (Mobile phones, Smartphones)
- Noise suppression of high-speed differential data lines such as HDMI, SATA and LAN

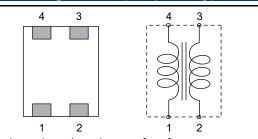
#### **Explanation of part numbers**



#### Construction

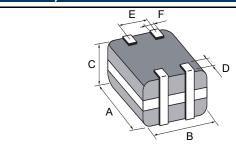


#### Circuit configuration (No polarity)



X The pin numbers shown here are for reference purposes only. Confirm the actual pin number arrangement with the exchanged specification documents.

#### **Dimensions in mm (not to scale)**

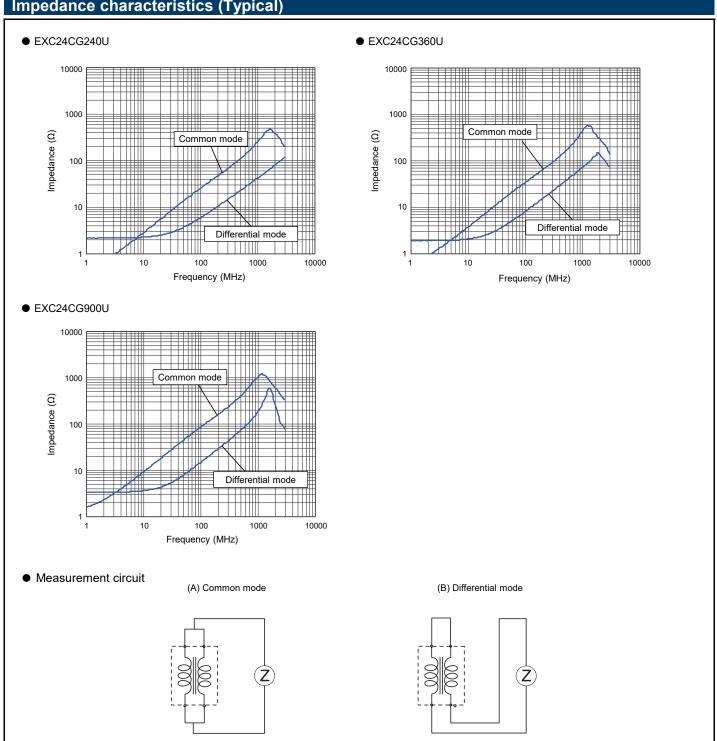


| Part No.       | Dimensions  |             |                 |             |             |                 | Mass (Weight) |
|----------------|-------------|-------------|-----------------|-------------|-------------|-----------------|---------------|
| (inch size)    | Α           | В           | С               | D           | E           | F               | (mg/ pc.)     |
| EXC24CG (0504) | 1.25 ± 0.15 | 1.00 ± 0.15 | $0.50 \pm 0.10$ | 0.20 ± 0.15 | 0.55 ± 0.10 | $0.30 \pm 0.10$ | 3.0           |

| Part number | Impedance (9 | Ω) at 100 MHz     | Rated voltage | Rated current | DC resistance |
|-------------|--------------|-------------------|---------------|---------------|---------------|
|             | Common mode  | Differential mode | (V) DC        | (mA) DC       | (Ω) max.      |
| EXC24CG240U | 24 Ω ± 25 %  | 15 Ω max.         | 5             | 160           | 1.5           |
| EXC24CG360U | 36 Ω ± 25 %  | 15 Ω max.         | 5             | 130           | 1.7           |
| EXC24CG900U | 90 Ω ± 25 %  | 20 Ω max.         | 5             | 100           | 3.0           |

● Category temperature range -40 °C to +85 °C

#### Impedance characteristics (Typical)





# EXC24CE/CF type



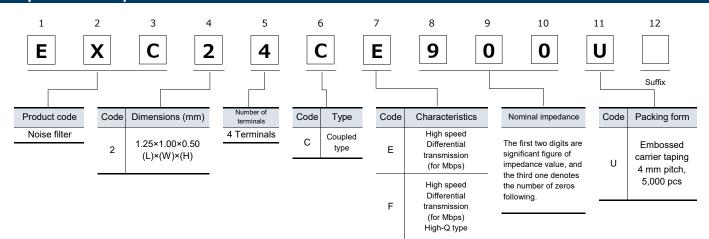
#### **Features**

- Elimination of radiation noises from high-speed differential transmissions
- Strong multilayer structure, excellent reflow resistance and high mounting reliability
- Magnetic shield type with no leakage
- High-Q impedance: EXC24CF
- Small and thin (L 1.25 mm×W 1.00 mm×H 0.50 mm)
- RoHS compliant

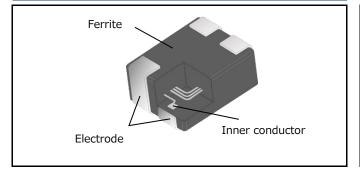
#### **Recommended applications**

- AV equipment (LCD-TV, DVD/Blu-ray drives), Information equipment (PCs, HDD, Printers), Communications equipment (Mobile phones, Smartphones)
- Noise suppression of high-speed differential data lines such as USB 2.0 and LVDS

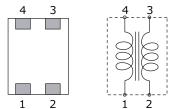
#### **Explanation of part numbers**



#### Construction

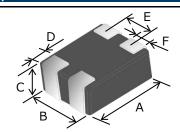


#### **Circuit configuration (No polarity)**



※ The pin numbers shown here are for reference purposes only. Confirm the actual pin number arrangement with the exchanged specification documents.

#### **Dimensions in mm (not to scale)**



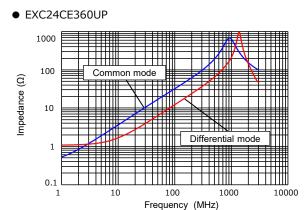
| Part No.       | Dimensions  |             |             |             |             |             |           |
|----------------|-------------|-------------|-------------|-------------|-------------|-------------|-----------|
| (inch size)    | А           | В           | С           | D           | E           | F           | (mg/ pc.) |
| EXC24CE (0504) | 1.25 ± 0.15 | 1.00 ± 0.15 | 0.50 ± 0.10 | 0.20 ± 0.15 | 0.55 ± 0.10 | 0.30 ± 0.10 | 3.0       |
| EXC24CF (0504) | 1.25 ± 0.15 | 1.00 ± 0.15 | 0.50 ± 0.10 | 0.20 ± 0.15 | 0.33 ± 0.10 | 0.30 ± 0.10 | 3.0       |

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|------|-------------|---|
| Nau  |             |   |
|      |             | ٦ |

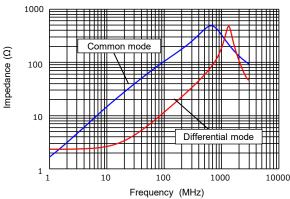
| Part number     | Impedance (0 | Ω) at 100 MHz     | Rated voltage | Rated current | DC resistance (Ω) max. |  |
|-----------------|--------------|-------------------|---------------|---------------|------------------------|--|
| r art number    | Common mode  | Differential mode | (V) DC        | (mA) DC       |                        |  |
| EXC24CE360UP    | 36 Ω ± 25 %  | 20 Ω max.         | 5             | 200           | 1.0                    |  |
| EXC24CE900U     | 90 Ω ± 25 %  | 15 Ω max.         | 5             | 160           | 1.75                   |  |
| EXC24CE121U     | 120 Ω ± 25 % | 18 Ω max.         | 5             | 140           | 2.2                    |  |
| EXC24CE201U     | 200 Ω ± 25 % | 20 Ω max.         | 5             | 130           | 2.7                    |  |
| NEW EXC24CE331U | 330 Ω ± 25 % | 35 Ω max.         | 5             | 100           | 6.2                    |  |
| EXC24CF900U     | 90 Ω ± 25 %  | 20 Ω max.         | 5             | 130           | 2.5                    |  |

Category temperature range −40 °C to +85 °C

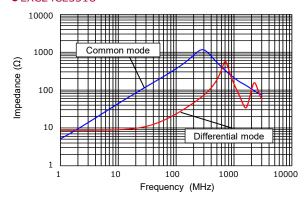
#### Impedance characteristics (Typical)







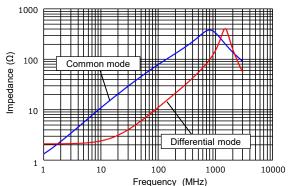
#### ●EXC24CE331U



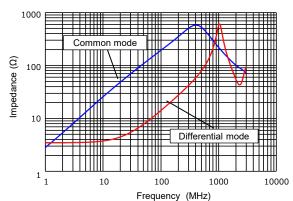
#### Measurement circuit



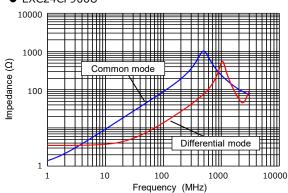
#### • EXC24CE900U



#### • EXC24CE201U

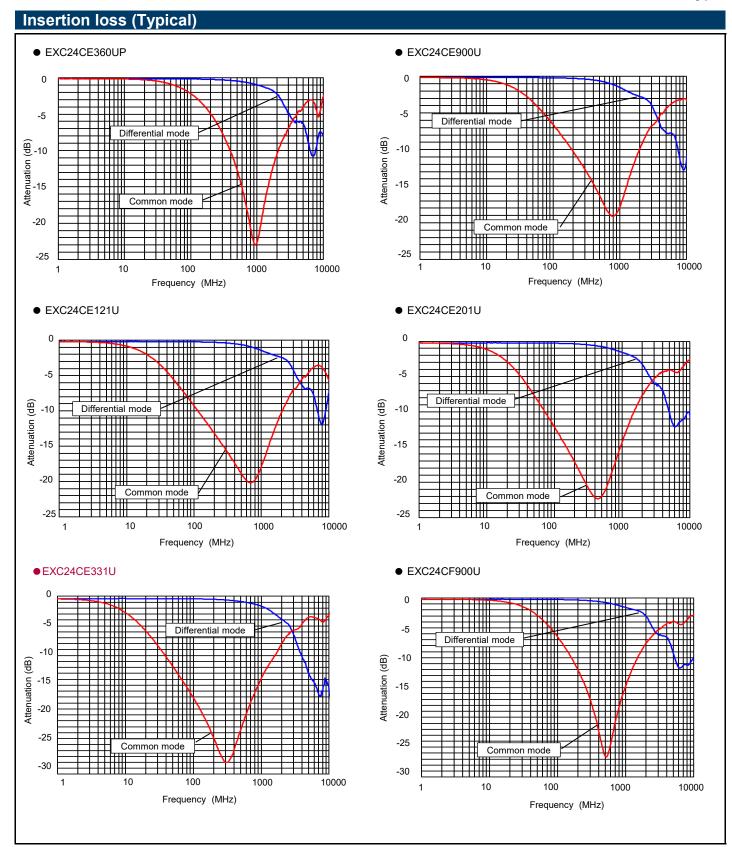


#### • EXC24CF900U



#### (B) Differential mode





■ As for packaging methods, soldering conditions and safety precautions, please see data files

**INDUSTRY** 

# **Common Mode Noise Filters**

# EXC34CG/CE type



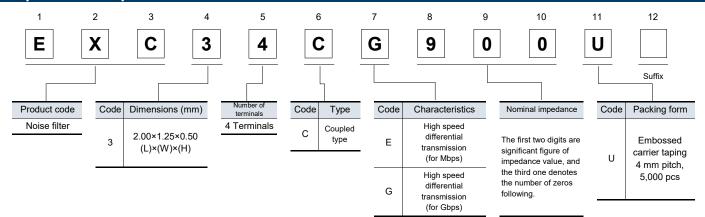
#### **Features**

- Thin type, built-in filter circuit (L 2.0 mm×W 1.25 mm×H 0.50 mm)
- Noise suppression of high-speed differential transmission lines with little influence of waveform rounding on signal transmission
- Strong multilayer/sintered structure, excellent reflow resistance and high mounting reliability
- Lead, halogen and antimony-free
- RoHS compliant

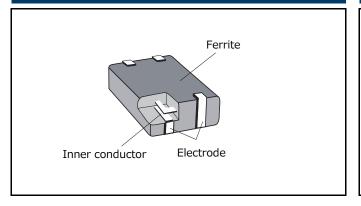
#### **Recommended applications**

- AV equipment (LCD-TV, DVD/Blu-ray drives), Information equipment (PCs, HDD, Printers)
- Noise suppression of high-speed differential data lines such as USB2.0, LVDS, HDMI and LAN

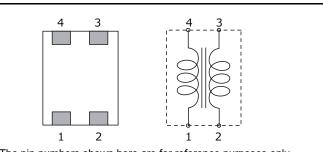
#### **Explanation of part numbers**



#### Construction

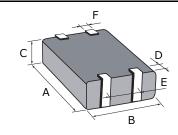


#### **Circuit configuration (No polarity)**



X The pin numbers shown here are for reference purposes only. Confirm the actual pin number arrangement with the exchanged specification documents.

#### **Dimensions in mm (not to scale)**

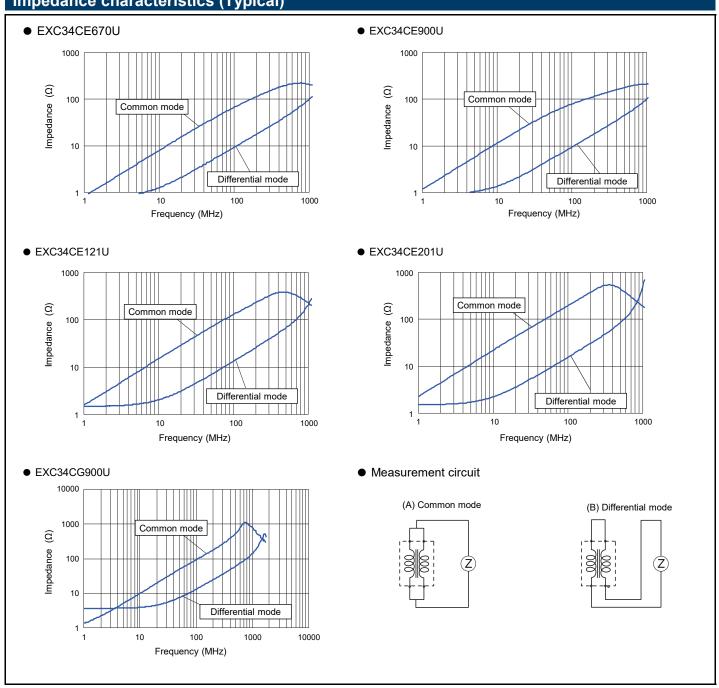


| Part No.       | Dimensions  |             |             |             |                 |             |           |
|----------------|-------------|-------------|-------------|-------------|-----------------|-------------|-----------|
| (inch size)    | А           | В           | С           | D           | Е               | F           | (mg/ pc.) |
| EXC34CG (0805) | 2.00 ± 0.15 | 1 25 4 0 15 | 0.50 ± 0.10 | 0.20 ± 0.20 | $0.80 \pm 0.10$ | 0.20 ± 0.15 | 5.0       |
| EXC34CE (0805) | 2.00 ± 0.13 | 1.25 ± 0.15 | 0.30 ± 0.10 | 0.30 ± 0.20 | 0.80 ± 0.10     | 0.30 ± 0.13 | 5.0       |

| Ratings     |                          |               |                            |                       |                   |                  |
|-------------|--------------------------|---------------|----------------------------|-----------------------|-------------------|------------------|
| Part number | Impedance (Ω) at 100 MHz | Rated current | Rated<br>voltage<br>(V) DC | Insulation resistance | Withstand voltage | DC<br>resistance |
|             | Common mode              | (mA) DC       |                            | (MΩ)min.              | (V) DC            | (Ω) max.         |
| EXC34CE670U | 67 Ω ± 25 %              | 250           | 5                          | 10 ΜΩ                 | 125               | 0.8              |
| EXC34CE900U | 90 Ω ± 25 %              | 250           | 5                          | 10 ΜΩ                 | 125               | 0.8              |
| EXC34CE121U | 120 Ω ± 25 %             | 200           | 5                          | 10 ΜΩ                 | 125               | 1.0              |
| EXC34CE201U | 200 Ω ± 25 %             | 200           | 5                          | 10 ΜΩ                 | 125               | 1.0              |
| EXC34CG900U | 90 Ω ± 25 %              | 100           | 5                          | 10 ΜΩ                 | 125               | 3.0              |

Category temperature range −40 °C to +85 °C







#### **INDUSTRY**

## **Common Mode Noise Filters Array**

## EXC18CG/CE type



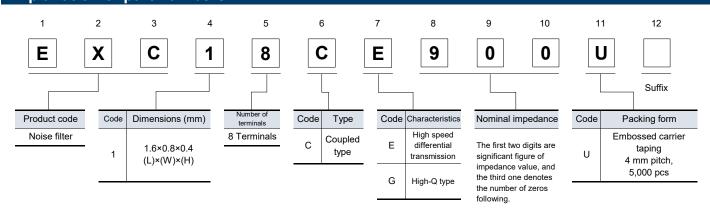
#### **Features**

- Small and thin type, two built-in filter circuit (L 1.6 mm ×W 0.8 mm×H 0.4 mm)
- Noise suppression of high-speed differential transmission lines with little influence of waveform rounding on signal transmission
- Low DC resistance and low insertion loss
- High-Q value and high impedance of GHz zone : EXC18CG type
- Strong multilayer/sintered structure, excellent reflow resistance and high mounting reliability
- Lead, halogen and antimony-free
- RoHS compliant

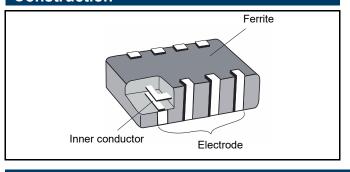
#### Recommended applications

- AV equipment (LCD-TV, DVD/Blu-ray drives), Information equipment (PCs, HDD, Printers)
- Noise suppression of high-speed differential data lines such as USB2.0, LVDS, HDMI and LAN

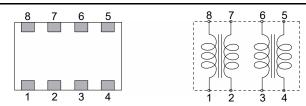
#### **Explanation of part numbers**



#### Construction

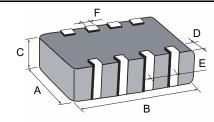


## Circuit configuration (No polarity)



※ The pin numbers shown here are for reference purposes only. Confirm the actual pin number arrangement with the exchanged specification documents.

#### **Dimensions in mm (not to scale)**

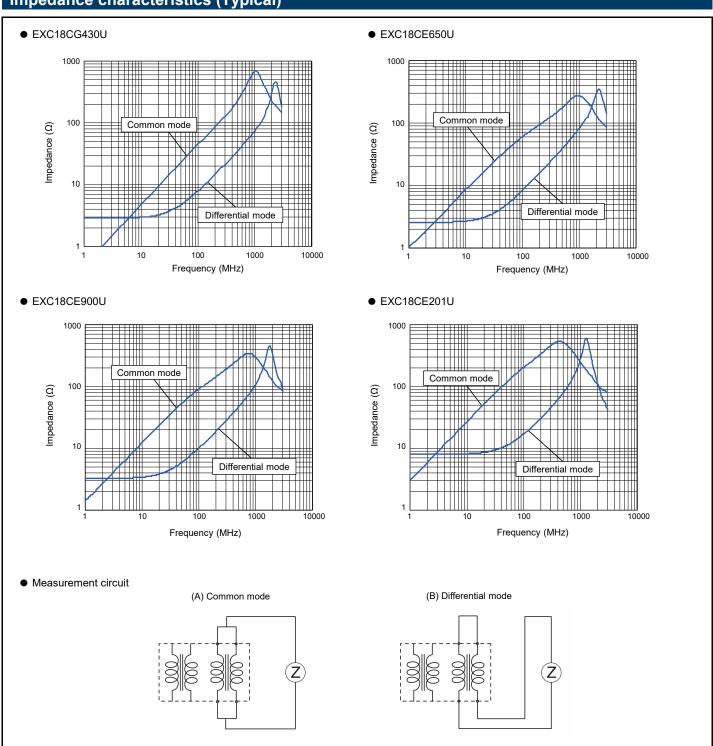


| Part No.       | Dimensions |           |           |           |           |            |           |  |  |  |
|----------------|------------|-----------|-----------|-----------|-----------|------------|-----------|--|--|--|
| (inch size)    | Α          | В         | С         | D         | Е         | F          | (mg/ pc.) |  |  |  |
| EXC18CG (0603) | 0.8 ± 0.1  | 1.6 ± 0.1 | 0.4 ± 0.1 | 0.2 ± 0.1 | 0.4 ± 0.1 | 0.2 ± 0.1  | 2.6       |  |  |  |
| EXC18CE (0603) | 0.0 ± 0.1  | 1.0 ± 0.1 | 0.4 ± 0.1 | 0.2 ± 0.1 | 0.4 ± 0.1 | U.Z ± U. I | 2.0       |  |  |  |

| Part number | Impedance (0 | Ω) at 100 MHz     | Rated voltage | Rated current | DC resistance |
|-------------|--------------|-------------------|---------------|---------------|---------------|
| raithamber  | Common mode  | Differential mode | (V) DC        | (mA) DC       | (Ω) max.      |
| EXC18CG430U | 43 Ω ± 25 %  | 15 Ω max.         | 5             | 100           | 2.7           |
| EXC18CE650U | 65 Ω ± 20 %  | 18 Ω max.         | 5             | 140           | 1.8           |
| EXC18CE900U | 90 Ω ± 20 %  | 20 Ω max.         | 5             | 130           | 2.0           |
| EXC18CE201U | 200 Ω ± 20 % | 22 Ω max.         | 5             | 100           | 3.5           |

Category temperature range −40 °C to +85 °C

#### **Impedance characteristics (Typical)**



## **Common Mode Noise Filters Array**

## EXC28CH type



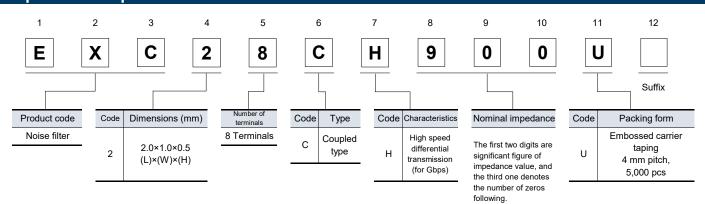
#### **Features**

- Small and thin type, two built-in filter circuit (L 2.0 mm×W 1.0 mm×H 0.5 mm)
- Suppression of high frequency noise with little influence of waveform rounding on signal transmission, achieved by setting high cut-off frequency between 6 and 10 GHz
- Strong multilayer/sintered structure, excellent reflow resistance and high mounting reliability
- Lead, halogen and antimony-free
- RoHS compliant

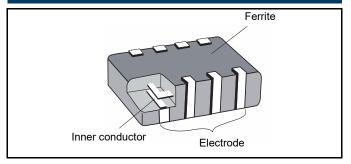
#### **Recommended applications**

- AV equipment (LCD-TV, DVD/Blu-ray drives), Information equipment (PCs, HDD, Printers)
- Noise suppression of high-speed differential data lines such as USB3.0, LVDS, HDMI and LAN

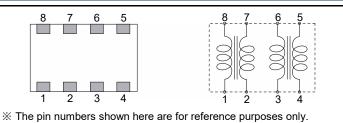
#### **Explanation of part numbers**



#### Construction

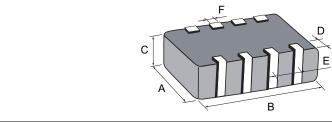


#### Circuit configuration (No polarity)



X The pin numbers shown here are for reference purposes only. Confirm the actual pin number arrangement with the exchanged specification documents.

#### **Dimensions in mm (not to scale)**

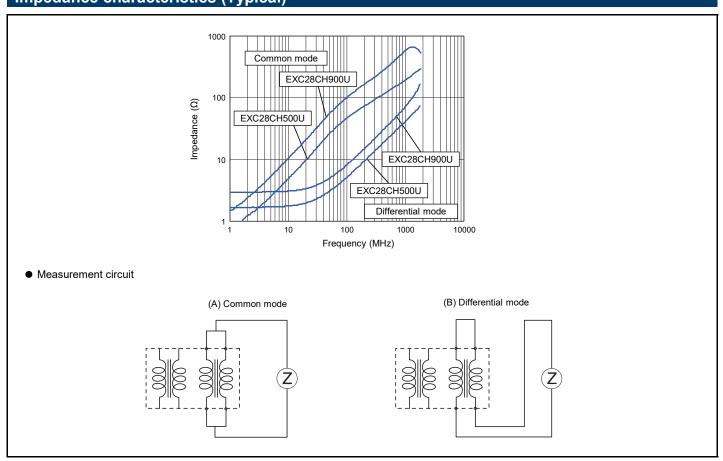


| Part No.       |                 | Dimensions    |               |                |               |                |     |  |  |  |  |
|----------------|-----------------|---------------|---------------|----------------|---------------|----------------|-----|--|--|--|--|
| (inch size)    | A               | A B C D E F   |               |                |               |                |     |  |  |  |  |
| EXC28CH (0804) | $1.00 \pm 0.15$ | $2.0 \pm 0.2$ | $0.5 \pm 0.1$ | $0.2 \pm 0.15$ | $0.5 \pm 0.1$ | $0.25 \pm 0.1$ | 5.0 |  |  |  |  |

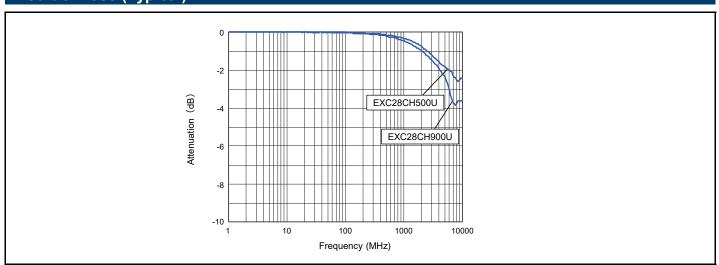
| Part number | Impedance (0 | Ω) at 100 MHz     | Cutoff<br>frequency | Rated voltage | Rated current | DC resistance |
|-------------|--------------|-------------------|---------------------|---------------|---------------|---------------|
|             | Common mode  | Differential mode | (GHz)               | (V) DC        | (mA) DC       | (Ω) max.      |
| EXC28CH500U | 50 Ω ± 25 %  | 13 Ω max.         | 10 Typ.             | 5             | 160           | 1.5           |
| EXC28CH900U | 90 Ω ± 20 %  | 15 Ω max.         | 6 Тур.              | 5             | 130           | 2.5           |

● Category temperature range -40 °C to +85 °C

## Impedance characteristics (Typical)



## Insertion loss (Typical)



**INDUSTRY** 

## **Common Mode Noise Filters Array**

## EXC28CG type



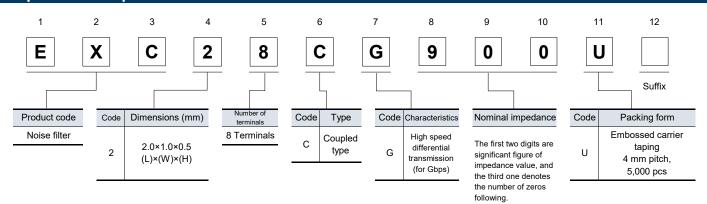
#### **Features**

- Small and thin type, two built-in filter circuit (L 2.0 mm×W 1.0 mm×H 0.5 mm)
- Prevention of weakening of transmission signals by controlling singal pass band as 3 GHz or above
- ullet Prevention of reflection of transmission signals and noise radiation by controlling TDR characteristic impedance as 100  $\Omega$
- Satisfaction of eye pattern standards of HDMI waveforms with capability to improve waveform fluctuations of Jitter and phase shift etc
- Elimination of radiation noises from high-speed differential transmissions
- Magnetic shield type with no leakage
- RoHS compliant

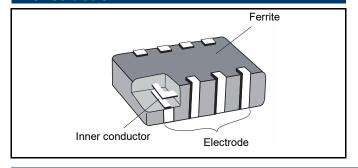
#### **Recommended applications**

- AV equipment (LCD-TV, DVD/Blu-ray drives), Information equipment (PCs, HDD), Communications equipment (Mobile phones, Smartphones)
- Noise suppression of high-speed differential data lines such as HDMI, SATA and LAN

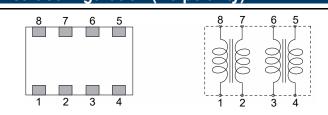
#### **Explanation of part numbers**



#### Construction

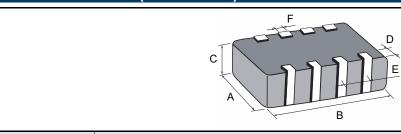


#### **Circuit configuration (No polarity)**



※ The pin numbers shown here are for reference purposes only. Confirm the actual pin number arrangement with the exchanged specification documents.

#### **Dimensions in mm (not to scale)**



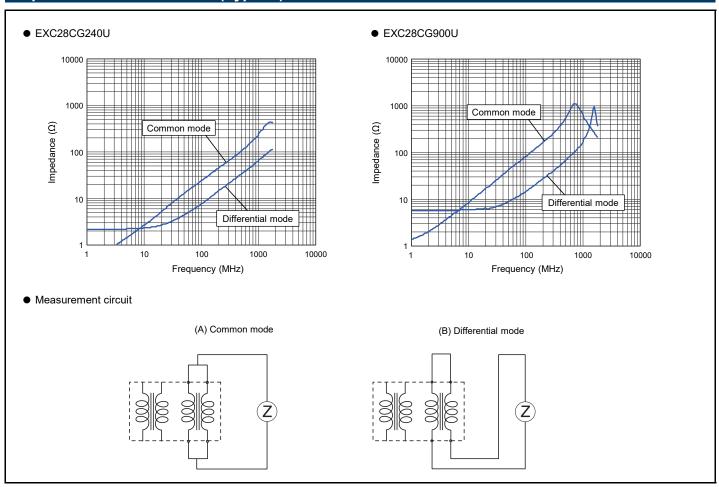
 $\mathsf{Unit}:\mathsf{mm}$ 

| Part No.       |                 | Dimensions    |               |                |               |                |           |  |  |  |  |  |
|----------------|-----------------|---------------|---------------|----------------|---------------|----------------|-----------|--|--|--|--|--|
| (inch size)    | Α               | В             | С             | D              | E             | F              | (mg/ pc.) |  |  |  |  |  |
| EXC28CG (0804) | $1.00 \pm 0.15$ | $2.0 \pm 0.2$ | $0.5 \pm 0.1$ | $0.2 \pm 0.15$ | $0.5 \pm 0.1$ | $0.25 \pm 0.1$ | 5.0       |  |  |  |  |  |

| Part number | Impedance (0 | ն) at 100 MHz     | Rated voltage | Rated current | DC resistance |
|-------------|--------------|-------------------|---------------|---------------|---------------|
|             | Common mode  | Differential mode | (V) DC        | (mA) DC       | (Ω) max.      |
| EXC28CG240U | 24 Ω ± 25 %  | 15 Ω max.         | 5             | 160           | 1.5           |
| EXC28CG900U | 90 Ω ± 25 %  | 17 Ω max.         | 5             | 130           | 3.0           |

● Category temperature range -40 °C to +85 °C

## Impedance characteristics (Typical)



#### **INDUSTRY**

## **Common Mode Noise Filters Array**

## EXC28CE type



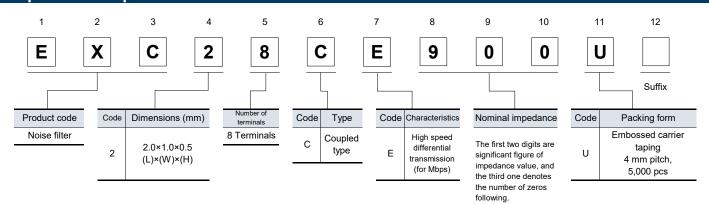
#### **Features**

- Small and thin type, two built-in filter circuit (L 2.0 mm×W 1.0 mm×H 0.5 mm)
- Elimination of radiation noises from high-speed differential transmissions
- Magnetic shield type with no leakage
- Strong multilayer/sintered structure, excellent reflow resistance and high mounting reliability
- Lead, halogen and antimony-free
- RoHS compliant

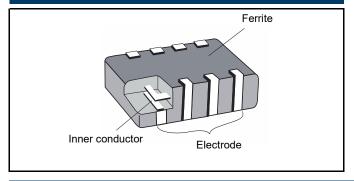
#### **Recommended applications**

- AV equipment (LCD-TV, DVD/Blu-ray drives), Information equipment (PCs, HDD, Printers), Communications equipment (Mobile phones, Smartphones)
- Noise suppression of high-speed differential data lines such as USB2.0 and LVDS

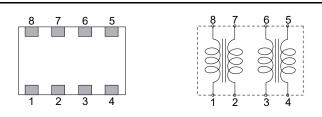
#### **Explanation of part numbers**



#### Construction

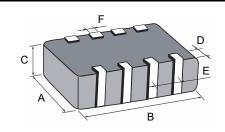


#### Circuit configuration (No polarity)



X The pin numbers shown here are for reference purposes only. Confirm the actual pin number arrangement with the exchanged specification documents.

#### **Dimensions in mm (not to scale)**

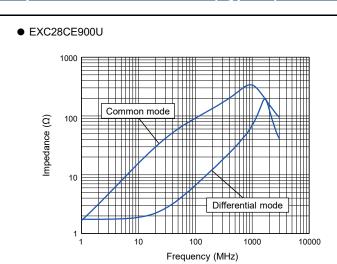


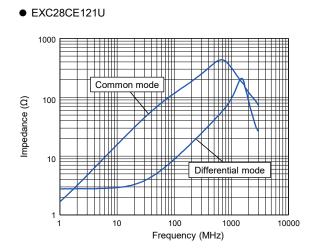
| Part No.       |             | Dimensions |           |            |           |            |     |  |  |  |  |
|----------------|-------------|------------|-----------|------------|-----------|------------|-----|--|--|--|--|
| (inch size)    | Α           | В          | С         | D          | E         | E F        |     |  |  |  |  |
| EXC28CE (0804) | 1.00 ± 0.15 | 2.0 ± 0.2  | 0.5 ± 0.1 | 0.2 ± 0.15 | 0.5 ± 0.1 | 0.25 ± 0.1 | 5.0 |  |  |  |  |

| Part number    | Impedance (9 | Ω) at 100 MHz     | Rated voltage | Rated current | DC resistance |  |
|----------------|--------------|-------------------|---------------|---------------|---------------|--|
| rait ilullibei | Common mode  | Differential mode | (V) DC        | (mA) DC       | (Ω) max.      |  |
| EXC28CE900U    | 90 Ω ± 25 %  | 15 Ω max.         | 5             | 160           | 1.5           |  |
| EXC28CE121U    | 120 Ω ± 25 % | 18 Ω max.         | 5             | 140           | 2.0           |  |
| EXC28CE201U    | 200 Ω ± 25 % | 20 Ω max.         | 5             | 130           | 2.5           |  |

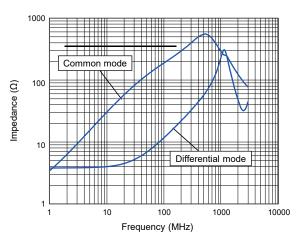
● Category temperature range -40 °C to +85 °C

#### Impedance characteristics (Typical)

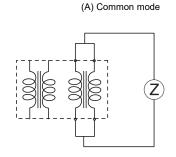




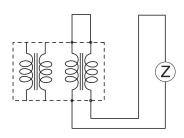
#### ● EXC28CE201U



Measurement circuit



(B) Differential mode

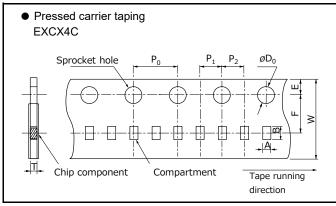


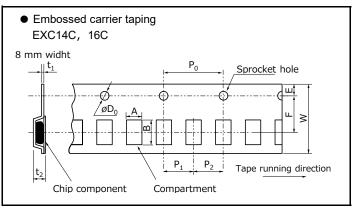
## Common Mode Noise Filters · Array / Packaging methods

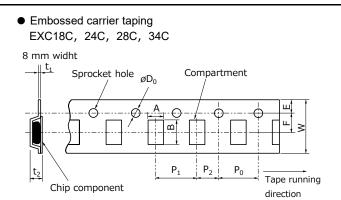
## Packaging methods (Taping)

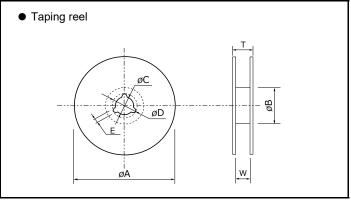
Standard quantity

|   | Part number | Size (inch) | Туре   | Kind of taping          | Pitch (P <sub>1</sub> ) (mm) | Quantity (pcs / reel) |  |
|---|-------------|-------------|--------|-------------------------|------------------------------|-----------------------|--|
|   | EXCX4C      | 0202        |        | Pressed carrier taping  | 2                            | 10,000                |  |
|   | EXC14C      | 0302        |        |                         | 2                            | 10.000                |  |
|   | EXC16C      | 0403        | Single |                         | 2                            | 10,000                |  |
|   | EXC24C      | 0504        |        | Embossed carrier taping |                              |                       |  |
|   | EXC34C      | 0805        |        | Embossed camer taping   | 4                            | 5.000                 |  |
|   | EXC18C      | 0603        | Array  |                         | 4                            | 3,000                 |  |
| - | EXC28C      | 0804        | Array  |                         |                              |                       |  |









#### Pressed carrier taping

Unit : mm

| Part number | Α         | В         | W       | F         | Е         | P <sub>1</sub> | P <sub>2</sub> | P <sub>0</sub> | $\phi D_0$ | T         |
|-------------|-----------|-----------|---------|-----------|-----------|----------------|----------------|----------------|------------|-----------|
| EXCX4C      | 0.60±0.10 | 0.80±0.10 | 8.0±0.2 | 3.50±0.05 | 1.75±0.10 | 2.0±0.1        | 2.0±0.1        | 4.0±0.1        | 1.5 +0.1   | 0.35 typ. |

#### Embossed carrier taping

Unit : mm

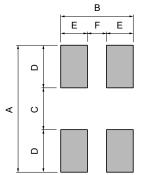
| Part number | Α         | В         | W       | F         | Е         | P <sub>1</sub> | P <sub>2</sub> | P <sub>0</sub>   | øD <sub>0</sub> | t <sub>1</sub> | t <sub>2</sub> |
|-------------|-----------|-----------|---------|-----------|-----------|----------------|----------------|------------------|-----------------|----------------|----------------|
| EXC14C      | 0.75±0.10 | 0.95±0.10 | 8.0±0.2 | 3.50±0.05 | 1.75±0.10 | 2.0±0.1        | 2.0±0.1        | 4.0±0.1          | 1.5 +0.1        | 0.25±0.05      | 0.85±0.15      |
| EXC16C      | 0.77±0.10 | 0.99±0.10 | 0.0±0.2 | 3.3010.03 | 1.73±0.10 | 2.010.1        | 2.0±0.1        | 4.010.1          | 1.5 0           |                | 0.80±0.15      |
| EXC18C      | 1.00±0.10 | 1.80±0.10 |         |           |           |                |                |                  |                 |                | 0.80±0.05      |
| EXC24C      | 1.20±0.15 | 1.45±0.15 | 8.0±0.2 | 3.5±0.1   | 1.75±0.10 | 4.0±0.1        | 2.0±0.1        | 4.0±0.1 1.5 +0.1 | 15 +0.1         | 0.25±0.05      |                |
| EXC28C      | 1.2010.13 | 2.25±0.15 | 0.0±0.2 |           | 1.73±0.10 | 4.0±0.1        | 2.0±0.1        |                  | 1.5 0           | 0.23±0.03      | 0.90±0.15      |
| EXC34C      | 1.50±0.20 | 2.30±0.20 |         |           |           |                |                |                  |                 |                |                |

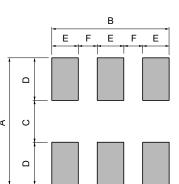
#### Standard reel dimensions

| Part number | øΑ        | øΒ       | øС       | øD       | E       | W       | Т        |
|-------------|-----------|----------|----------|----------|---------|---------|----------|
| EXCX4C      |           |          | 13.0±0.2 |          |         |         | 11.4±1.0 |
| EXC14C      |           |          |          |          |         |         |          |
| EXC16C      |           |          |          |          |         |         |          |
| EXC18C      | 180.0±3.0 | 60.0±1.0 | 13.0±0.5 | 21.0±0.8 | 2.0±0.5 | 9.0±0.3 | 11.4±1.5 |
| EXC24C      |           |          | 13.0±0.3 |          |         |         | 11.4±1.3 |
| EXC28C      |           |          |          |          |         |         |          |
| EXC34C      |           |          |          |          |         |         |          |

#### Recommended land pattern design

● Single EXCX4C, 14C, 24C, 34C

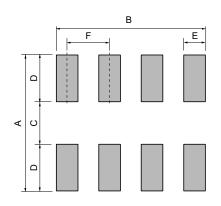




EXC16C

| · · · · · · · · · · · · · · · · · · · |                 |                 |                 |                 |                 |                 |
|---------------------------------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|
| Part number                           |                 |                 | Dime            | nsions          |                 |                 |
| Part number                           | Α               | В               | С               | D               | Е               | F               |
| EXCX4C                                | 0.80 to<br>0.90 | 0.60 to<br>0.75 | 0.20 to<br>0.30 | 0.30            | 0.20 to<br>0.25 | 0.20 to<br>0.25 |
| EXC14C                                | 0.80 to<br>1.00 | 0.80            | 0.30            | 0.25 to<br>0.35 | 0.30            | 0.20            |
| EXC24C                                | 1.60 to<br>2.00 | 0.95            | 0.70            | 0.45 to<br>0.65 | 0.35            | 0.25            |
| EXC34C                                | 2.60            | 1.20            | 1.10            | 0.75            | 0.40            | 0.40            |
| EXC16C                                | റ ഒര            | 0.85            | በ 33            | በ 33            | 0.15            | 0.20            |

Array



| Part number    | Dimensions |      |     |     |      |     |  |  |
|----------------|------------|------|-----|-----|------|-----|--|--|
| rait ilullibei | Α          | В    | С   | D   | Е    | F   |  |  |
| EXC18C         | 1.4        | 1.4  | 0.4 | 0.5 | 0.2  | 0.4 |  |  |
| EXC28C         | 1.4        | 1.75 | 0.4 | 0.5 | 0.25 | 0.5 |  |  |

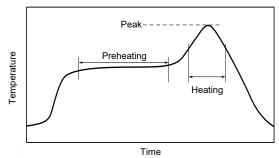
Unit: mm

#### **Recommended soldering conditions**

Recommendations and precautions are described below

#### • Recommended soldering conditions for reflow

- Reflow soldering shall be performed a maximum of two times.
- Please contact us for additional information when used in conditions other than those specified.
- Please measure the temperature of the terminals and study every kind of solder and printed circuit board for solderability before actual use.



#### For soldering (Example: Sn-37Pb)

|              | Temperature    | Time          |
|--------------|----------------|---------------|
| Preheating   | 140 ℃ to 160 ℃ | 60 s to 120 s |
| Main heating | Above 200 ℃    | 30 s to 40 s  |
| Peak         | 235 ± 10 °C    | max. 10 s     |

#### For lead-free soldering (Example :Sn-3Ag-0.5Cu)

|              | • • •          |               |
|--------------|----------------|---------------|
|              | Temperature    | Time          |
| Preheating   | 150 ℃ to 170 ℃ | 60 s to 120 s |
| Main heating | Above 230 ℃    | 30 s to 40 s  |
| Peak         | max. 260 ℃     | max. 10 s     |

#### Flow soldering

·We do not recommend flow soldering, because flow soldering may cause bridges between the electrodes.

《Repair with hand soldering》

- Preheat with a blast of hot air or similar method. Use a soldering iron with a tip temperature of 350 °C or less.
   Solder each electrode for 3 seconds or less.
- Never touch this product with the tip of a soldering iron.

## Common Mode Noise Filters With ESD Suppressor EXC14CS type

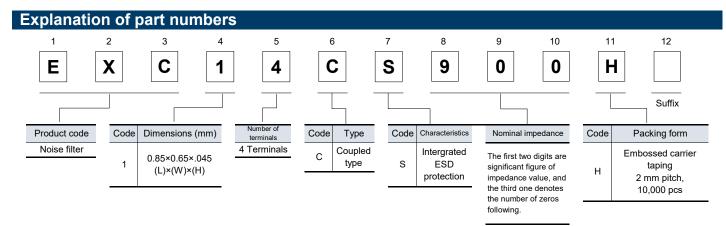


#### **Features**

- Provides EMI Filtering and ESD Potection (L 0.85 mm×W 0.65 mm×H 0.45mm)
- ESD and noise suppression of high-speed differential transmission lines with little influence of waveform rounding on signal transmission
- High Common mode attenuation in the range between 700 MHz and 1000 MHz (RF band)
- Strong multilayer/sintered structure, excellent reflow resistance and high mounting reliability
- RoHS compliant

#### **Recommended applications**

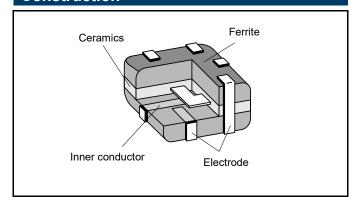
- Smartphones, Tablet PCs and DSC
- ESD and noise suppression of high-speed differential data lines such as MIPI and USB



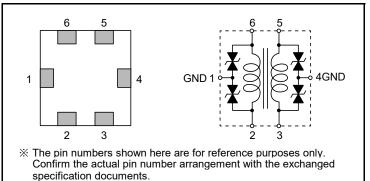
#### Construction

(inch size)

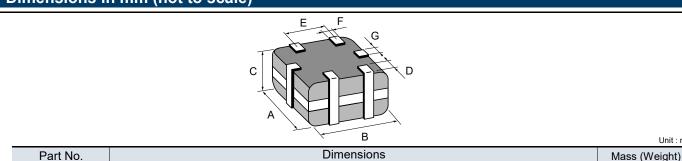
EXC14CS (0302)



## **Circuit configuration (No polarity)**



#### **Dimensions in mm (not to scale)**



 $0.67 \pm 0.05 | 0.87 \pm 0.05 | 0.45 \pm 0.05$ 

Unit: mm

(mg/pc.)

0.97

G

 $0.20 \pm 0.07$ 

 $0.15 \pm 0.07$ 

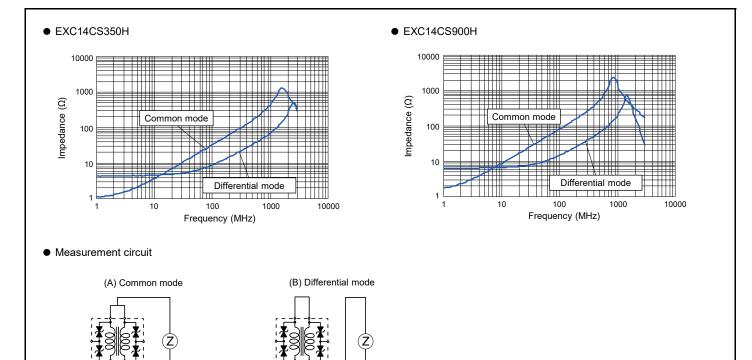
Ε

 $0.40 \pm 0.05 \mid 0.20 \pm 0.07$ 

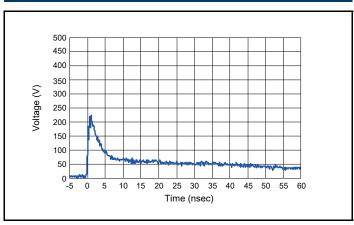
| Part number    | Impedance (0 | Ω) at 100 MHz     | Rated voltage | Rated current | DC resistance |
|----------------|--------------|-------------------|---------------|---------------|---------------|
| rait ilullibei | Common mode  | Differential mode | (V) DC        | (mA) DC       | (Ω) max.      |
| EXC14CS350H    | 35 Ω ± 30 %  | 15 Ω max.         | 5             | 100           | 2.0 ± 30 %    |
| EXC14CS900H    | 90 Ω ± 20 %  | 20 Ω max.         | 5             | 100           | 3.3 ± 30 %    |

Category temperature range −40 °C to +85 °C

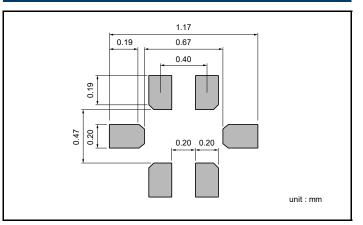
#### Impedance characteristics (Typical)



#### ESD suppression characteristics (Typ.: IEC6100-4-2, 8 kV contact discharge )



#### Recommended land pattern design (not to scale)



# Common Mode Noise Filters With ESD Suppressor

EXC24CS type



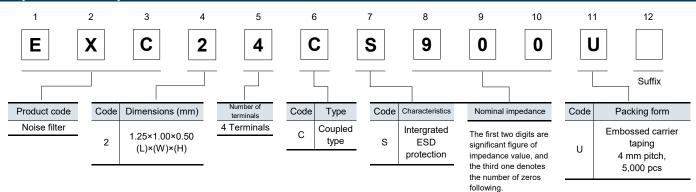
#### **Features**

- Provides EMI Filtering and ESD Potection (L 1.25 mm×W 1.00 mm×H 0.50 mm)
- ESD and noise suppression of high-speed differential transmission lines with little influence of waveform rounding on signal transmission
- High Common mode attenuation in the range between 700 MHz and 1000 MHz (RF band)
- Strong multilayer/sintered structure, excellent reflow resistance and high mounting reliability
- Lead, halogen and antimony-free
- RoHS compliant

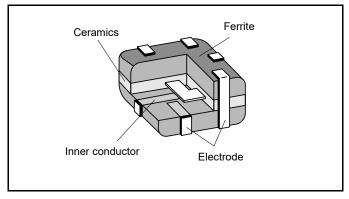
#### **Recommended applications**

- Smartphones, Tablet PCs and DSC
- ESD and noise suppression of high-speed differential data lines such as MIPI and USB

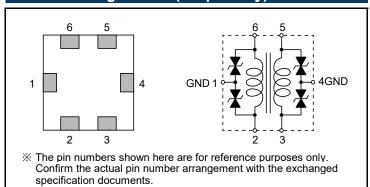
#### **Explanation of part numbers**



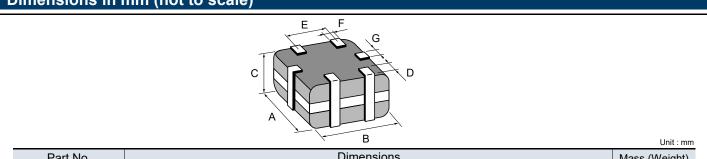
#### Construction



#### **Circuit configuration (No polarity)**



#### **Dimensions in mm (not to scale)**

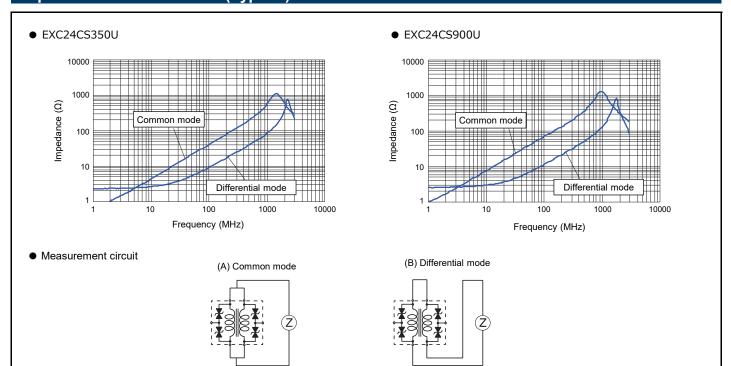


Part No. Dimensions Mass (Weight) (mg/pc.) (inch size) В С D Ε F G EXC24CS (0504) 1.25 ± 0.15  $1.00 \pm 0.15$  $0.50 \pm 0.10$  $0.20 \pm 0.15$  $0.55 \pm 0.10$  $0.30 \pm 0.10$  $0.20 \pm 0.10$ 2.4

| Part number    | Impedance (0 | Ω) at 100 MHz     | Rated voltage | Rated current | DC resistance |
|----------------|--------------|-------------------|---------------|---------------|---------------|
| Fait ilullibei | Common mode  | Differential mode | (V) DC        | (mA) DC       | (Ω) max.      |
| EXC24CS350U    | 35 Ω ± 30 %  | 15 Ω max.         | 5             | 100           | 2.0           |
| EXC24CS900U    | 90 Ω ± 20 %  | 20 Ω max.         | 5             | 100           | 3.0           |

● Category temperature range -40 °C to +85 °C

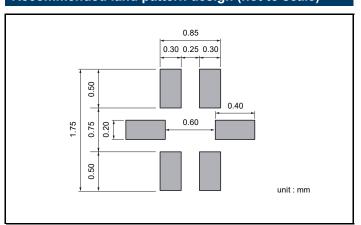
#### Impedance characteristics (Typical)



#### ESD suppression characteristics (Typ. : IEC6100-4-2, 8 kV contact discharge )

#### 500 450 400 350 Voltage (V) 300 250 200 150 100 50 15 20 25 30 35 40 45 50 55 0 5 10 Time (nsec)

#### Recommended land pattern design (not to scale)



## **Common Mode Noise Filters Array With ESD Suppressor**

EXC18CS type



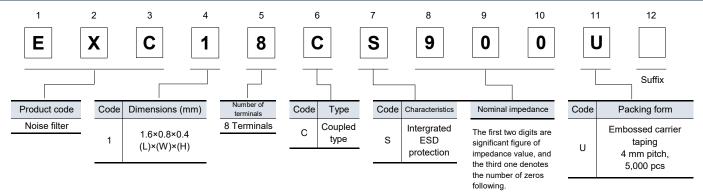
#### **Features**

- Provides EMI Filtering and ESD Potection (L 1.6 mm ×W 0.8 mm×H 0.4 mm)
- ESD and noise suppression of high-speed differential transmission lines with little influence of waveform rounding on signal transmission
- High Common mode attenuation in the range between 700 MHz and 1000 MHz (RF band)
- Strong multilayer/sintered structure, excellent reflow resistance and high mounting reliability
- Lead, halogen and antimony-free
- RoHS compliant

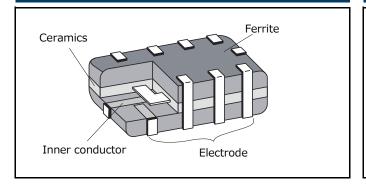
#### **Recommended applications**

- Smartphones, Tablet PCs and DSC
- ESD and noise suppression of high-speed differential data lines such as MIPI and USB

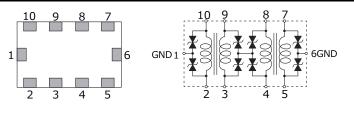
#### **Explanation of part numbers**



#### **Construction**

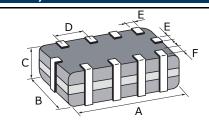


## **Circuit configuration (No polarity)**



※ The pin numbers shown here are for reference purposes only. Confirm the actual pin number arrangement with the exchanged specification documents.

#### Dimensions in mm (not to scale)



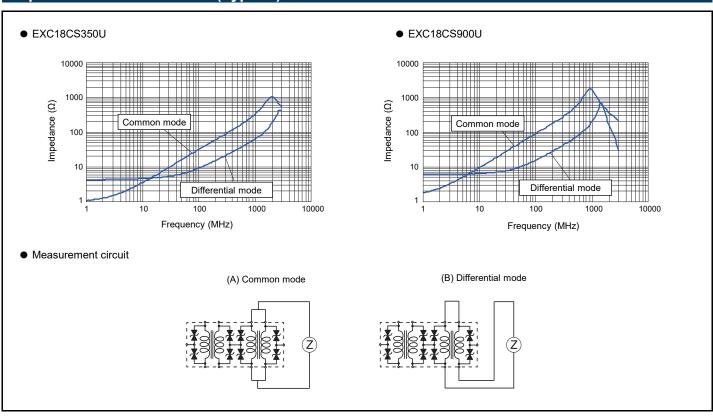
単位 : mm

| Part No.       | Dimensions  |          |           |           |           |           |           |
|----------------|-------------|----------|-----------|-----------|-----------|-----------|-----------|
| (inch size)    | A B C D E F |          |           |           |           |           | (mg/ pc.) |
| EXC18CS (0603) | 1.6 ± 0.1   | 0.8± 0.1 | 0.4 ± 0.1 | 0.4 ± 0.1 | 0.2 ± 0.1 | 0.2 ± 0.1 | 1.9       |

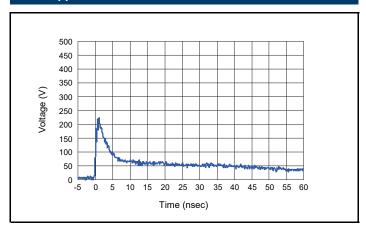
| Part number | Impedance (0                  | Ω) at 100 MHz | Rated voltage | Rated current | DC resistance |
|-------------|-------------------------------|---------------|---------------|---------------|---------------|
| Part Humber | Common mode Differential mode |               | (V) DC        | (mA) DC       | (Ω) max.      |
| EXC18CS350U | 35 Ω ± 30 %                   | 15 Ω max.     | 5             | 100           | 1.8 ± 30 %    |
| EXC18CS900U | 90 Ω ± 20 %                   | 20 Ω max.     | 5             | 100           | 3.0 ± 30 %    |

● Category temperature range -40 °C to +85 °C

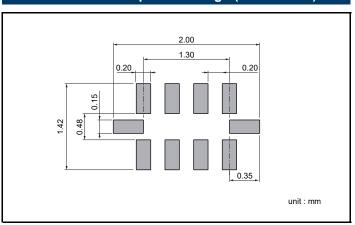
#### Impedance characteristics (Typical)



#### ESD suppression characteristics (Typ. : IEC6100-4-2, 8 kV contact discharge )



#### Recommended land pattern design (not to scale)

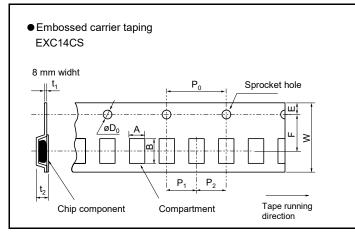


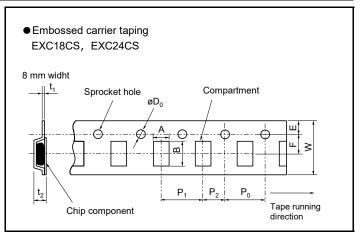
## Common mode Noise Filters with ESD Suppressor / Packaging methods

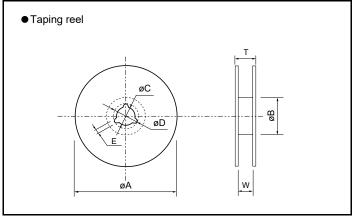
## Packaging methods (Taping)

#### Standard quantity

| Part number | Size (inch) | Туре   | Kind of taping          | Pitch (P <sub>1</sub> ) (mm) | Quantity (pcs / reel) |
|-------------|-------------|--------|-------------------------|------------------------------|-----------------------|
| EXC14CS     | 0302        | Single |                         | 2                            | 10000                 |
| EXC24CS     | 0504        | Single | Embossed Carrier Taping | 4                            | 5000                  |
| EXC18CS     | 0603        | Array  |                         | 4                            | 5000                  |







#### Embossed carrier taping

Unit : mm

| Part number | Α         | В         | W       | F         | Е         | P <sub>1</sub> | P <sub>2</sub> | P <sub>0</sub> | $\phi D_0$ | t <sub>1</sub> | t <sub>2</sub> |
|-------------|-----------|-----------|---------|-----------|-----------|----------------|----------------|----------------|------------|----------------|----------------|
| EXC14CS     | 0.75±0.10 | 0.95±0.10 | 8.0±0.2 | 3.50±0.05 | 1.75±0.10 | 2.0±0.1        | 2.0±0.1        | 4.0±0.1        | 1.5 +0.1   | 0.25±0.05      | 0.85±0.15      |
| EXC18CS     | 1.00±0.10 | 1.80±0.10 | 8.0±0.2 | 3.5±0.1   | 1.75±0.10 | 4.0±0.1        | 2.0±0.1        | 4.0±0.1        | 1.5 +0.1   | 0.25±0.05      | 0.50±0.05      |
| EXC24CS     | 1.20±0.15 | 1.45±0.15 | 0.U±U.2 | 3.5±0.1   | 1.75±0.10 | 4.0±0.1        | 2.0±0.1        | 4.0±0.1        | 1.5 0      | 0.25±0.05      | 0.90±0.15      |

#### Standard reel dimensions

| Part number | øΑ        | øΒ       | øС       | øD       | E       | W       | Т        |
|-------------|-----------|----------|----------|----------|---------|---------|----------|
| EXC14CS     |           |          |          |          |         |         |          |
| EXC18CS     | 180.0±3.0 | 60.0±1.0 | 13.0±0.5 | 21.0±0.8 | 2.0±0.5 | 9.0±0.3 | 11.4±1.5 |
| EXC24CS     |           |          |          |          |         |         |          |

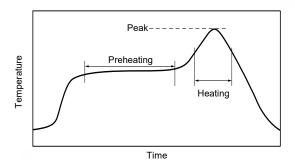
#### Common mode Noise Filters with ESD Suppressor / Mounting

#### **Recommended soldering conditions**

Recommendations and precautions are described below

#### Recommended soldering conditions for reflow

- · Reflow soldering shall be performed a maximum of two times.
- Please contact us for additional information when used in conditions other than those specified.
- Please measure the temperature of the terminals and study every kind of solder and printed circuit board for solderability before actual use.



#### For soldering (Example: Sn-37Pb)

| <br>         | <u> </u>       |               |
|--------------|----------------|---------------|
|              | Temperature    | Time          |
| Preheating   | 140 ℃ to 160 ℃ | 60 s to 120 s |
| Main heating | Above 200 ℃    | 30 s to 40 s  |
| Peak         | 235 ± 10 °C    | max. 10 s     |

#### For lead-free soldering (Example :Sn-3Ag-0.5Cu)

|              | Temperature    | Time          |
|--------------|----------------|---------------|
| Preheating   | 150 ℃ to 170 ℃ | 60 s to 120 s |
| Main heating | Above 230 ℃    | 30 s to 40 s  |
| Peak         | max. 260 ℃     | max. 10 s     |

#### • Flow soldering

·We do not recommend flow soldering, because flow soldering may cause bridges between the electrodes.

《Repair with hand soldering》

- Preheat with a blast of hot air or similar method. Use a soldering iron with a tip temperature of 350 °C or less.
   Solder each electrode for 3 seconds or less.
- Never touch this product with the tip of a soldering iron.



## Replacement list for "Not recommended for new design"

\* If you are using any of the following models on the deleted list, please substitute them with the suggested alternative model as soon as possible.

| Non-recon    | nmende          | ed part n                    | umber                         |              |           | Replac                        | ement <sub>l</sub> | oart number |             |                  |                 |   |             |      |   |
|--------------|-----------------|------------------------------|-------------------------------|--------------|-----------|-------------------------------|--------------------|-------------|-------------|------------------|-----------------|---|-------------|------|---|
| -            |                 | Noise Filt<br>uppressor      | ers                           | Common       | Mode No   | ise Filters                   |                    | ESD Sup     | pressor     |                  | Combination     |   |             |      |   |
| Part number  | Inch size       | ESD<br>protection<br>element | Impedance<br>(Common<br>Mode) | Part number  | Inch size | Impedance<br>(Common<br>Mode) | Number of pieces   | Part number | Inch size   | Number of pieces | pattern         |   |             |      |   |
| EXC14CS350U  | XC14CS350U 0302 |                              | 35 Ω                          | EXC14CH350U  | 0302      | 35 Ω                          | 1                  | EZAEG1N50AC | 0201        | 2                | 1               |   |             |      |   |
| LAC14C33300  | 0302            |                              | 35 12                         | EXC14CH350U  | 0302      | 35 Ω                          | 1                  | EZAEG2N50AX | 0402        | 2                | 2               |   |             |      |   |
|              |                 | 2 line                       |                               | EXC14CE900U  | 0302      | 90 Ω                          | 1                  | EZAEG1N50AC | 0201        | 2                | 1)*1            |   |             |      |   |
| EXC14CS900U  | 0302            |                              | 90 Ω                          | EXC14CE900U  | 0302      | 90 Ω                          | 1                  | EZAEG2N50AX | 0402        | 2                | ②*1             |   |             |      |   |
|              |                 |                              | 90 12                         | EXC24CH900U  | 0504      | 90 Ω                          | 1                  | EZAEG1N50AC | 0201        | 2                | 3               |   |             |      |   |
|              |                 |                              |                               | EXC24CH900U  | 0504      | 90 Ω                          | 1                  | EZAEG2N50AX | 0402        | 2                | 4               |   |             |      |   |
|              |                 | - Z IIIIe                    |                               | EXC24CH500U  | 0504      | 50 Ω                          | 1                  | EZAEG1N50AC | 0201        | 2                | 1               |   |             |      |   |
| EV0040005011 | 0504            |                              | 35 Ω                          | EXC24CH500U  | 0504      | 50 Ω                          | 1                  | EZAEG2N50AX | 0402        | 2                | 2               |   |             |      |   |
| EXC24CS350U  |                 |                              |                               | EXC24CE360UP | 0504      | 36 Ω                          | 1                  | EZAEG1N50AC | 0201        | 2                | ③*1             |   |             |      |   |
|              |                 |                              |                               | EXC24CE360UP | 0504      | 36 Ω                          | 1                  | EZAEG2N50AX | 0402        | 2                | <b>4</b> *1     |   |             |      |   |
| EVC24CC00011 |                 | 0501                         |                               |              |           | 0504                          |                    | 90 Ω        | EXC24CH900U | 0504             | 90 Ω            | 1 | EZAEG1N50AC | 0201 | 2 |
| EXC24CS900U  | 0504            |                              | 90 12                         | EXC24CH900U  | 0504      | 90 Ω                          | 1                  | EZAEG2N50AX | 0402        | 2                | 2               |   |             |      |   |
| EVC400035011 | 0000            |                              | 25.0                          | EXC14CH350U  | 0302      | 35 Ω                          | 2                  | EZAEG1N50AC | 0201        | 4                | 1 *2            |   |             |      |   |
| EXC18CS350U  | 0603            |                              | 35 Ω                          | EXC14CH350U  | 0302      | 35 Ω                          | 2                  | EZAEG2N50AX | 0402        | 4                | ②*2             |   |             |      |   |
|              |                 | 4.11                         |                               | EXC18CE900U  | 0603      | 90 Ω                          | 1                  | EZAEG1N50AC | 0201        | 4                | ①*1             |   |             |      |   |
| EV0400000011 | 0000            | 4 line                       | 00.0                          | EXC18CE900U  | 0603      | 90 Ω                          | 1                  | EZAEG2N50AX | 0402        | 4                | ②*1             |   |             |      |   |
| EXC18CS900U  | 0603            |                              | 90 Ω                          | EXC24CH900U  | 0504      | 90 Ω                          | 2                  | EZAEG1N50AC | 0201        | 4                | ③ <sup>*2</sup> |   |             |      |   |
|              |                 |                              |                               | EXC24CH900U  | 0504      | 90 Ω                          | 2                  | EZAEG2N50AX | 0402        | 4                | <b>4</b> *2     |   |             |      |   |

<sup>\*1:</sup> USB2.0, LVDS(<1Gbps) only

<sup>\*2:</sup> No replacement part number for Array products



# Common Mode Noise Filters 2 Mode Noise Filters EXC14CP type



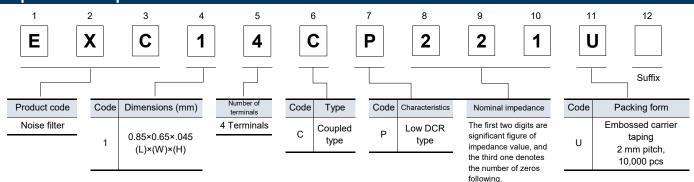
#### **Features**

- Small size and low-profile: 0302 inch size (L 0.85 mm×W 0.65 mm×H 0.45 mm)
- Burst/radiation noise filtering for audio circuits
- The optimally magnetic-coupled ferrite beads allow for the filtering of both common and normal mode noises
- The strong multi-layer structure provides high resistance to reflow soldering heat and a high mounting reliability
- RoHS compliant

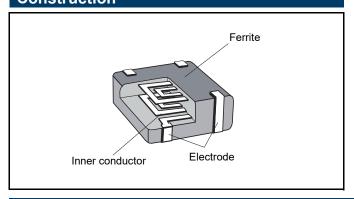
#### **Recommended applications**

- Smart phones, Tablet PCs, DSC and Portable Music Player
- Noise suppression of burst noise of Receiver/Microphone and D-class power amplifier

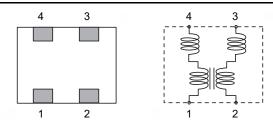
#### **Explanation of part numbers**



#### Construction

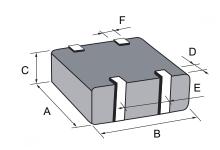


#### Circuit configuration (No polarity)



X The pin numbers shown here are for reference purposes only. Confirm the actual pin number arrangement with the exchanged specification documents.

#### **Dimensions in mm (not to scale)**

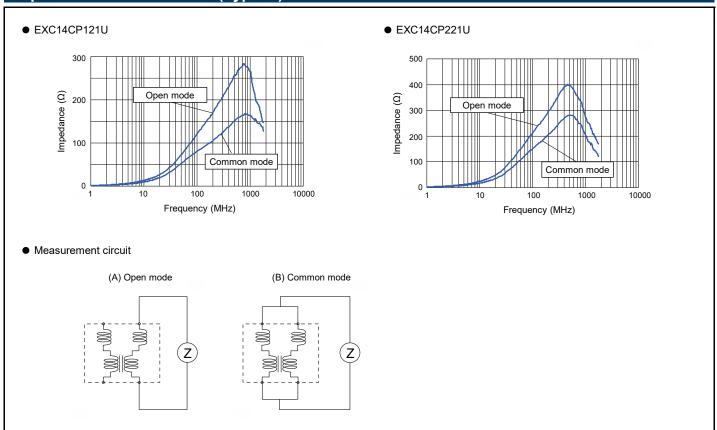


| Part No.       |             | Dimensions  |             |           |             |             |     |  |  |  |
|----------------|-------------|-------------|-------------|-----------|-------------|-------------|-----|--|--|--|
| (inch size)    | Α           | A B C D E F |             |           |             |             |     |  |  |  |
| EXC14CP (0302) | 0.65 ± 0.05 | 0.85 ± 0.05 | 0.45 ± 0.05 | 0.10 min. | 0.50 ± 0.10 | 0.27 ± 0.10 | 1.2 |  |  |  |

| Part number    | Impedance (9 | ն) at 100 MHz | Rated voltage | Rated current | DC resistance |  |
|----------------|--------------|---------------|---------------|---------------|---------------|--|
| i ait iidiibei | Open mode    | Common mode   | (V) DC        | (mA) DC       | (Ω) max.      |  |
| EXC14CP121U    | 120 Ω ± 30 % | 75 Ω ± 25 %   | 5             | 300           | 0.5           |  |
| EXC14CP221U    | 220 Ω ± 30 % | 140 Ω ± 25 %  | 3             | 200           | 0.7           |  |

Category temperature range −40 °C to +85 °C

#### Impedance characteristics (Typical)





**INDUSTRY** 

## **Common Mode Noise Filters** 2 Mode Noise Filters

## EXC24CB/CP/CN type



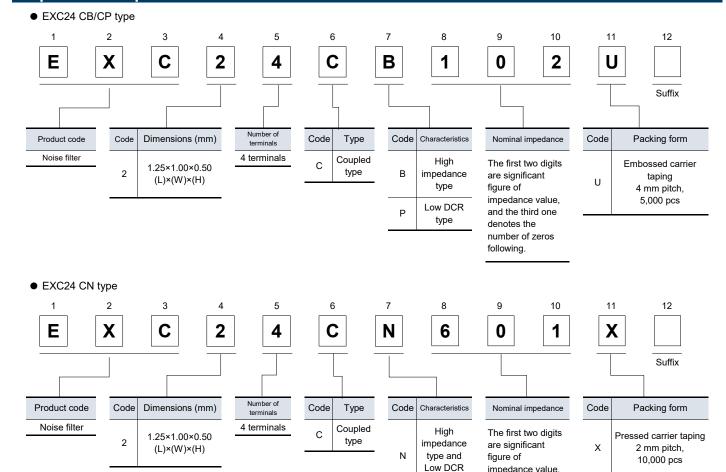
#### **Features**

- Burst/radiation noise filtering for audio circuits
- The optimally magnetic-coupled ferrite beads allow for the filtering of both common and normal mode noises
- The strong multi-layer structure provides high resistance to reflow soldering heat and a high mounting reliability
- Magnetic shield type
- High Impedance : 220 to 1 kΩ (EXC24CB type)
- Low Resistance Value: 0.4 Ω max. (EXC24CP type)
- High Impedance : 600 Ω, Low Resistance Value : 0.9 Ω max. (EXC24CN type)
- RoHS compliant

#### **Recommended applications**

- Smart phones, Tablet PCs, DSC and Portable Music Player
- Noise suppression of burst noise of Receiver/Microphone and D-class power amplifier

#### **Explanation of part numbers**



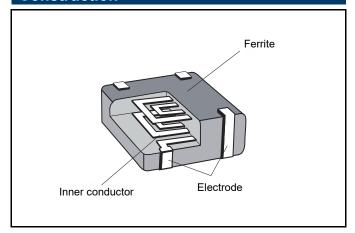
impedance value,

and the third one denotes the number of zeros following.

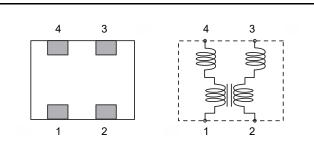
type

## 2 Mode Noise Filters EXC24CB/CP/CN type

## Construction

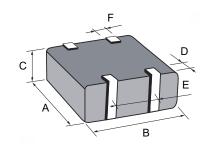


## **Circuit configuration (No polarity)**



X The pin numbers shown here are for reference purposes only. Confirm the actual pin number arrangement with the exchanged specification documents.

## Dimensions in mm (not to scale)



Unit : mm

| Part No.    |             | Mass (Weight) |             |             |             |             |     |  |
|-------------|-------------|---------------|-------------|-------------|-------------|-------------|-----|--|
| (inch size) | Α           | A B C D E F   |             |             |             |             |     |  |
| EXC24C      | 1.00 ± 0.15 | 1.25 ± 0.15   | 0.50 ± 0.10 | 0.20 ± 0.15 | 0.65 ± 0.10 | 0.35 ± 0.10 | 3.0 |  |

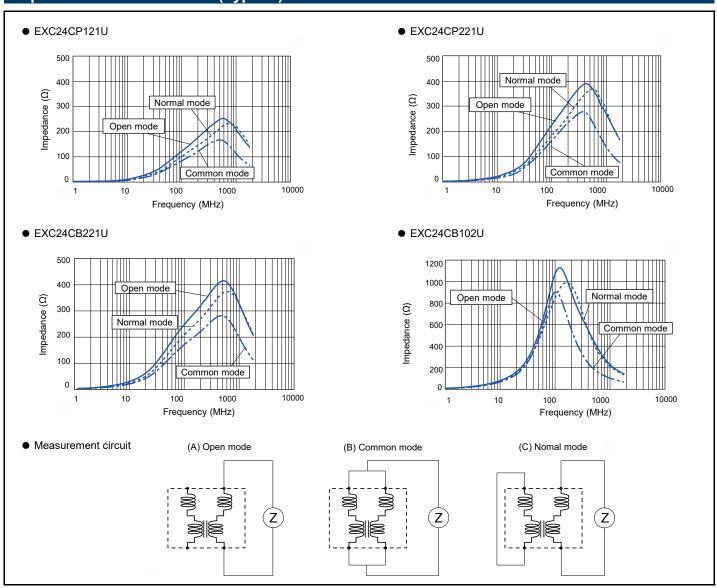
## Ratings

| Part number    | Impedance      | (Open mode)   | Rated voltage | Rated current | DC resistance |
|----------------|----------------|---------------|---------------|---------------|---------------|
| rait ilullibei | (Ω) at 100 MHz | Tolerance (%) | (V) DC        | (mA) DC       | (Ω) max.      |
| EXC24CP121U    | 120            |               |               | 500           | 0.3           |
| EXC24CP221U    | 220            | ± 25          | E             | 350           | 0.4           |
| EXC24CB221U    | 220            | ± 23          | 3             | 100           | 0.7           |
| EXC24CB102U    | 1000           |               |               | 50            | 1.5           |

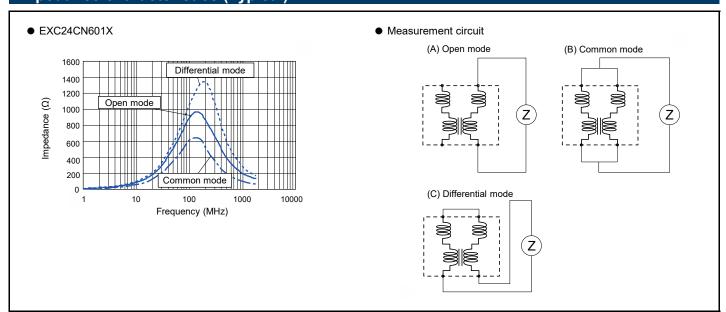
| Part number | Impedance (C   | Common mode)  | Rated voltage | Rated current | DC resistance |
|-------------|----------------|---------------|---------------|---------------|---------------|
|             | (Ω) at 100 MHz | Tolerance (%) | (V) DC        | (mA) DC       | (Ω) max.      |
| EXC24CN601X | 600            | ± 25          | 5             | 200           | 0.9           |

● Category temperature range -40 °C to +85 °C

#### Impedance characteristics (Typical)



#### Impedance characteristics (Typical)

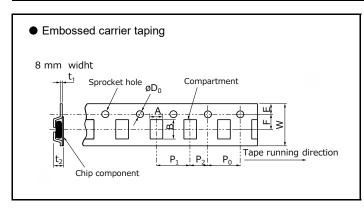


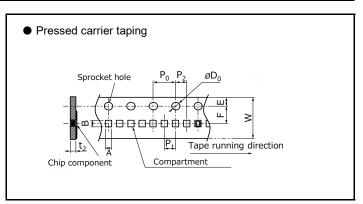
## 2 Mode Noise Filters / Packaging methods

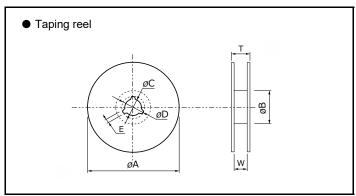
## Packaging methods (Taping)

#### Standard quantity

| Part number        | Size (inch) | Kind of taping          | Pitch (P <sub>1</sub> ) (mm) | Quantity (pcs / reel) |
|--------------------|-------------|-------------------------|------------------------------|-----------------------|
| EXC14CP□□□U        | 0302        | Embassed carrier tening | 2                            | 10,000                |
| EXC24CP/CB   □ □ U | 0504        | Embossed carrier taping | 4                            | 5,000                 |
| EXC24CN            | 0504        | Pressed carrier taping  | 2                            | 10,000                |







#### Embossed carrier dimensions

Unit : mm

| Part number | Α         | В         | W       | F         | Е         | P <sub>1</sub> | P <sub>2</sub> | $P_0$   | $\phi D_0$ | t <sub>1</sub> | t <sub>2</sub> |
|-------------|-----------|-----------|---------|-----------|-----------|----------------|----------------|---------|------------|----------------|----------------|
| EXC14CP     | 0.75±0.10 | 0.95±0.10 | 8.0±0.2 | 3.50±0.05 | 1.75±0.10 | 2.0±0.1        | 2.0±0.1        | 4.0±0.1 | 1.5 +0.1 0 | 0.25±0.05      | 0.85±0.15      |
| EXC24CP     | 1 20+0 15 | 1.45±0.15 | 8.0±0.2 | 3.50±0.10 | 1.75±0.10 | 4.0±0.1        | 2.0±0.1        | 4.0±0.1 | 1.5 +0.1   | 0.25±0.05      | 0.90±0.15      |
| EXC24CB     | 1.20±0.15 | 1.45±0.15 | 0.0±0.2 | 3.50±0.10 | 1.75±0.10 | 4.0±0.1        | 2.0±0.1        | 4.0±0.1 | 1.5        | 0.23±0.03      | 0.90±0.13      |

#### Pressed carrier dimensions

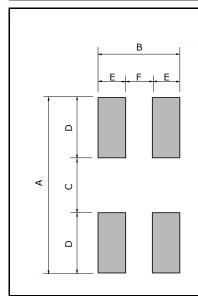
Unit : mm

| Part number | Α         | В         | W       | F       | E         | P <sub>1</sub> | P <sub>2</sub> | P <sub>0</sub> | $\phi D_0$ | t <sub>2</sub> |
|-------------|-----------|-----------|---------|---------|-----------|----------------|----------------|----------------|------------|----------------|
| EXC24CN     | 1.14±0.10 | 1.38±0.15 | 8.0±0.2 | 3.5±0.1 | 1.75±0.10 | 2.0±0.1        | 2.0±0.1        | 4.0±0.1        | 1.5 +0.1   | 0.68±0.10      |

#### Standard reel dimensions

| Part number | øΑ        | øΒ       | øС       | øD       | E       | W       | Т        |  |
|-------------|-----------|----------|----------|----------|---------|---------|----------|--|
| <br>EXC14C  | 180.0±3.0 | 60.0±1.0 | 13.0±0.5 | 21.0±0.8 | 2.0±0.5 | 9.0±0.3 | 11.4±1.5 |  |
| EXC24C      | 100.0±3.0 | 00.0±1.0 | 13.0±0.5 | 21.0±0.6 | 2.0±0.5 | 9.0±0.3 | 11.4±1.5 |  |

## Recommended land pattern design



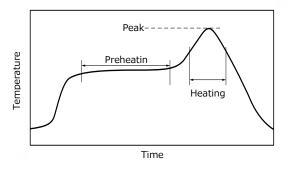
|             |                 |      |      |                 |      | Unit : mm |  |  |  |  |  |
|-------------|-----------------|------|------|-----------------|------|-----------|--|--|--|--|--|
| Part number | Dimensions      |      |      |                 |      |           |  |  |  |  |  |
| Part Humber | Α               | В    | С    | D               | Е    | F         |  |  |  |  |  |
| EXC14CP     | 0.80 to<br>1.00 | 0.80 | 0.30 | 0.25 to<br>0.35 | 0.30 | 0.20      |  |  |  |  |  |
| EXC24CP     | 1.50 to         |      |      | 0.50 to         |      |           |  |  |  |  |  |
| EXC24CB     | 1.90            | 1.10 | 0.50 | 0.30 to         | 0.40 | 0.30      |  |  |  |  |  |
| EXC24CN     | 1.90            |      |      | 0.70            |      |           |  |  |  |  |  |

#### **Recommended soldering conditions**

Recommendations and precautions are described below

#### Recommended soldering conditions for reflow

- Reflow soldering shall be performed a maximum of two times.
- Please contact us for additional information when used in conditions other than those specified.
- Please measure the temperature of the terminals and study every kind of solder and printed circuit board for solderability before actual use.



#### For soldering (Example: Sn-37Pb)

|              | Temperature    | Time          |
|--------------|----------------|---------------|
| Preheating   | 140 ℃ to 160 ℃ | 60 s to 120 s |
| Main heating | Above 200 ℃    | 30 s to 40 s  |
| Peak         | 235 ± 10 °C    | max. 10 s     |

#### For lead-free soldering (Example :Sn-3Ag-0.5Cu)

| Temperature    | Time                          |
|----------------|-------------------------------|
| 150 ℃ to 170 ℃ | 60 s to 120 s                 |
| Above 230 ℃    | 30 s to 40 s                  |
| max. 260 ℃     | max. 10 s                     |
|                | 150 ℃ to 170 ℃<br>Above 230 ℃ |

#### Flow soldering

·We do not recommend flow soldering, because flow soldering may cause bridges between the electrodes.

《Repair with hand soldering》

- Preheat with a blast of hot air or similar method. Use a soldering iron with a tip temperature of 350 °C or less.
   Solder each electrode for 3 seconds or less.
- Never touch this product with the tip of a soldering iron.

## **Common Mode Noise Filters / Common perfomance**

| Perfomance                   |                            |   |
|------------------------------|----------------------------|---|
| Test item                    | Performance requirements   | Test conditions resistance                      |
| Resistance                   | Within specified tolerance | 25 ℃  |
| Overload                     | _                          | Rated voltage                                   |
| Resistance to soldering heat | ±30 % (Impedance change)   | 260 ℃, 10 s                                     |
| Rapid change of temperature  | ±30 % (Impedance change)   | -40 °C (30 min.) / +85 °C (30 min.), 200 cycles |
| High temperature exposure    | ±30 % (Impedance change)   | 85 ℃ , 500 h                                    |
| Damp heat,<br>Steady state   | ±30 % (Impedance change)   | 60 ℃, 95 %RH, 500 h                             |
| Load life in humidity        | ±30 % (Impedance change)   | 60 ℃, 95 %RH, Rated current, 500 h              |



## Application Guidelines (ESD Suppressor)

## Safety precautions

- When using our products, no matter what sort of equipment they might be used for, be sure to make a written agreement on the specifications with us in advance. The design and specifications in this catalog are subject to change without prior notice.
- Do not use the products beyond the specifications described in this catalog.
- This catalog explains the quality and performance of the products as individual components. Before use, check and evaluate their operations when installed in your products under the actual conditions for use.
- Install the following systems for a failsafe design to ensure safety if these products are to be used in equipment
  where a defect in these products may cause the loss of human life or other significant damage, such as
  damage to vehicles (automobile, train, vessel), traffic lights, medical equipment, aerospace equipment,
  electric heating appliances, combustion/gas equipment, rotating equipment, and disaster/crime prevention
  equipment.
  - \* Systems equipped with a protection circuit and a protection device.
  - \* Systems equipped with a redundant circuit or other system to prevent an unsafe status in the event of a single fault.
  - \* Systems equipped with an arresting the spread of fire or preventing glitch.

#### **Precautions for use**

- These products are designed and manufactured for general and standard use in general electronic equipment. (e.g. AV equipment, home electric appliances, office equipment, information and communication equipment) For applications in which special quality and reliability are required, or if the failure or malfunction of the products may directly jeopardize life or cause threat of personal injury (such as for aircraft and aerospace equipment, traffic and transport equipment, combustion equipment, medical equipment, accident prevention and anti-theft devices, and safety equipment), please be sure to consult with our sales representative in advance and to exchange product specifications which conform to such applications.
- These products are not intended for use in the following special conditions. Before using the products, carefully check the effects on their quality and performance, and determine whether or not they can be used.
  - 1. In liquid, such as water, oil, chemicals, or organic solvent.
  - 2. In direct sunlight, outdoors, or in dust.
  - 3. In salty air or air with a high concentration of corrosive gas, such as  $Cl_2$ ,  $H_2S$ ,  $NH_3$ ,  $SO_2$ , or  $NO_X$ .
  - Electromagnetic and Radioactive Environment.
     Avoid any environment where strong electromagnetic waves and radiation exist.
  - 5. In an environment where these products cause dew condensation.
  - 6. Sealing or coating of these products or a printed circuit board on which these products are mounted, with resin or other materials.
- These products generate Joule heat when energized. Carefully position these products so that their heat will not affect the other components.
- Carefully position these products so that their temperatures will not exceed the category temperature range
  due to the effects of neighboring heat-generating components. Do not mount or place heat-generating
  components or inflammables, such as vinyl-coated wires, near these products.
- Note that non-cleaning solder, halogen-based highly active flux, or water-soluble flux may deteriorate the performance or reliability of the products.
- Carefully select a flux cleaning agent for use after soldering. An unsuitable agent may deteriorate the
  performance or reliability. In particular, when using water or a water-soluble cleaning agent, be careful not to
  leave water residues. Otherwise, the insulation performance may be deteriorated.
- Do not apply flux to these products after soldering. The activity of flux may be a cause of failures in these products.
- Refer to the recommended soldering conditions and set the soldering condition. High peak temperature or long heating time may impair the performance or the reliability of these products.
- Recommended soldering condition is for the guideline for ensuring the basic characteristics of the products, not for the stable soldering conditions. Conditions for proper soldering should be set up according to individual conditions.
- Do not reuse any products after removal from mounting boards.
- Do not drop these products. If these products are dropped, do not use them. Such products may have received mechanical or electrical damage.
- If any doubt or concern to the safety on these products arise, make sure to inform us immediately and conduct technical examinations at your side.



### **Precautions for storage**

The performance of these products, including the solderability, is guaranteed for a year from the date of arrival at your company, provided that they remain packed as they were when delivered and stored at a temperature of 5 °C to 35 °C and a relative humidity of 45 % to 85 %.

Even within the above guarantee periods, do not store these products in the following conditions. Otherwise, their electrical performance and/or solderability may be deteriorated, and the packaging materials (e.g. taping materials) may be deformed or deteriorated, resulting in mounting failures.

- 1. In salty air or in air with a high concentration of corrosive gas, such as Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, or NO<sub>X</sub>.
- 2. In direct sunlight.

<Package markings>

Package markings include the product number, quantity, and country of origin.

In principle, the country of origin should be indicated in English.

#### **Precaution specific to this product**

- 1. If a large electric surge (especially, one which is larger than an ESD) is expected to be applied, be sure to test and confirm proper ESD Suppressor (hereafter called the suppressors) functionality when mounted on your board. When the applied load is more than the allowable rated power under normal load conditions, it may impair performance and/or the reliability of the suppressors. Never exceed the rated power. If the product will be used under these special conditions, be sure to contact a Panasonic representative first.
- 2. Do not use halogen-based or other high-activity flux. Otherwise, the residue may impair the suppressors' performance and/or reliability.
- 3. When soldering with a soldering iron, never touch the suppressors' bodies with the tip of the soldering iron. When using a soldering iron with a high temperature tip, finish soldering as quickly as possible (within three seconds at 350 °C max.).
- 4. Mounting of the suppressors with excessive or insufficient wetting amount of solder may affect the connection reliability or the performance of the suppressors. Carefully check the effects and apply a proper amount of solder for use.
- 5. When the suppressors' protective coatings are chipped, flawed, or removed, the characteristics of the suppressors may be impaired. Take special care not to apply mechanical shock during automatic mounting or cause damage during handling of the boards with the suppressors mounted
- 6. Do not apply shock to the suppressors or pinch them with a hard tool (e.g. pliers and tweezers). Otherwise, the suppressors' protective coatings and bodies may be chipped, affecting their performance.
- 7. Avoid excessive bending of printed circuit boards in order to protect the suppressors from abnormal stress.
- 8. Do not immerse the suppressors in solvent for a long time. Before using solvent, carefully check the effects of immersion.
- 9. Do not apply excessive tension to the terminals.

#### AEC-Q200 Compliant (ESD Suppressor, High withstanding type)

The products are tested based on all or part of the test conditions and methods defined in AEC-Q200. Please consult with Panasonic for the details of the product specification and specific evaluation test results, etc., and please review and approve Panasonic's product specification before ordering.

## **Panasonic**

**INDUSTRY** 

## **ESD Suppressor**

## EZAEG 2A, 3A type



- Don't use these products in the engine room.
- Don't use these products in any driving applications or any other critial functions that may affect passanger's sagety. (e.g. Power train, ABS, Engine ECU, Air bag, and so on.)
- Don't use these products in applications related to the autonomous driving equipment with system level 3 or higher.

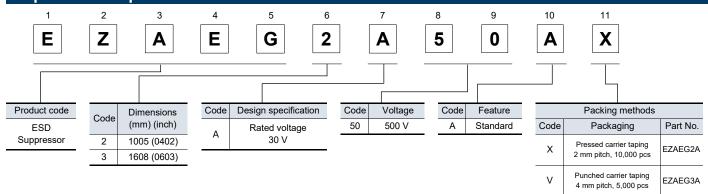
#### **Features**

- ESD protection of high-speed data lines
- Low capacitance [1005 (0402) size: 0.05 pF, 1608 (0603) size: 0.10 pF]
- Good ESD suppression characteristics
- Good ESD withstanding
- RoHS compliant

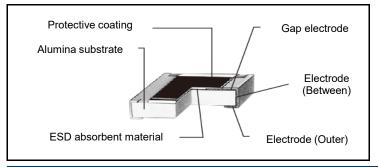
#### **Recommended applications**

- Smart phones, Mobile phones, RF Modules, NFC and GPS
- ESD suppresion of high-speed differential data line such as Antena circuit, HDMI, SATA, USB, Display Port

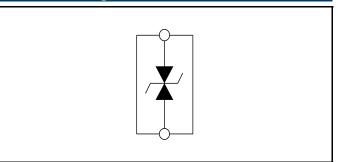
#### **Explanation of part numbers**



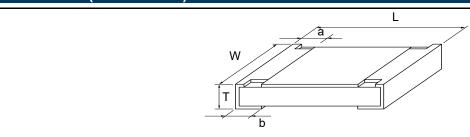
#### Construction



#### Circuit configuration



#### **Dimensions (not to scale)**



| Part No.       |             | Mass (Weight) |                 |                 |             |     |
|----------------|-------------|---------------|-----------------|-----------------|-------------|-----|
| (inch size)    | L           | L W a b T     |                 |                 |             |     |
| EZAEG2A (0402) | 1.00 ± 0.10 | 0.50 ± 0.05   | 0.20 ± 0.10     | 0.25 ± 0.10     | 0.38 ± 0.05 | 0.6 |
| EZAEG3A (0603) | 1.60 ± 0.15 | 0.80 ± 0.15   | $0.30 \pm 0.20$ | $0.30 \pm 0.20$ | 0.50 ± 0.10 | 2.2 |

| Ratings     |                     |               |                            |
|-------------|---------------------|---------------|----------------------------|
| Part number | Capacitance *1 (pF) | Rated voltage | Category temperature range |
| EZAEG2A50AX | 0.05 +0.05 -0.04    | 30 V max.     | –55 °C to +125 °C          |
| EZAEG3A50AV | 0.10 +0.10          | 30 V IIIAX.   | -55 C to +125 C            |

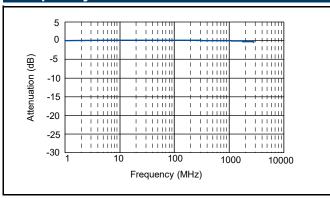
<sup>\*1:</sup> Capacitance = The capacitance value shall be measured under the conditions specified below.

Frequency : 1 MHz  $\pm$  10 %, Voltage : 1 Vrms  $\pm$  0.2 Vrms, Temperature : 25  $^{\circ}$ C $\pm$  2  $^{\circ}$ C

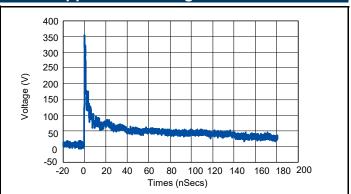
#### **Perfomance**

| Test item                    | Performance requirements    | Test conditions  |
|------------------------------|-----------------------------|--|
| Peak voltage                 | 500 V max.                  | IEC61000-4-2, contact discharge 8 kV, Peak voltage value                         |
| Clamping voltage             | 100 V max.                  | IEC61000-4-2, contact discharge 8 kV, voltage at 30 ns after initiation of pulse |
| Leakage current              | 1 μA max.                   | Current at rated voltage (DC 30 V)   |
| ESD withstanding             |                             | IEC61000-4-2, contact discharge 8 kV, +/- 10 times                               |
| Rapid change of temperature  | 1 1                         | -55 ℃ (30 min.) /+125 ℃ (30 min.), 100 cycles                                    |
| Load life in humidity        | Leakage current  10 µA max. | 60 ℃, 90 % to 95 %RH, Rated voltage, 1000 h                                      |
| Endurance at 85 ℃            | το μα πιαχ.                 | 85 ℃, Rated voltage, 1000 h  |
| Resistance to soldering heat |                             | 270 ℃, 10 s  |

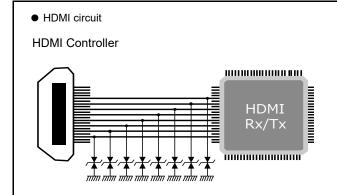
#### **Frequency characteristics**



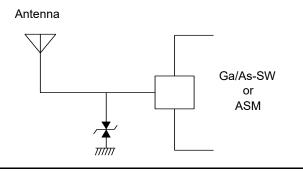
#### **ESD Suppression voltage waveform**



#### Typical circuits requiring protection

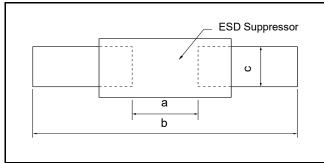


#### Antenna circuit



#### **Recommended land pattern**

Recommended land pattern design for ESD Suppressor is shown below.



Unit : mm

| Part number | Dimensions |            |            |  |  |
|-------------|------------|------------|------------|--|--|
| Fait Humber | а          | b          | С          |  |  |
| EZAEG2A     | 0.5 to 0.6 | 1.4 to 1.6 | 0.4 to 0.6 |  |  |
| EZAEG3A     | 0.7 to 0.9 | 2.0 to 2.2 | 0.8 to 1.0 |  |  |

## **Panasonic**

**INDUSTRY** 

## **ESD Suppressor**

## EZAEG 1N, 2N type



- Don't use these products in the engine room.
- Don't use these products in any driving applications or any other critial functions that may affect passanger's sagety. (e.g. Power train, ABS, Engine ECU, Air bag, and so on.)
- Don't use these products in applications related to the autonomous driving equipment with system level 3 or higher.

#### **Features**

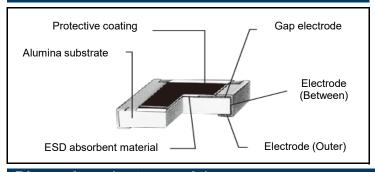
- Good ESD withstanding (IEC61000-4-2 15 kV contact/air Discharge)
- ESD protection of high-speed data lines
- Low capacitance [0603 (0201) size: 0.04 pF, 1005(0402) size: 0.05 pF]
- Good ESD suppression characteristics
- RoHS compliant

## Recommended applications

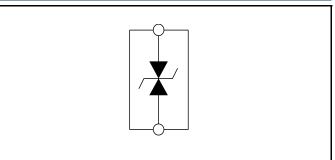
- Smart phones, Mobile phones, RF Modules, NFC and GPS
- ESD suppresion of high-speed differential data line such as Antena circuit, HDMI, SATA, USB, Display Port

#### Explanation of part numbers 1 2 3 4 5 6 8 10 11 Ε Ζ Α Ε G 2 5 0 Α Product code Voltage Feature Part No. Code Design specification Code Code Code Dimensions Packaging Code (mm) (inch) 500 V 50 Standard Pressed carrier taping ESD withstanding C EZAEG1N 2 mm pitch, 15,000 pcs Suppressor 0603 (0201) Ν Rated voltage 2 1005 (0402) Pressed carrier taping Х EZAEG2N 30 V 2 mm pitch, 10,000 pcs

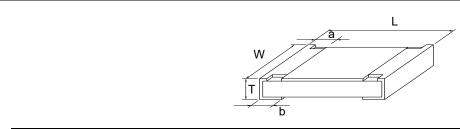
#### Construction



#### **Circuit configuration**



#### **Dimensions (not to scale)**



| Part No.<br>(inch size) |                 | Mass (Weight)<br>(g/1000 pcs) |             |             |             |              |
|-------------------------|-----------------|-------------------------------|-------------|-------------|-------------|--------------|
| (IIICII SIZE)           | L               | W                             | а           | b           | Т           | (g/1000 pcs) |
| EZAEG1N (0201)          | $0.60 \pm 0.03$ | $0.30 \pm 0.03$               | 0.15 ± 0.10 | 0.15 ± 0.10 | 0.23 ± 0.03 | 0.12         |
| EZAEG2N (0402)          | 1.00 ± 0.10     | 0.50 ± 0.05                   | 0.20 ± 0.10 | 0.27 ± 0.10 | 0.38 ± 0.05 | 0.60         |

| Ratings     |                     |               |                            |
|-------------|---------------------|---------------|----------------------------|
| Part number | Capacitance *1 (pF) | Rated voltage | Category temperature range |
| EZAEG1N50AC | 0.04 +0.04 -0.03    | 30 V max.     | –55 °C to +125 °C          |
| EZAEG2N50AX | 0.05 +0.05          | 30 V IIIAX.   | -55 C to +125 C            |

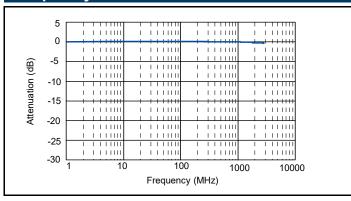
<sup>\*1:</sup> Capacitance = The capacitance value shall be measured under the conditions specified below.

Frequency: 1 MHz ± 10 %, Voltage: 1 Vrms ± 0.2 Vrms, Temperature: 25 ℃± 2 ℃

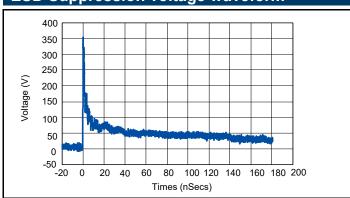
#### Perfomance

| 1 CHOMANCC                   |   |  |
|------------------------------|---|--|
| Test item                    | Performance requirements  | Test conditions  |
| Peak voltage                 | 500 V max.  | IEC61000-4-2, contact discharge 8 kV, Peak voltage value                   |
| Clamping voltage             | ing voltage 100 V max. IEC61000-4-2, contact discharge 8 kV, voltage at 30 ns after initiation of |  |
| Leakage current              | 1 μA max.   | Current at rated voltage (DC 30 V)   |
| ESD withstanding             |   | IEC61000-4-2, contact discharge 15 kV or air discharge 15 kV, +/- 50 times |
| Rapid change of temperature  |   | -55 ℃ (30 min.) /+125 ℃ (30 min.), 100 cycles                              |
| Load life in humidity        | Leakage current 10 µA max.  | 60 °C, 90 % to 95 %RH, Rated voltage, 1000 h                               |
| Endurance at 85 ℃            | το μα πιαλ.   | 85 ℃, Rated voltage, 1000 h  |
| Resistance to soldering heat |   | 270 ℃, 10 s  |

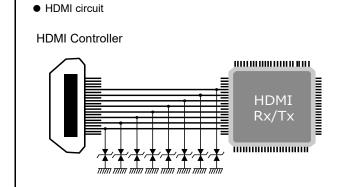
#### **Frequency characteristics**



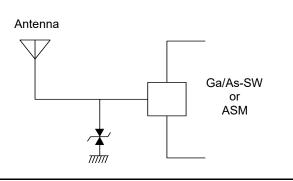
#### **ESD Suppression voltage waveform**



#### Typical circuits requiring protection

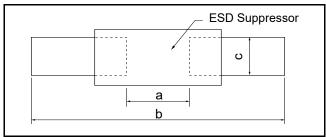


#### Antenna circuit



#### **Recommended land pattern**

Recommended land pattern design for ESD Suppressor is shown below.



Unit : mm

| Part number    | Dimensions |            |              |  |  |
|----------------|------------|------------|--------------|--|--|
| Fait ilullibei | а          | b          | С            |  |  |
| EZAEG1N        | 0.3 to 0.4 | 0.8 to 0.9 | 0.25 to 0.35 |  |  |
| EZAEG2N        | 0.5 to 0.6 | 1.4 to 1.6 | 0.40 to 0.60 |  |  |

## **Panasonic**

INDUSTRY

## **ESD Suppressor Array**

## **EZAEG CA type**

- Don't use these products in the engine room.
- Don't use these products in any driving applications or any other critial functions that may affect passanger's sagety. (e.g. Power train, ABS, Engine ECU, Air bag, and so on.)
- Don't use these products in applications related to the autonomous driving equipment with system level 3 or higher.

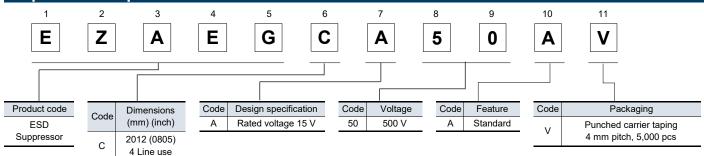
#### **Features**

- 4 ESD suppressors in one package
- ESD protection of high-speed data lines
- Low capacitance (0.25 pF)
- Good ESD suppression characteristics
- Good ESD withstanding
- RoHS compliant

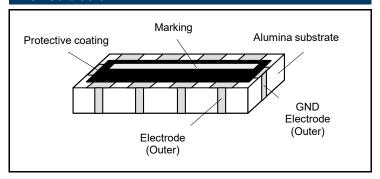
#### **Recommended applications**

- AV equipment (LCD-TV, DVD/Blu-ray drives), Information equipment (PCs, HDD)
- ESD suppresion of high-speed differential data line such as USB3.0, HDMI, Display Port

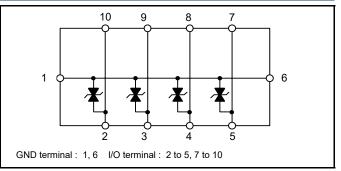
#### **Explanation of part numbers**



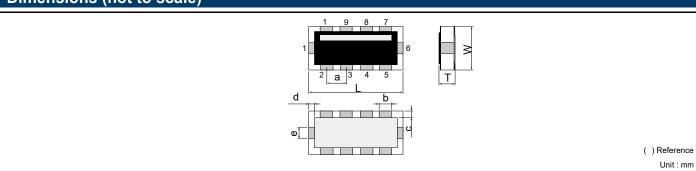
#### Construction



## Circuit configuration



#### **Dimensions (not to scale)**



| Part No.              | Dimensions |             |       |             |             |             |             | Mass<br>(Weight) |              |
|-----------------------|------------|-------------|-------|-------------|-------------|-------------|-------------|------------------|--------------|
| (inch size)           | L          | W           | а     | b           | С           | d           | е           | Т                | (g/1000 pcs) |
| EZAEGCA50AV<br>(0805) | 2.0 ± 0.1  | 1.25 ± 0.10 | (0.5) | 0.30 ± 0.15 | 0.25 ± 0.15 | 0.20 ± 0.15 | 0.35 ± 0.15 | 0.50 ± 0.10      | 4.0          |

|             |                     |                  |                  | <u> </u>                   |
|-------------|---------------------|------------------|------------------|----------------------------|
| Part number | Capacitance *1 (pF) | Rated voltage *2 | Rated current *3 | Category temperature range |
| EZAEGCA50AV | 0.25 +0.05          | 15 V max.        | 100 mA max.      | –55 °C to +125 °C          |

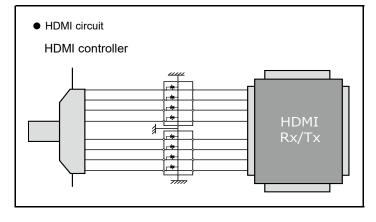
<sup>\*1:</sup> Capacitance = The capacitance value shall be measured under the conditions specified below.

Frequency : 1 MHz  $\pm$  10 %, Voltage : 1 Vrms  $\pm$  0.2 Vrms, Temperature : 25  $^{\circ}$ C $\pm$  2  $^{\circ}$ C

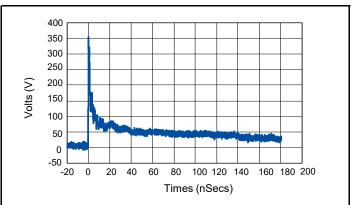
#### **Perfomance**

| Test item                    | Performance requirements      | Test conditions  |  |
|------------------------------|-------------------------------|--|--|
| Peak voltage                 | 500 V max.                    | IEC61000-4-2, contact discharge 8 kV, Peak voltage value                         |  |
| Clamping voltage             | 100 V max.                    | IEC61000-4-2, contact discharge 8 kV, voltage at 30 ns after initiation of pulse |  |
| Leakage current              | 1 μA max.                     | Current at Rated voltage (DC 15 V)   |  |
| ESD withstanding             |                               | IEC61000-4-2, contact discharge 8 kV, +/- 10 times                               |  |
| Rapid change of temperature  | Leakage current<br>10 μA max. | -55 ℃ (30 min.) /+125 ℃ (30 min.), 100 cycles                                    |  |
| Load life in humidity        |                               | 60 ℃, 90 % to 95 %RH, Rated voltage, 1000 h                                      |  |
| Endurance at 85 ℃            |                               | 85 ℃, Rated voltage, 1000 h  |  |
| Resistance to soldering heat |                               | 270 ℃, 10 s  |  |

## Typical circuits requiring protection

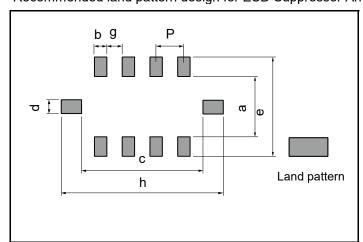


## ESD Suppression voltage waveform



#### Recommended land pattern

Recommended land pattern design for ESD Suppressor Array is shown below.



|            |      |      | Unit : mm |  |  |
|------------|------|------|-----------|--|--|
| Dimensions |      |      |           |  |  |
| а          | b    | С    | d         |  |  |
| 0.75       | 0.25 | 1.70 | 0.35      |  |  |

| Dimensions |      |      |      |  |  |
|------------|------|------|------|--|--|
| е          | h    | g    | Р    |  |  |
| 1.85       | 2.60 | 0.25 | 0.50 |  |  |

<sup>\*2:</sup> Rated voltage between I/O terminal and GND.

<sup>\*3:</sup> Rated current between input terminal and output terminal.



## **ESD Suppressor / High withstanding products**

## **EZAEG 3W type**

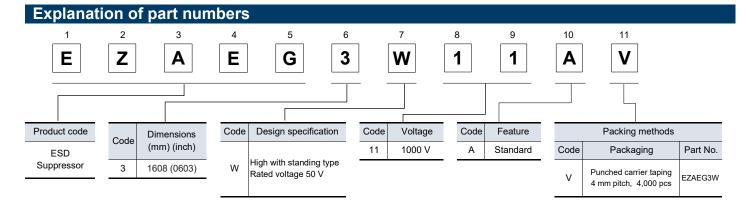


#### **Features**

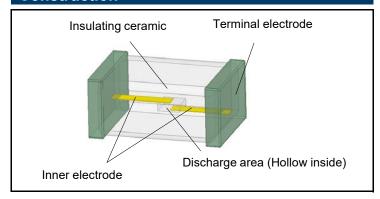
- Excellent ESD withstanding(Conforms with automotive ESD standards (ISO10605, air discharge 25 kV)
- Low capacitance 1608 (0603) size: 0.10 pF
- High rated voltage (DC 50 V) contributes to reduce the risk of communication error
- AEC-Q200 compliant
- RoHS compliant

#### **Recommended applications**

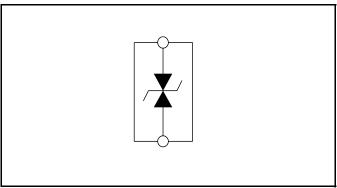
- High speed data line for automotive (CAN, Ethernet, USB, LVDS)
- Automotive antenna
- Amusement eqipment



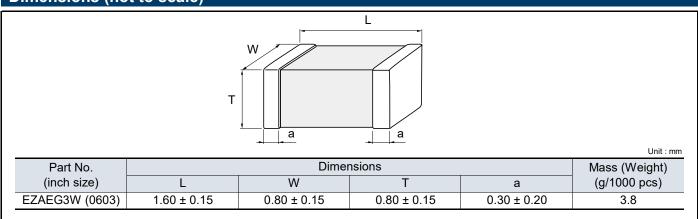
#### Construction



## Circuit configuration



#### **Dimensions (not to scale)**



# High withstanding products / EZAEG 3W type

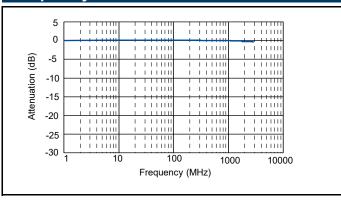
| Ratings     |                                |               |                            |
|-------------|--------------------------------|---------------|----------------------------|
| Part number | Capacitance <sup>*1</sup> (pF) | Rated voltage | Category temperature range |
| EZAEG3W11AV | 0.10 +0.10                     | 50 V max.     | –55 °C to +125 °C          |

<sup>\*1:</sup> Capacitance = The capacitance value shall be measured under the conditions specified below.

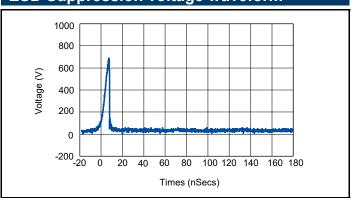
Frequency : 1 MHz  $\pm$  10 %, Voltage : 1 Vrms  $\pm$  0.2 Vrms, Temperature : 25  $^{\circ}$ C $\pm$  2  $^{\circ}$ C

| Perfomance                   |                               |   |
|------------------------------|-------------------------------|---|
| Test item                    | Performance requirements      | Test conditions                                   |
| Peak voltage                 | 1000 V max.                   | ISO10605, air discharge 15 kV, Peak voltage value |
| Leakage current              | 1 μA max.                     | Current at Rated voltage (DC 50 V)                |
| ESD withstanding             |                               | ISO10605, air discharge 25 kV, +/- 50 times       |
| Rapid change of temperature  | Lookogo ourront               | -55 °C (30 min.) /+125 °C (30 min.), 100 cycles   |
| Load life in humidity        | Leakage current<br>10 µA max. | 85 ℃, 85 %RH, Rated voltage, 1000 h               |
| Endurance at 125 ℃           |                               | 125 ℃, Rated voltage, 1000 h                      |
| Resistance to soldering Heat |                               | 270 ℃, 10 s                                       |

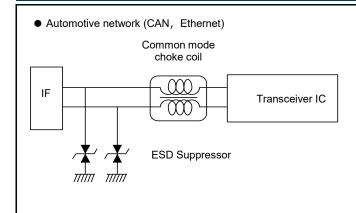
# **Frequency characteristics**



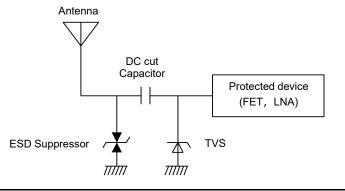
# **ESD Suppression voltage waveform**



# Typical circuits requiring protection

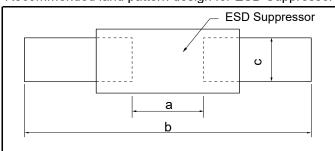


#### Automotive antenna



## **Recommended land pattern**

Recommended land pattern design for ESD Suppressor is shown below.



|          |   |            | 011111 1111111 |
|----------|---|------------|----------------|
| number   |   | Dimensions |                |
| iuiiibei | 3 | h          | 0              |

Part n EZAEG3W 0.8 to 1.0 2.0 to 2.6 0.8 to 1.0

As for packaging methods, soldering conditions and safety precautions, please see data files.

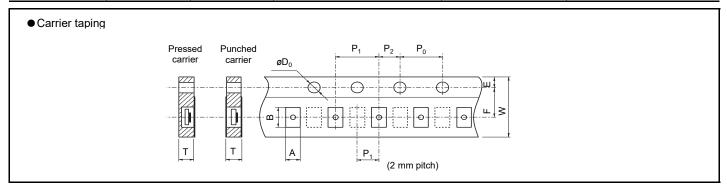
Unit · mm

# ESD Suppressor · Array / Packaging methods

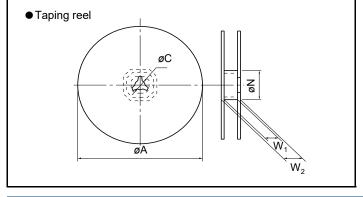
# Packaging methods (Taping)

#### Standard quantity

| Part number | Size (inch) | Туре   | Kind of taping         | Pitch (P <sub>1</sub> ) (mm) | Quantity (pcs / reel) |
|-------------|-------------|--------|------------------------|------------------------------|-----------------------|
| EZAEG1N     | 0201        |        | Pressed carrier taping | 2                            | 15000                 |
| EZAEG2A,2N  | 0402        | Single | Fressed Carrier taping | 2                            | 10000                 |
| EZAEG3A     | 0603        | Single |                        |                              | 5000                  |
| EZAEG3W     | 0603        |        | Punched carrier taping | 4                            | 4000                  |
| EZAEGCA     | 0805        | Array  |                        |                              | 5000                  |



|             |            |           |           |           |           |           |                |                |                |                 | Unit : mm |
|-------------|------------|-----------|-----------|-----------|-----------|-----------|----------------|----------------|----------------|-----------------|-----------|
| Part number | Size(inch) | Α         | В         | W         | F         | Е         | P <sub>1</sub> | P <sub>2</sub> | P <sub>0</sub> | øD <sub>0</sub> | Т         |
| EZAEG1N     | 0201       | 0.38±0.05 | 0.68±0.05 |           |           |           | 2.00±0.10      |                |                |                 | 0.42±0.05 |
| EZAEG2A,2N  | 0402       | 0.70±0.05 | 1.20±0.05 |           |           |           | 2.00±0.10      |                |                |                 | 0.60±0.05 |
| EZAEG3A     | 0603       | 1.10±0.10 | 1.90±0.10 | 8.00±0.20 | 3.50±0.05 | 1.75±0.10 |                | 2.00±0.05      | 4.00±0.10      | 1.5 +0.1        | 0.70±0.05 |
| EZAEG3W     | 0603       | 0.91±0.10 | 1.82±0.10 |           |           |           | 4.00±0.10      |                |                | -               | 1.08±0.10 |
| EZAEGCA     | 0805       | 1.55±0.15 | 2.30±0.20 |           |           |           |                |                |                |                 | 0.85±0.05 |



| Dimensions |           |          |  |  |  |
|------------|-----------|----------|--|--|--|
| øΑ         | øN        | øС       |  |  |  |
| 180.0 0    | 60.0 +1.0 | 13.0±0.2 |  |  |  |

| Dimensions |          |  |  |  |  |
|------------|----------|--|--|--|--|
| $W_1$      | $W_2$    |  |  |  |  |
| 9.0 +1.0   | 11.4±1.0 |  |  |  |  |

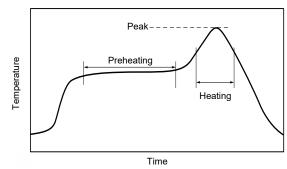
Unit : mm

# **Recommended soldering conditions**

Recommendations and precautions are described below

#### • Recommended soldering conditions for reflow

- · Reflow soldering shall be performed a maximum of two times.
- Please contact us for additional information when used in conditions other than those specified.
- Please measure the temperature of the terminals and study every kind of solder and printed circuit board for solderability before actual use.



#### For soldering (Example : Sn/Pb )

|              | Temperature    | Time          |
|--------------|----------------|---------------|
| Preheating   | 140 ℃ to 160 ℃ | 60 s to 120 s |
| Main heating | Above 200 ℃    | 30 s to 40 s  |
| Peak         | 235 ± 5 ℃      | max. 10 s     |

## For lead-free soldering (Example : Sn/Ag/Cu )

| · · · · · · · · · · · · · · · · · · · |                |               |  |  |  |
|---------------------------------------|----------------|---------------|--|--|--|
|                                       | Temperature    | Time          |  |  |  |
| Preheating                            | 150 ℃ to 180 ℃ | 60 s to 120 s |  |  |  |
| Main heating                          | Above 230 ℃    | 30 s to 40 s  |  |  |  |
| Peak                                  | max. 260 ℃     | max. 10 s     |  |  |  |
|                                       |                |               |  |  |  |





**Application Guidelines** (EZJZ-M, EZJP-M series)

# Handling precautions

- · Do not use the products beyond the descriptions in this product catalog.
- This product catalog guarantees the quality of the products as individual components.
   Before you use the products, please make sure to check and evaluate the products in the circumstance where they are installed in your product.

# Safety precautions

Multilayer Varistors(Automotive Grade) (hereafter referred to as "Varistors") should be used for general purpose applications as countermeasures against ESD and noise found in vehicle electronics (Engine ECU and various body ECU, accessory equipment, etc.) equipment. When subjected to severe electrical, environmental, and/or mechanical stress beyond the specifications, as noted in the Ratings and Specified Conditions section, the Varistors' performance may be degraded, or become failure mode, such as short circuit mode and open-circuit mode. If you use under the condition of short-circuit, heat generation of Varistors will occur by running large current due to application of voltage. There are possibilities of smoke emission, substrate burn-out, and, in the worst case, fire. For products which require high safety levels, please carefully consider how a single malfunction can affect your product. In order to ensure the safety in the case of a single malfunction, please design products with fail-safe, such as setting up protecting circuits, etc.

We are trying to improve the quality and the reliability, but the durability differs depending on the use environment and the use conditions. On use, be sure to confirm the actual product under the actual use conditions.

- For the following applications and conditions, please be sure to consult with our sales representative in advance and to exchange product specifications which conform to such applications.
  - · When your application may have difficulty complying with the safety or handling precautions specified below.
  - High-quality and high-reliability required devices that have possibility of causing hazardous conditions, such as death or injury (regardless of directly or indirectly), due to failure or malfunction of the product.
  - ① Aircraft and Aerospace Equipment (artificial satellite, rocket, etc.)
  - ② Submarine Equipment (submarine repeating equipment, etc.)
  - ③ Transportation Equipment (airplanes, trains, ship, traffic signal controllers, etc.)
  - Power Generation Control Equipment (atomic power, hydroelectric power, thermal power plant control system, etc.)
  - ⑤ Medical Equipment (life-support equipment, pacemakers, dialysis controllers, etc.)
  - 6 Information Processing Equipment (large scale computer systems, etc.)
  - ② Electric Heating Appliances, Combustion devices (gas fan heaters, oil fan heaters, etc.)
  - **® Rotary Motion Equipment**

  - 10 And any similar types of equipment

# **Strict observance**

#### 1. Confirmation of Rated Performance

The Varistors shall be operated within the specified rating/performance.

Applications exceeding the specifications may cause deteriorated performance and/or breakdown, resulting in degradation and/or smoking or ignition of products. The following are strictly observed.

- (1) The Varistors shall not be operated beyond the specified operating temperature range.
- (2) The Varistors shall not be operated in excess of the specified maximum allowable voltage.
- (3) The Varistors shall not be operated in the circuits to which surge current and ESD that exceeds the specified maximum peak current and maximum ESD.
- (4) Never use for AC power supply circuits.
- 2. The Varistors shall not be mounted near flammables.



# Operating conditions and circuit design

#### 1. Circuit design

#### 1.1 Operating temperature and storage temperature

When operating a components-mounted circuit, please be sure to observe the "Operating Temperature Range", written in delivery specifications. Storage temperature of PCB after mounting Varistors, which is not operated, should be within the specified "Storage Temperature Range" in the delivery specifications. Please remember not to use the product under the condition that exceeds the specified maximum temperature.

#### 1.2 Operating voltage

The Varistors shall not be operated in excess of the "Maximum allowable voltage". If the Varistors are operated beyond the specified Maximum allowable voltage, it may cause short and/or damage due to thermal run away. The circuit that continuously applies high frequency and/or steep pulse voltage please examines the reliability of the Varistor even if it is used within a "Maximum allowable voltage". Also, it would be safer to check also the safety and reliability of your circuit.

#### 1.3 Self-heating

The surface temperature of the Varistors shall be under the specified Maximum Operating Temperature in the Specifications including the temperature rise caused by self-heating. Check the temperature rise of the Varistor in your circuit.

#### 1.4 Environmental restrictions

The Varistors does not take the use under the following special environments into consideration. Accordingly, the use in the following special environments, and such environmental conditions may affect the performance of the product; prior to use, verify the performance, reliability, etc. thoroughly.

- ① Use in liquids such as water, oil, chemical, and organic solvent.
- ② Use under direct sunlight, in outdoor or in dusty atmospheres.
- ③ Use in places full of corrosive gases such as sea breeze, Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NOx.
- 4 Use in environment with large static electricity or strong electromagnetic waves or strong radial ray.
- (5) Where the product is close to a heating component, or where an inflammable such as a polyvinyl chloride wire is arranged close to the product.
- 6 Where this product is sealed or coated with resin etc.
- Where solvent, water, or water-soluble detergent is used in flux cleaning after soldering. (Pay particular attention to water-soluble flux.)
- ® Use in such a place where the product is wetted due to dew condensation.
- Use the product in a contaminated state.
  - Ex.) Do not handle the product such as sticking sebum directly by touching the product after mounting printed circuit board.
- ① Under severe conditions of vibration or impact beyond the specified conditions found in the Specifications.

#### 2. Design of printed circuit board

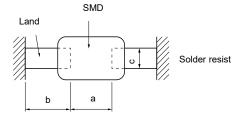
#### 2.1 Selection of printed circuit boards

There is a possibility of performance deterioration by heat shock (temperature cycles), which causes cracks, from alumina substrate. Please confirm that the substrate you use does not deteriorate the Varistors' quality.

#### 2.2 Design of land pattern

(1) Recommended land dimensions are shown below. Use the proper amount of solder in order to prevent cracking. Using too much solder places excessive stress on the Varistors.

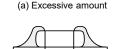
Recommended land dimensions(Ex.)



|           |                                |     |     |            |            | Unit : mm  |
|-----------|--------------------------------|-----|-----|------------|------------|------------|
| Size code | Size code Component dimensions |     |     |            | h          |            |
| / EIA     | L                              | W   | Т   | а          | D          | С          |
| 0(0402)   | 1.0                            | 0.5 | 0.5 | 0.4 to 0.5 | 0.4 to 0.5 | 0.4 to 0.5 |
| 1(0603)   | 1.6                            | 0.8 | 0.8 | 0.8 to 1.0 | 0.6 to 0.8 | 0.6 to 0.8 |

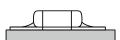
(2) The land size shall be designed to have equal space, on both right and left side. If the amount of solder on the right land is different from that of the left land, the component may be cracked by stress since the side with a larger amount of solder solidifies later during cooling.

Recommended amount of solder





(b) Proper amount



(c) Insufficient amount

#### 2.3 Utilization of solder resist

- (1) Solder resist shall be utilized to equalize the amounts of solder on both sides.
- (2) Solder resist shall be used to divide the pattern for the following cases;
  - · Components are arranged closely.
  - The Varistor is mounted near a component with lead wires.
  - · The Varistor is placed near a chassis.

See the table right.

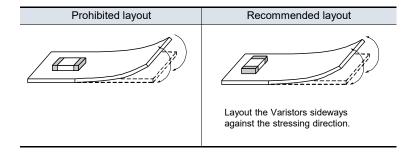
# Prohibited applications and recommended applications

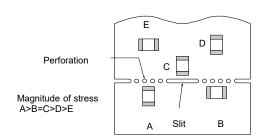
| Item   | Prohibited applications                           | Improved applications by pattern division |
|--|---|---|
| Mixed mounting<br>with a<br>component<br>with lead wires | The lead wire of a component with lead wires      | Solder resist                             |
| Arrangement<br>near<br>chassis                           | Chassis Solder(ground solder) Electrode pattern   | Solder resist                             |
| Retro-fitting of component with lead wires               | A lead wire of retrofitted component Solderingiro | Solder resist                             |
| Lateral<br>arrangement                                   | Portion to be excessively soldered                | Solder resist                             |

#### 2.4 Component layout

To prevent the crack of Varistors, place it on the position that could not easily be affected by the bending stress of substrate while going through procedures after mounting or handling.

- (1)To minimize mechanical stress caused by the warp or bending of a PC board, please follow the recommended Varistors' layout below.
- (2) The following layout is for your reference since mechanical stress near the dividing/breaking position of a PC board varies depending on the mounting position of the Varistors.





(3) The magnitude of mechanical stress applied to the Varistors when dividing the circuit board in descending order is as follows: push back < slit < V-groove < perforation. Also take into account the layout of the Varistors and the dividing/breaking method.

#### 2.5 Mounting density and spaces

Intervals between components should not be too narrow to prevent the influence from solder bridges and solder balls. The space between components should be carefully determined.



# **Precautions for assembly**

#### 1. Storage

- (1) The Varistors shall be stored between 5 to 40 °C and 20 to 70 % RH, not under severe conditions of high temperature and humidity.
- (2) If stored in a place where humidity, dust, or corrosive gasses (hydrogen sulfide, sulfurous acid, hydrogen chloride and ammonia, etc.) are contained, the solderability of terminals electrodes will be deteriorated. In addition, storage in a place where the heat or direct sunlight exposure occurs will causes or direct sunlight exposure occurs will causes mounting problems due to deformation of tapes and reels and components and taping/reels sticking together.
- (3) Do not store components longer than 12 months. Check the solderability of products that have been stored for more than 12 months before use.

#### 2. Adhesives for Mounting

- (1) The amount and viscosity of an adhesive for mounting shall be such that the adhesive will not flow off on the land during its curing.
- (2) If the amount of adhesive is insufficient for mounting, the Varistors may fall off after or during soldering.
- (3) Low-viscosity of the adhesive causes displacement of Varistors.
- (4) The heat-curing methods for adhesive are ultraviolet radiation, far-infrared radiation, and so on. In order to prevent the terminal electrodes of the Varistors from oxidizing, the curing shall be under the following conditions:160 °C max., for 2 minutes max.
- (5) Insufficient curing may cause the Varistors to fall off after or during soldering. In addition, insulation resistance between terminal electrodes may deteriorate due to moisture absorption. In order to prevent these problems, please observe proper curing conditions.

#### 3. Chip Mounting Consideration

- (1) When mounting the Varistors components on a PC board, the Varistor bodies shall be free from excessive impact loads such as mechanical impact or stress due to the positioning, pushing force and displacement of vacuum nozzles during mounting.
- (2) Maintenance and inspection of the Chip Mounter must be performed regularly.
- (3) If the bottom dead center of the vacuum nozzle is too low, the Varistor will crack from excessive force during mounting. Pease refer to the following precautions and recommendations.
  - (a) Set and adjust the bottom dead center of the vacuum nozzles to the upper surface of the PC board after correcting the warp of the PC board.
  - (b) Set the pushing force of the vacuum nozzle during mounting to 1 to 3 N in static load.
  - (c) For double surface mounting, apply a supporting pin on the rear surface of the PC board to suppress the bending of the PC board in order to minimize the impact of the vacuum nozzles. Typical examples are shown in the table below secondary.
  - (d) Adjust the vacuum nozzles so that their bottom dead center during mounting is not too low.

| Item                          | Prohibited mounting        | Recommended mounting  |
|-------------------------------|----------------------------|---|
| Single<br>surface<br>mounting | Crack                      | The supporting pin does not necessarily have to be positioned beneath the Varistor.  Supporting pin |
| Double<br>surface<br>mounting | Separation of solder Crack | Supporting pin  |

- (4) The closing dimensions of the positioning chucks shall be controlled. Maintenance and replacement of positioning chucks shall be performed regularly to prevent chipping or cracking of the Varistors caused by mechanical impact during positioning due to worn positioning chucks.
- (5) Maximum stroke of the nozzle shall be adjusted so that the maximum bending of PC board does not exceed 0.5 mm at 90 mm span. The PC board shall be supported by an adequate number of supporting pins.



#### 4. Selection of soldering flux

Soldering flux may seriously affect the performance of the Varistors. Please confirm enough whether the soldering flux have an influence on performance of the Varistors or not, before using.

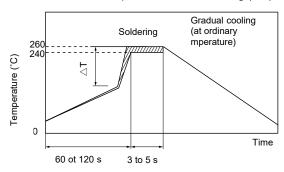
#### 5. Soldering

#### 5.1 Flow soldering

When conducting flow soldering, stress from abrupt temperature change is applied to the Varistors, so the temperature, especially temperature of solder should be controlled very carefully. Varistors should not be subjected to abrupt temperature change because it causes occurrence of thermal cracks as a result of excessive thermal stress inside of the Varistors from flow soldering. You should be careful to temperature difference. Therefore it is essential that soldering process follow these recommended conditions.

- (1) Application of Soldering flux :
  - The soldering flux shall be applied to the mounted Varistors thinly and uniformly by foaming method.
- (2) Preheating: Conduct sufficient pre-heating, and make sure that the temperature difference between solder and Varistors' surface is 150 °C or less.
- (3) Immersion into Soldering bath:
  - The Varistors shall be immersed into a soldering bath of 240 to 260 °C for 3 to 5 seconds.
- (4) Gradual Cooling: After soldering, avoid rapid cooling (forced cooling) and conduct gradual cooling, so that thermal cracks do not occur.
- (5) Flux Cleaning: When the Varistors are immersed into a cleaning solvent, be sure that the surface temperatures of devices do not exceed 100 °C.
- (6) Performing flow soldering once under the conditions shown in the figure below [Recommended profile of Flow soldering (Ex.)] will not cause any problems. However, pay attention to the possible warp and bending of the PC board.

#### Recommended profile of flow soldering (Ex.)



<△T:Allowable temperature difference>

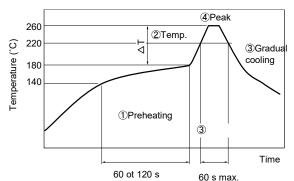
| Size / EIA | Temp. tol. |
|------------|------------|
| 0603       | T ≦150 °C  |

For products specified in individual specifications, avoid flow soldering.

#### 5.2 Reflow soldering

The reflow soldering temperature conditions are composed of temperature curves of Preheating, Temp. rise, Heating, Peak and Gradual cooling. Large temperature difference inside the Varistors caused by rapid heat application to the Varistors may lead to excessive thermal stresses, contributing to the thermal cracks. The Preheating temperature requires controlling with great care so that tombstone phenomenon may be prevented.

#### Recommended profile of Reflow Soldering (Ex.)



| Item           | Temperature           | Period or speed |
|----------------|-----------------------|-----------------|
| ① Preheating   | 140 to 180 ℃          | 60 to 120 s     |
| (2) Taman miaa | Preheating temp       | 2 to 5 ℃ / s    |
| ② Temp. rise   | to Peak temp.         | 2105 C/S        |
| ③ Heating      | 220 ℃ min. 60 s max.  |                 |
| ④ Peak         | 260 °C max. 10 s max. |                 |
| ⑤ Gradual      | Peak temp.            | 1 to 4 ℃ / s    |
| cooling        | to 140 ℃              | 1 10 4 C/S      |

| Size / EIA | Temp. tol. |
|------------|------------|
| 0402, 0603 | T ≦150 °C  |

 $\Delta T$ : Allowable temperature difference  $\Delta T \leq 150 \,^{\circ}\text{C}$ 



The rapid cooling (forced cooling) during Gradual cooling part should be avoided, because this may cause defects such as the thermal cracks, etc. When the Varistors are immersed into a cleaning solvent, make sure that the surface temperatures of the devices do not exceed 100 °C. Performing reflow soldering twice under the conditions shown in the figure above [Recommended profile of Flow soldering (Ex.)] will not cause any problems. However, pay attention to the possible warp and bending of the PC board.

Recommended soldering condition is for the guideline for ensuring the basic characteristics of the components, not for the stable soldering conditions. Conditions for proper soldering should be set up according to individual conditions. The temperature of this product at the time of mounting changes depending on mounting conditions, therefore, please confirm that Product surface becomes the specified temperature when mounting it on the end product.

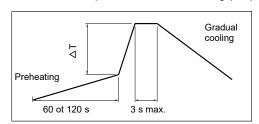
#### 5.3 Hand soldering

Hand soldering typically causes significant temperature change, which may induce excessive thermal stresses inside the Varistors, resulting in the thermal cracks, etc. In order to prevent any defects, the following should be observed.

- · Control the temperature of the soldering tips with special care.
- · Avoid the direct contact of soldering tips with the Varistors and/or terminal electrodes.
- · Do not reuse dismounted Varistors.
- (1) Condition 1 (with preheating)
  - (a) Soldering : Use thread solder (ø1.0 mm or below) which contains flux with low chlorine, developed for precision electronic equipment.
  - (b) Preheating : Conduct sufficient preheating, and make sure that the temperature difference between solder and Varistors' surface is 150 °C or less.
  - (c) Temperature of Iron tip: 350 °C max.

    (The required amount of solder shall be melted in advance on the soldering tip.)
  - (d) Gradual cooling: After soldering, the Varistors shall be cooled gradually at room temperature.

#### Recommended profile of Hand soldering (Ex.)



 $\Delta T$ : Allowable temperature difference  $\Delta T \leq 150 \,^{\circ}$ C

# (2) Condition 2 (without preheating) Hand soldering can be performed without preheating, by following the conditions below:

- (a) Soldering iron tip shall never directly touch the ceramic and terminal electrodes of the Varistors.
- (b) The lands are sufficiently preheated with a soldering iron tip before sliding the soldering iron tip to the terminal electrodes of the Varistors for soldering.

#### Conditions of hand soldering without preheating

| Item                                 | Condition  |
|--------------------------------------|------------|
| Temperature of Iron tip              | 350 ℃ max. |
| Wattage                              | 20 W max.  |
| Shape of Iron tip                    | ø3 mm max. |
| Soldering time with a soldering iron | 3 s max.   |



#### 6. Post soldering cleaning

#### 6.1 Cleaning solvent

Soldering flux residue may remain on the PC board if cleaned with an inappropriate solvent.

This may deteriorate the performance of Varistors, especially insulation resistance.

#### 6.2 Cleaning conditions

Inappropriate cleaning conditions such as insufficient cleaning or excessive cleaning may impair the electrical characteristics and reliability of the Varistors.

- (1) Insufficient cleaning can lead to:
  - (a) The halogen substance found in the residue of the soldering flux may cause the metal of terminal electrodes to corrode.
  - (b) The halogen substance found in the residue of the soldering flux on the surface of the Varistors may change resistance values.
  - (c) Water-soluble soldering flux may have more remarkable tendencies of (a) and (b) above compared to those of rosin soldering flux.
- (2) Excessive cleaning can lead to:
  - (a) When using ultrasonic cleaner, make sure that the output is not too large, so that the substrate will not resonate. The resonation causes the cracks in Varistors and/or solders, and deteriorates the strength of the terminal electrodes. Please follow these conditions for Ultrasonic cleaning:

Ultrasonic wave output : 20 W/L max.
Ultrasonic wave frequency : 40 kHz max.
Ultrasonic wave cleaning time : 5 min. max.

#### 6.3 Contamination of cleaning solvent

Cleaning with contaminated cleaning solvent may cause the same results as that of insufficient cleaning due to the high density of liberated halogen.

#### 7. Inspection process

The pressure from measuring terminal pins might bend the PCB when implementing circuit inspection after mounting Varistors on PCB, and as a result, cracking may occur.

- (1) Mounted PC boards shall be supported by an adequate number of supporting pins on the back with bend settings of 90 mm span 0.5 mm max.
- (2) Confirm that the measuring pins have the right tip shape, are equal in height, have the right pressure and are set in the correct positions. The following figures are for your reference to avoid bending the PC board.

| Item                   | Prohibited mounting | Recommended mounting |
|------------------------|---------------------|----------------------|
|                        | Check pin           | Check pin            |
| Bending of<br>PC board | Separated, Crack    | Supporting pin       |

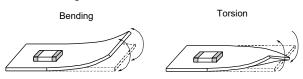
#### 8. Protective coating

Make sure characteristics and reliability when using the resin coating or resin embedding for the purpose of improvement of humidity resistance or gas resistance, or fixing of parts because failures of a thermistors such as 1).2) and 3) may be occurred.

- (1) The solvent which contained in the resin permeate into the Varistors, and it may deteriorate the characteristic.
- (2) When hardening the resin, chemical reaction heat (curing heat generation) happen and it may occurs the infection to the Varistors.
- (3) The lead wire might be cut down and the soldering crack might be happen by expansion or contraction of resin hardening.

#### 9. Dividing / Breaking of PC boards

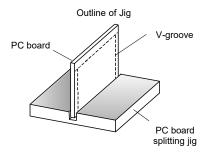
(1) Please be careful not to stress the substrate with bending/twisting when dividing, after mounting components including Varistors. Abnormal and excessive mechanical stress such as bending or torsion shown below can cause cracking in the Varistors.

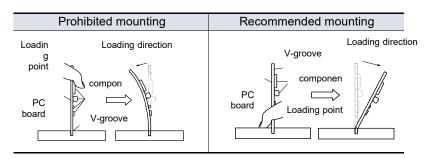


(2) Dividing/Breaking of the PC boards shall be done carefully at moderate speed by using a jig or apparatus to prevent the Varistors on the boards from mechanical damage.



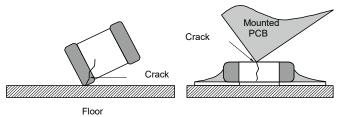
(3) Examples of PCB dividing/breaking jigs: The outline of PC board breaking jig is shown below. When PC board are broken or divided, loading points should be close to the jig to minimize the extent of the bending. Also, planes with no parts mounted on should be used as plane of loading, in order to prevent tensile stress induced by the bending, which may cause cracks of the Varistors or other parts mounted on the PC boards.





#### 10. Mechanical Impact

- (1) The Varistors shall be free from any excessive mechanical impact. The Varistor body is made of ceramics and may be damaged or cracked if dropped. Never use a Varistor which has been dropped; their quality may already be impaired, and in that case, failure rate will increase.
- (2) When handling PC boards with Varistors mounted on them, do not allow the Varistors to collide with another PC board. When mounted PC boards are handled or stored in a stacked state, the corner of a PC board might strike Varistors, and the impact of the strike may cause damage or cracking and can deteriorate the withstand voltage and insulation resistance of the Varistor.



11. Do not reuse this product after removal from the mounting board.

# Precautions for discarding

As to the disposal of the Varisrors, check the method of disposal in each country or region where the modules are incorporated in your products to be used.

#### Other

The various precautions described above are typical. For special mounting conditions, please contact us.

## Applicable laws and regulations, others

- 1. This product not been manufactured with any ozone depleting chemical controlled under the Montreal Protocol.
- 2. This product comply with RoHS(Restriction of the use of certain Hazardous Substance in electrical and electronic equipment) (DIRECTIVE 2011/65/EU and 2015/863/EU).
- 3. All the materials used in this part are registered material under the Law Concerning the Examination and Regulation of Manufacture, etc. of Chemical Substance.
- 4. If you need the notice by letter of "A preliminary judgement on the Laws of Japan foreign exchange and Foreign Trade Control", be sure to let us know.
- 5. These products are not dangerous goods on the transportation as identified by UN (United nations) numbers or UN classification.
- 6. The technical information in this catalog provides example of our products' typical operations and application circuit. We do not guarantee the non-infringement of third party's intellectual property rights and we do not grant any license, Right or interest in our intellectual property.

#### **AEC-Q200 Compliant**

The products are tested based on all or part of the test conditions and methods defined in AEC-Q200. Please consult with Panasonic for the details of the product specification and specific evaluation test results, etc., and please review and approve Panasonic's product specification before ordering.

# Panasonic

**INDUSTRY** 

# **Multilayer Varistor**

Automotive grade

EZJZ-M, EZJP-M series



11

M

Code

G

Н

Example

Capacitance

68 pF

100 pF

150 pF

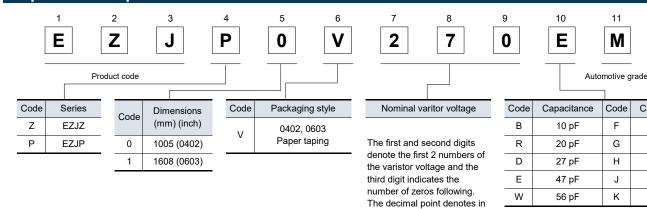
220 pF

330 pF

## **Features**

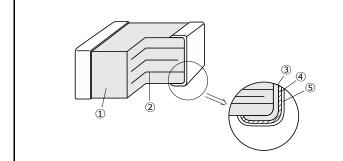
- Excellent ESD suppression due to original advanced material technology
- Having large electrostatic resistance meeting IEC61000-4-2, ISO10605
- Having no polarity (bipolar) facilitated replacing Zener Diodes. Capable of replacing 2 Zener Diodes and 1 Capacitor
- Lead-free plating terminal electrodes enabling great solderability
- Wide range of products is available by adopting multilayer structure, meeting various needs
- AEC-Q200 compliant
- RoHS compliant

# **Explanation of part numbers**



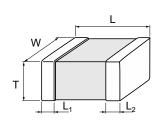
R.

## Construction



| No. | Name                      |                        |  |
|-----|---------------------------|------------------------|--|
| 1   | Zinc oxide-based ceramics |                        |  |
| 2   | Internal electrode        |                        |  |
| 3   |                           | Substrate electrode    |  |
| 4   | Terminal electrode        | Intermediate electrode |  |
| (5) |                           | External electrode     |  |

# **Dimensions in mm (not to scale)**



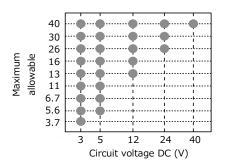
|           |            |             |             |             | Unit : mm                       |
|-----------|------------|-------------|-------------|-------------|---------------------------------|
| Size code | Size(inch) | L           | W           | Т           | L <sub>1</sub> , L <sub>2</sub> |
| 0         | 0402       | 1.00 ± 0.05 | 0.50 ± 0.05 | 0.50 ± 0.05 | 0.2 ± 0.1                       |
| 1         | 0603       | 1.6 ± 0.1   | 0.8 ± 0.1   | 0.8 ± 0.1   | 0.3 ± 0.2                       |

# Multilayer Varistor (Automotive grade) / EZJZ-M, EZJP-M series

# **Features**

Wide variety of products is available by adopting multilayer construction, which achieved wide range of usage, such as application to DC voltage lines and signal lines.

Varistor voltage: 12 to 100 V (at 1 mA)
Capacitance: 10 to 220 pF max. (at 1 MHz)



# **Recommended applications**

- Engine ECU
- Various body ECU
- Communication line, such as CAN, LIN
- Audio, Navigation
- LED Light
- Control SW

# **Ratings and characteristics**

|                |             | Maximum                        | Nominal varistor       | Capacitance         | (pF)      | Maximum                                    | Maximu                        | m ESD                    |
|----------------|-------------|--------------------------------|------------------------|---------------------|-----------|--|-------------------------------|--------------------------|
| Size<br>(inch) | Part No.    | allowable<br>voltage<br>DC (V) | voltage<br>at 1 mA (V) | at 1 MHz            | at 1 kHz  | peak current<br>at 8/20 µs,<br>2 times (A) | IEC61000-4-2<br>150 pF/ 330 Ω | ISO10605<br>330 pF/ 2 kΩ |
|                | EZJP0V120JM | 7.5                            | 12                     | 220 max. [150 typ.] | 175 typ.  | 10   |                               |                          |
|                | EZJP0V180HM | 11                             | 18                     | 150 max. [120 typ.] | 140 typ.  | 10   |                               |                          |
|                | EZJP0V220HM | 13                             | 22                     | 150 max. [100 typ.] | 116 typ.  | 10   |                               |                          |
|                | EZJP0V270GM | 18                             | 27                     | 100 max. [85 typ.]  | 100 typ.  | 10   |                               |                          |
|                | EZJP0V270EM | 18                             | 27                     | 47 max. [33 typ.]   | 37 typ.   | 4  |                               |                          |
| 0402           | EZJP0V270RM | 18                             | 27                     | 20 max. [15 typ.]   | 16.5 typ. | 2  |                               |                          |
|                | EZJP0V270BM | 18                             | 27                     | 10 max. [8 typ.]    | 10 typ.   | <del>-</del>                               |                               |                          |
|                | EZJP0V330GM | 25                             | 33                     | 100 max. [85 typ.]  | 100 typ.  | 10   |                               |                          |
|                | EZJP0V420WM | 30                             | 42                     | 56 max. [40 typ.]   | 45 typ.   | 6  |                               |                          |
|                | EZJP0V650DM | 40                             | 65                     | 27 max. [22 typ.]   | 33 typ.   | 2  |                               |                          |
|                | EZJP0V101BM | 30                             | 100                    | 10 max. [8 typ.]    | 10 typ.   | _  |                               |                          |
|                | EZJP1V120KM | 7.5                            | 12                     | 330 max. [250 typ.] | 290 typ.  | 20   |                               |                          |
|                | EZJP1V180JM | 11                             | 18                     | 220 max. [180 typ.] | 210 typ.  | 20   | Contact                       | Contact                  |
|                | EZJP1V220JM | 13                             | 22                     | 220 max. [160 typ.] | 185 typ.  | 10   | discharge<br>8 kV             | discharge<br>25 kV       |
|                | EZJP1V270GM | 18                             | 27                     | 100 max. [85 typ.]  | 100 typ.  | 10   | O KV                          | 20 10                    |
|                | EZJP1V270EM | 18                             | 27                     | 47 max. [33 typ.]   | 37 typ.   | 5  |                               |                          |
|                | EZJP1V270RM | 18                             | 27                     | 20 max. [15 typ.]   | 16.5 typ. | 2  |                               |                          |
|                | EZJP1V330GM | 25                             | 33                     | 100 max. [85 typ.]  | 100 typ.  | 10   |                               |                          |
| 0603           | EZJP1V420FM | 30                             | 42                     | 68 max. [55 typ.]   | 63 typ.   | 8  |                               |                          |
|                | EZJP1V650DM | 40                             | 65                     | 27 max. [22 typ.]   | 33 typ.   | 2  |                               |                          |
|                | EZJZ1V180JM | 11                             | 18                     | 220 max. [180 typ.] | 210 typ.  | 20   | 1                             |                          |
|                | EZJZ1V220JM | 13                             | 22                     | 220 max. [160 typ.] | 185 typ.  | 20   |                               |                          |
|                | EZJZ1V270GM | 16                             | 27                     | 100 max. [85 typ.]  | 100 typ.  | 20   | 1                             |                          |
|                | EZJZ1V330GM | 26                             | 33                     | 100 max. [85 typ.]  | 100 typ.  | 20   | 1                             |                          |
|                | EZJZ1V420FM | 30                             | 42                     | 68 max. [55 typ.]   | 63 typ.   | 15   | 1                             |                          |
|                | EZJZ1V650DM | 40                             | 65                     | 27 max. [22 typ.]   | 33 typ.   | 5  |                               |                          |

Operating temperature range : E2

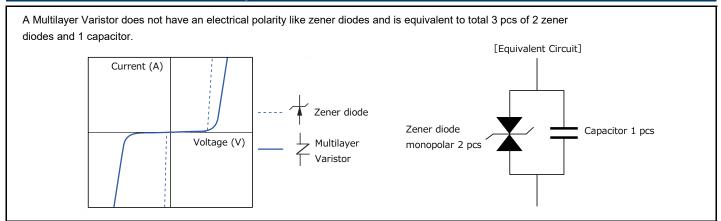
EZJP serie -55 to 150  $^{\circ}$ C, EZJZ serie -55 to 125  $^{\circ}$ C

\* Recommend soldering method : Reflow soldering

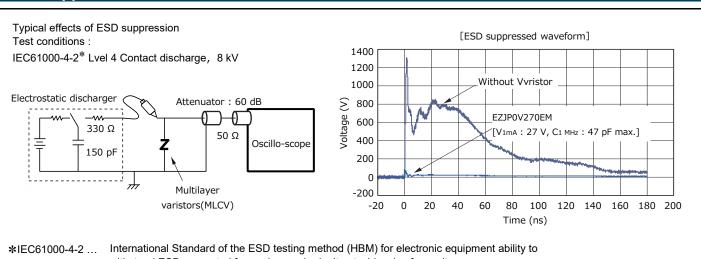
| Maximum allowable voltage Maximum DC Voltage that can be applied continuously within the operating temperature range |   |
|--|---|
| Varistor voltage   | Varistor starting voltage between terminals at DC 1 mA, also known as Breakdown voltage |
| Maximum peak current   | Maximum current that can be withstood under the standard pulse 8/20 μs, 2 times based   |
| Maximum ESD  | Maximum voltage that can be withstood under ESD   |

# Multilayer Varistors (Automotive grade) EZJZ-M, EZJP-M series / Characteristics

# Varistor characteristics and equivalent circuit



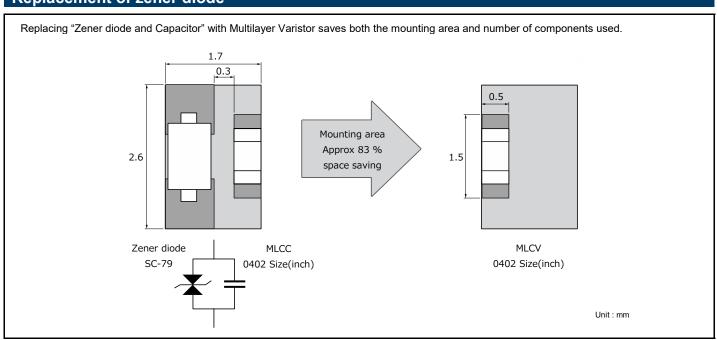
# **ESD Suppressive effects**



| *IEC61000-4-2 | International Standard of the ESD testing method (HBM) for electronic equipment ability to |
|---------------|--|
|               | withstand ESD generated from a human body. It sets 4 levels of severity                    |

| Severity          | Level 1 | Level 2 | Level 3 | Level 4 |
|-------------------|---------|---------|---------|---------|
| Contact discharge | 2 kV    | 4 kV    | 6 kV    | 8 kV    |
| Air discharge     | 2 kV    | 4 kV    | 8 kV    | 15 kV   |

## Replacement of zener diode



# Multilayer Varistors (Automotive grade) EZJZ-M, EZJP-M series / Performance and testing

|                                      | and testing metl             |  |  |  |  |
|--------------------------------------|------------------------------|--|--|--|--|
| Characteristics                      | Specifications               | Testing method   |  |  |  |
| Standard test conditions             |                              | Electrical characteristics shall be measured under the following conditions. Temp. : 5 to 35 $^{\circ}$ C, Relative humidity : 85 $^{\circ}$ 8 or less   |  |  |  |
| Varistor voltage                     | To meet the specified value. | The Varistor voltage is the voltage ( $V_C$ ,or $V_{cmA}$ ) between both end terminals of a Varistor when specified current (CmA) is applied to it. The measurement shall be made as quickly as possible to avoid heating effects.   |  |  |  |
| Maximum allowable voltage            | To meet the specified value. | The maximum DC voltage that can be applied continuously to a varistor.   |  |  |  |
| Capacitance                          | To meet the specified value. | Capacitance shall be measured at the specified frequency, bias voltage 0 V, and measuring voltage 0.2 to 2.0 Vrms  |  |  |  |
| Maximum peak current                 | To meet the specified value. | The maximum current measured (Varistor voltage tolerance is within ±10 %) when a standard impulse current of 8/20 µ seconds is applied twice with an interval of 5 minutes.  |  |  |  |
| Maximum ESD                          | To meet the specified value. | The maximum ESD measured (while the varistor voltage is within blow ranges of its nominal value when exposed to ESD 10 times (five times for each positive-negative polarity) based on IEC61000 4-2, ISO10605.  EZJP \  \to |  |  |  |
| Solder ability                       | To meet the specified value. | The part shall be immersed into a soldering bath under the conditions below.  Solder: Sn-Ag-Cu  Soldering flux: Ethanol solution of rosin (Concentration approx. 25 wt%)  Soldering temp.: 230 ± 5 °C  Period: 4 ± 1 s  Soldering position  Soldering position  Immerse both terminal electrodes until they are completely into the soldering bath.  |  |  |  |
| Resistance to soldering heat         | ΔVc/Vc :<br>within ±10 %     | After the immersion, leave the part for 24 ±2 hours under the standard condition, then evaluate its characteristics. Soldering conditions are specified below:  Soldering conditions: 270 °C, 3 s / 260 °C, 10 s  Soldering position: Immerse both terminal electrodes until they are completely into the soldering bath.  After repeating the cycles stated below for specified number of times, leave the part for 24±2  |  |  |  |
| Temperature<br>cycling               | ΔVc/Vc :<br>within ±10 %     | hours, then evaluate its characteristics.  Cycle: 2000 cycles  Step Temperature Period  1 Max. operating temp. 30±3 min  2 Ordinary temp. 3 min max.  3 Min. operating temp. 30±3 min  4 Ordinary temp. 3 min max.   |  |  |  |
| Vibration                            | ΔVc/Vc :<br>within ±10 %     | The varistor shall be soldered on the testing board shown.  G force: 5 G  Vibration frequency range: 10 to 2000 Hz  Sweet time: 20 min.  Sweet direction: 12 cycles for 3 courses perpendicular each other   |  |  |  |
| Mechanical shock                     | ΔVc/Vc :<br>within ±10 %     | The varistor shall be soldered on the testing board shown.  Shock-wave formation : Half sine , 11 ms  G force : 50 G  Sweet direction : 6 directions of X, Y, Z, for each three times  |  |  |  |
| Biased humidity                      | ΔVc/Vc :<br>within ±10 %     | After conducting the test under the conditions specified below, leave the part 24±2 hours, then evaluate its characteristics.  Temp.: 85 ± 2 °C  Humidity: 80 to 85 %RH  Applied voltage: Maximum allowable voltage (Individually specified)  Period: 2000+24/0 h  |  |  |  |
| High temperature exposure (dry heat) | ΔVc/Vc :<br>within ±10 %     | After conducting the test under the conditions specified below, leave the part 24±2 hours, then evaluate its characteristics.  Temp.: Maximum operating temperature ±3 °C (Individually specified)  Applied voltage: Maximum allowable voltage (Individually specified)  Period: 2000+24/0 h   |  |  |  |

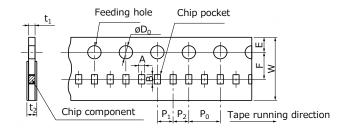
# Multilayer Varistors (Automotive grade) EZJZ-M, EZJP-M series / Packaging

# Packaging methods (Taping)

#### Standard quantity

| Series     | Size code<br>(inch size) | Thickness<br>(mm) | Kind of taping  | Pitch<br>(mm) | Quantity<br>(pcs/reel) |
|------------|--------------------------|-------------------|-----------------|---------------|------------------------|
| EZJZ, EZJP | 0 (0402)                 | 0.5               | Punched carrier | 2             | 10,000                 |
| EZJZ, EZJF | 1 (0603)                 | 0.8               | taping          | 4             | 4,000                  |

#### • 2 mm Pitch (Punched carrier taping) Size 0402



| t. | Feeding hole  | Chip pocket |          |
|----|---------------|-------------|----------|
| 1  | $\sqrt{gD_0}$ |             |          |
|    | 1/ 1/ 1       | /1 1 1      | 1 Just 1 |

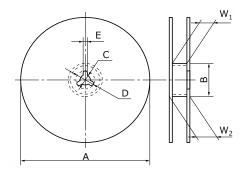
• 4 mm Pitch (Punched carrier taping) Size 0603

| ØD <sub>0</sub> ØD <sub>0</sub> P <sub>1</sub> P <sub>2</sub> P <sub>0</sub> | t, recally hole chip pocket                           |
|--|---|
|  | $\sqrt{gD_0}$   |
| $P_1$ $P_2$ $P_0$  |   |
| Chip component Tape running direction  | $\begin{array}{c ccccccccccccccccccccccccccccccccccc$ |

|              |               |               |             |               |               |                |                |                |                  | Uı             | nit : mm       |
|--------------|---------------|---------------|-------------|---------------|---------------|----------------|----------------|----------------|------------------|----------------|----------------|
| Code         | Α             | В             | W           | F             | Е             | P <sub>1</sub> | P <sub>2</sub> | P <sub>0</sub> | øD <sub>0</sub>  | t <sub>1</sub> | t <sub>2</sub> |
| EZJZ<br>EZJP | 0.62<br>±0.05 | 1.12<br>±0.05 | 8.0<br>±0.2 | 3.50<br>±0.05 | 1.75<br>±0.10 | 2.00<br>±0.05  | 2.00<br>±0.05  | 4.0<br>±0.1    | 1.5<br>+0.1<br>0 | 0.7<br>max.    | 1.0<br>max.    |

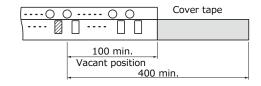
|              |             |             |             |               |               |                |                |                |                  | UI             | 111            |
|--------------|-------------|-------------|-------------|---------------|---------------|----------------|----------------|----------------|------------------|----------------|----------------|
| Code         | Α           | В           | W           | F             | E             | P <sub>1</sub> | P <sub>2</sub> | P <sub>0</sub> | øD <sub>0</sub>  | t <sub>1</sub> | t <sub>2</sub> |
| EZJZ<br>EZJP | 1.0<br>±0.1 | 1.8<br>±0.1 | 8.0<br>±0.2 | 3.50<br>±0.05 | 1.75<br>±0.10 | 4.0<br>±0.1    | 2.00<br>±0.05  | 4.0<br>±0.1    | 1.5<br>+0.1<br>0 | 1.1<br>max.    | 1.4<br>max.    |

#### Reel for taping

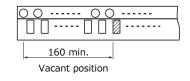


| <ul> <li>Leader part</li> </ul> | and taped end |
|---------------------------------|---------------|
|---------------------------------|---------------|

Leader part



Tape end



Unit : mm

I Init : mm

|              |                   |                       |                      |                      |                     |                | Unit : mm      |
|--------------|-------------------|-----------------------|----------------------|----------------------|---------------------|----------------|----------------|
| Code         | Α                 | В                     | С                    | D                    | Е                   | W <sub>1</sub> | W <sub>2</sub> |
| EZJZ<br>EZJP | ø180 <sup>0</sup> | ø60.0 <sup>+1.0</sup> | 13.0 <sub>±0.5</sub> | 21.0 <sub>±0.8</sub> | 2.0 <sub>±0.5</sub> | 9.0 +1.0       | 11.4±1.0       |

■ As for packaging methods, handling precautions please see data files



# **Application Guidelines**

(EZJZ, EZJP series : For DC voltage lines, high speed signal lines / EZJS series : For DC voltage lines)

# Handling precautions

- Do not use the products beyond the descriptions in this product catalog.
- This product catalog guarantees the quality of the products as individual components.
   Before you use the products, please make sure to check and evaluate the products in the circumstance where they are installed in your product.

# Safety precautions

Multilayer Varistors(Automotive Grade) (hereafter referred to as "Varistors") should be used for general purpose applications as countermeasures against ESD and noise found in vehicle electronics (Engine ECU and various body ECU, accessory equipment, etc.) equipment. When subjected to severe electrical, environmental, and/or mechanical stress beyond the specifications, as noted in the Ratings and Specified Conditions section, the Varistors' performance may be degraded, or become failure mode, such as short circuit mode and open-circuit mode. If you use under the condition of short-circuit, heat generation of Varistors will occur by running large current due to application of voltage. There are possibilities of smoke emission, substrate burn-out, and, in the worst case, fire. For products which require high safety levels, please carefully consider how a single malfunction can affect your product. In order to ensure the safety in the case of a single malfunction, please design products with fail-safe, such as setting up protecting circuits, etc.

We are trying to improve the quality and the reliability, but the durability differs depending on the use environment and the use conditions. On use, be sure to confirm the actual product under the actual use conditions.

- For the following applications and conditions, please be sure to consult with our sales representative in advance and to exchange product specifications which conform to such applications.
  - · When your application may have difficulty complying with the safety or handling precautions specified below.
  - High-quality and high-reliability required devices that have possibility of causing hazardous conditions, such as death or injury (regardless of directly or indirectly), due to failure or malfunction of the product.
  - ① Aircraft and Aerospace Equipment (artificial satellite, rocket, etc.)
  - 2 Submarine Equipment (submarine repeating equipment, etc.)
  - ③ Transportation Equipment (airplanes, trains, ship, traffic signal controllers, etc.)
  - ④ Power Generation Control Equipment (atomic power, hydroelectric power, thermal power plant control system, etc.)
  - ⑤ Medical Equipment (life-support equipment, pacemakers, dialysis controllers, etc.)
  - 6 Information Processing Equipment (large scale computer systems, etc.)
  - ② Electric Heating Appliances, Combustion devices (gas fan heaters, oil fan heaters, etc.)
  - ® Rotary Motion Equipment

  - And any similar types of equipment

# **Strict observance**

#### 1. Confirmation of Rated Performance

The Varistors shall be operated within the specified rating/performance.

Applications exceeding the specifications may cause deteriorated performance and/or breakdown, resulting in degradation and/or smoking or ignition of products. The following are strictly observed.

- (1) The Varistors shall not be operated beyond the specified operating temperature range.
- (2) The Varistors shall not be operated in excess of the specified maximum allowable voltage.
- (3) The Varistors shall not be operated in the circuits to which surge current and ESD that exceeds the specified maximum peak current and maximum ESD.
- (4) Never use for AC power supply circuits.
- 2. The Varistors shall not be mounted near flammables.



# Operating conditions and circuit design

#### 1. Circuit design

#### 1.1 Operating temperature and storage temperature

When operating a components-mounted circuit, please be sure to observe the "Operating Temperature Range", written in delivery specifications. Storage temperature of PCB after mounting Varistors, which is not operated, should be within the specified "Storage Temperature Range" in the delivery specifications. Please remember not to use the product under the condition that exceeds the specified maximum temperature.

#### 1.2 Operating voltage

The Varistors shall not be operated in excess of the "Maximum allowable voltage". If the Varistors are operated beyond the specified Maximum allowable voltage, it may cause short and/or damage due to thermal run away. The circuit that continuously applies high frequency and/or steep pulse voltage please examines the reliability of the Varistor even if it is used within a "Maximum allowable voltage". Also, it would be safer to check also the safety and reliability of your circuit.

#### 1.3 Self-heating

The surface temperature of the Varistors shall be under the specified Maximum Operating Temperature in the Specifications including the temperature rise caused by self-heating. Check the temperature rise of the Varistor in your circuit.

#### 1.4 Environmental restrictions

The Varistors does not take the use under the following special environments into consideration. Accordingly, the use in the following special environments, and such environmental conditions may affect the performance of the product; prior to use, verify the performance, reliability, etc. thoroughly.

- ① Use in liquids such as water, oil, chemical, and organic solvent.
- ② Use under direct sunlight, in outdoor or in dusty atmospheres.
- ③ Use in places full of corrosive gases such as sea breeze, Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NOx.
- ④ Use in environment with large static electricity or strong electromagnetic waves or strong radial ray.
- ⑤ Where the product is close to a heating component, or where an inflammable such as a polyvinyl chloride wire is arranged close to the product.
- 6 Where this product is sealed or coated with resin etc.
- Where solvent, water, or water-soluble detergent is used in flux cleaning after soldering. (Pay particular attention to water-soluble flux.)
- ® Use in such a place where the product is wetted due to dew condensation.
- Use the product in a contaminated state.
  - Ex.) Do not handle the product such as sticking sebum directly by touching the product after mounting printed circuit board.
- ① Under severe conditions of vibration or impact beyond the specified conditions found in the Specifications.

#### 2. Design of printed circuit board

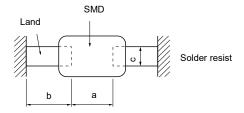
#### 2.1 Selection of printed circuit boards

There is a possibility of performance deterioration by heat shock (temperature cycles), which causes cracks, from alumina substrate. Please confirm that the substrate you use does not deteriorate the Varistors' quality.

#### 2. 2 Design of land pattern

(1) Recommended land dimensions are shown below. Use the proper amount of solder in order to prevent cracking. Using too much solder places excessive stress on the Varistors.

Recommended land dimensions(Ex.)



| Size code | Com | ponent | dimensions  |            | h            | С          |  |
|-----------|-----|--------|-------------|------------|--------------|------------|--|
| / EIA     | L   | W      | T           | а          | b            |            |  |
| Z(0201)   | 0.6 | 0.3    | 0.3         | 0.2 to 0.3 | 0.25 to 0.30 | 0.2 to 0.3 |  |
| 0(0402)   | 1.0 | 0.5    | 0.5         | 0.4 to 0.5 | 0.4 to 0.5   | 0.4 to 0.5 |  |
| 1(0603)   | 1.6 | 0.8    | 0.8         | 0.8 to 1.0 | 0.6 to 0.8   | 0.6 to 0.8 |  |
| 2(0805)   | 2.0 | 1.25   | 0.8 to 1.25 | 0.8 to 1.2 | 0.8 to 1.0   | 0.8 to 1.0 |  |

(2) The land size shall be designed to have equal space, on both right and left side. If the amount of solder on the right land is different from that of the left land, the component may be cracked by stress since the side with a larger amount of solder solidifies later during cooling.

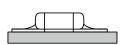
#### Recommended amount of solder



(a) Excessive amount



(b) Proper amount



(c) Insufficient amount

Unit: mm

#### 2.3 Utilization of solder resist

- (1) Solder resist shall be utilized to equalize the amounts of solder on both sides.
- (2) Solder resist shall be used to divide the pattern for the following cases;
  - · Components are arranged closely.
  - The Varistor is mounted near a component with lead wires.
  - · The Varistor is placed near a chassis.

See the table right.

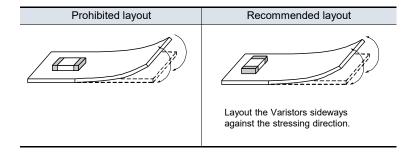
#### Prohibited applications and recommended applications

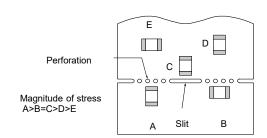
| Item   | Prohibited applications                           | Improved applications by pattern division |
|--|---|---|
| Mixed mounting<br>with a<br>component<br>with lead wires | The lead wire of a component with lead wires      | Solder resist                             |
| Arrangement<br>near<br>chassis                           | Chassis Solder(ground solder) Electrode pattern   | Solder resist                             |
| Retro-fitting of component with lead wires               | A lead wire of retrofitted component Solderingiro | Solder resist                             |
| Lateral<br>arrangement                                   | Portion to be excessively soldered                | Solder resist                             |

#### 2.4 Component layout

To prevent the crack of Varistors, place it on the position that could not easily be affected by the bending stress of substrate while going through procedures after mounting or handling.

- (1)To minimize mechanical stress caused by the warp or bending of a PC board, please follow the recommended Varistors' layout below.
- (2) The following layout is for your reference since mechanical stress near the dividing/breaking position of a PC board varies depending on the mounting position of the Varistors.





(3) The magnitude of mechanical stress applied to the Varistors when dividing the circuit board in descending order is as follows: push back < slit < V-groove < perforation. Also take into account the layout of the Varistors and the dividing/breaking method.

#### 2.5 Mounting density and spaces

Intervals between components should not be too narrow to prevent the influence from solder bridges and solder balls. The space between components should be carefully determined.



# **Precautions for assembly**

#### 1. Storage

- (1) The Varistors shall be stored between 5 to 40 °C and 20 to 70 % RH, not under severe conditions of high temperature and humidity.
- (2) If stored in a place where humidity, dust, or corrosive gasses (hydrogen sulfide, sulfurous acid, hydrogen chloride and ammonia, etc.) are contained, the solderability of terminals electrodes will be deteriorated. In addition, storage in a place where the heat or direct sunlight exposure occurs will causes or direct sunlight exposure occurs will causes mounting problems due to deformation of tapes and reels and components and taping/reels sticking together.
- (3) Do not store components longer than 12 months. Check the solderability of products that have been stored for more than 12 months before use.

#### 2. Adhesives for Mounting

- (1) The amount and viscosity of an adhesive for mounting shall be such that the adhesive will not flow off on the land during its curing.
- (2) If the amount of adhesive is insufficient for mounting, the Varistors may fall off after or during soldering.
- (3) Low-viscosity of the adhesive causes displacement of Varistors.
- (4) The heat-curing methods for adhesive are ultraviolet radiation, far-infrared radiation, and so on. In order to prevent the terminal electrodes of the Varistors from oxidizing, the curing shall be under the following conditions:160 °C max., for 2 minutes max.
- (5) Insufficient curing may cause the Varistors to fall off after or during soldering. In addition, insulation resistance between terminal electrodes may deteriorate due to moisture absorption. In order to prevent these problems, please observe proper curing conditions.

#### 3. Chip Mounting Consideration

- (1) When mounting the Varistors components on a PC board, the Varistor bodies shall be free from excessive impact loads such as mechanical impact or stress due to the positioning, pushing force and displacement of vacuum nozzles during mounting.
- (2) Maintenance and inspection of the Chip Mounter must be performed regularly.
- (3) If the bottom dead center of the vacuum nozzle is too low, the Varistor will crack from excessive force during mounting. Pease refer to the following precautions and recommendations.
  - (a) Set and adjust the bottom dead center of the vacuum nozzles to the upper surface of the PC board after correcting the warp of the PC board.
  - (b) Set the pushing force of the vacuum nozzle during mounting to 1 to 3 N in static load.
  - (c) For double surface mounting, apply a supporting pin on the rear surface of the PC board to suppress the bending of the PC board in order to minimize the impact of the vacuum nozzles. Typical examples are shown in the table below secondary.
  - (d) Adjust the vacuum nozzles so that their bottom dead center during mounting is not too low.

| Item                          | Prohibited mounting        | Recommended mounting  |
|-------------------------------|----------------------------|---|
| Single<br>surface<br>mounting | Crack                      | The supporting pin does not necessarily have to be positioned beneath the Varistor.  Supporting pin |
| Double<br>surface<br>mounting | Separation of solder Crack | Supporting pin  |

- (4) The closing dimensions of the positioning chucks shall be controlled. Maintenance and replacement of positioning chucks shall be performed regularly to prevent chipping or cracking of the Varistors caused by mechanical impact during positioning due to worn positioning chucks.
- (5) Maximum stroke of the nozzle shall be adjusted so that the maximum bending of PC board does not exceed 0.5 mm at 90 mm span. The PC board shall be supported by an adequate number of supporting pins.



#### 4. Selection of soldering flux

Soldering flux may seriously affect the performance of the Varistors. Please confirm enough whether the soldering flux have an influence on performance of the Varistors or not, before using.

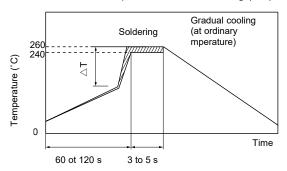
#### 5. Soldering

#### 5.1 Flow soldering

When conducting flow soldering, stress from abrupt temperature change is applied to the Varistors, so the temperature, especially temperature of solder should be controlled very carefully. Varistors should not be subjected to abrupt temperature change because it causes occurrence of thermal cracks as a result of excessive thermal stress inside of the Varistors from flow soldering. You should be careful to temperature difference. Therefore it is essential that soldering process follow these recommended conditions.

- (1) Application of Soldering flux :
  - The soldering flux shall be applied to the mounted Varistors thinly and uniformly by foaming method.
- (2) Preheating: Conduct sufficient pre-heating, and make sure that the temperature difference between solder and Varistors' surface is 150 °C or less.
- (3) Immersion into Soldering bath :
  - The Varistors shall be immersed into a soldering bath of 240 to 260 °C for 3 to 5 seconds.
- (4) Gradual Cooling: After soldering, avoid rapid cooling (forced cooling) and conduct gradual cooling, so that thermal cracks do not occur.
- (5) Flux Cleaning: When the Varistors are immersed into a cleaning solvent, be sure that the surface temperatures of devices do not exceed 100 °C.
- (6) Performing flow soldering once under the conditions shown in the figure below [Recommended profile of Flow soldering (Ex.)] will not cause any problems. However, pay attention to the possible warp and bending of the PC board.

#### Recommended profile of flow soldering (Ex.)



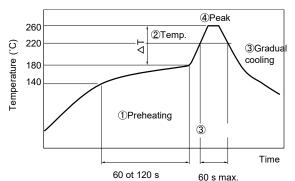
| Size / EIA | Temp. tol. |
|------------|------------|
| 0603       | T ≦150 °C  |

For products specified in individual specifications, avoid flow soldering.

#### 5.2 Reflow soldering

The reflow soldering temperature conditions are composed of temperature curves of Preheating, Temp. rise, Heating, Peak and Gradual cooling. Large temperature difference inside the Varistors caused by rapid heat application to the Varistors may lead to excessive thermal stresses, contributing to the thermal cracks. The Preheating temperature requires controlling with great care so that tombstone phenomenon may be prevented.

#### Recommended profile of Reflow Soldering (Ex.)



| Item         | Temperature     | Period or speed |
|--------------|-----------------|-----------------|
| 1 Preheating | 140 to 180 ℃    | 60 to 120 s     |
| ② Town rice  | Preheating temp | 2 to 5 ℃ / s    |
| ② Temp. rise | to Peak temp.   | 2105 C/S        |
| ③ Heating    | 220 ℃ min.      | 60 s max.       |
| 4 Peak       | 260 °C max.     | 10 s max.       |
| ⑤ Gradual    | Peak temp.      | 1 to 4 ℃ / s    |
| cooling      | to 140 ℃        | 1104 C/S        |

| Size / EIA   | Temp. tol. |
|--------------|------------|
| 0201 to 0805 | T ≦150 °C  |

 $\Delta T$ : Allowable temperature difference  $\Delta T \leq 150 \,^{\circ}\text{C}$ 



The rapid cooling (forced cooling) during Gradual cooling part should be avoided, because this may cause defects such as the thermal cracks, etc. When the Varistors are immersed into a cleaning solvent, make sure that the surface temperatures of the devices do not exceed 100 °C. Performing reflow soldering twice under the conditions shown in the figure above [Recommended profile of Flow soldering (Ex.)] will not cause any problems. However, pay attention to the possible warp and bending of the PC board.

Recommended soldering condition is for the guideline for ensuring the basic characteristics of the components, not for the stable soldering conditions. Conditions for proper soldering should be set up according to individual conditions. The temperature of this product at the time of mounting changes depending on mounting conditions, therefore, please confirm that Product surface becomes the specified temperature when mounting it on the end product.

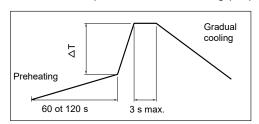
#### 5.3 Hand soldering

Hand soldering typically causes significant temperature change, which may induce excessive thermal stresses inside the Varistors, resulting in the thermal cracks, etc. In order to prevent any defects, the following should be observed.

- · Control the temperature of the soldering tips with special care.
- · Avoid the direct contact of soldering tips with the Varistors and/or terminal electrodes.
- · Do not reuse dismounted Varistors.
- (1) Condition 1 (with preheating)
  - (a) Soldering : Use thread solder (ø1.0 mm or below) which contains flux with low chlorine, developed for precision electronic equipment.
  - (b) Preheating : Conduct sufficient preheating, and make sure that the temperature difference between solder and Varistors' surface is 150 °C or less.
  - (c) Temperature of Iron tip: 350 °C max.

    (The required amount of solder shall be melted in advance on the soldering tip.)
  - (d) Gradual cooling: After soldering, the Varistors shall be cooled gradually at room temperature.

#### Recommended profile of Hand soldering (Ex.)



 $\Delta T$ : Allowable temperature difference  $\Delta T \le 150$  °C

# (2) Condition 2 (without preheating) Hand soldering can be performed without preheating,

by following the conditions below:

- (a) Soldering iron tip shall never directly touch the ceramic and terminal electrodes of the Varistors.
- (b) The lands are sufficiently preheated with a soldering iron tip before sliding the soldering iron tip to the terminal electrodes of the Varistors for soldering.

#### Conditions of hand soldering without preheating

| Item                                 | Condition   |
|--------------------------------------|-------------|
| Temperature of Iron tip              | 270 °C max. |
| Wattage                              | 20 W max.   |
| Shape of Iron tip                    | ø3 mm max.  |
| Soldering time with a soldering iron | 3 s max.    |



#### 6. Post soldering cleaning

#### 6.1 Cleaning solvent

Soldering flux residue may remain on the PC board if cleaned with an inappropriate solvent.

This may deteriorate the performance of Varistors, especially insulation resistance.

#### 6.2 Cleaning conditions

Inappropriate cleaning conditions such as insufficient cleaning or excessive cleaning may impair the electrical characteristics and reliability of the Varistors.

- (1) Insufficient cleaning can lead to:
  - (a) The halogen substance found in the residue of the soldering flux may cause the metal of terminal electrodes to corrode
  - (b) The halogen substance found in the residue of the soldering flux on the surface of the Varistors may change resistance values.
  - (c) Water-soluble soldering flux may have more remarkable tendencies of (a) and (b) above compared to those of rosin soldering flux.
- (2) Excessive cleaning can lead to:
  - (a) When using ultrasonic cleaner, make sure that the output is not too large, so that the substrate will not resonate. The resonation causes the cracks in Varistors and/or solders, and deteriorates the strength of the terminal electrodes. Please follow these conditions for Ultrasonic cleaning:

Ultrasonic wave output : 20 W/L max.
Ultrasonic wave frequency : 40 kHz max.
Ultrasonic wave cleaning time : 5 min. max.

#### 6.3 Contamination of cleaning solvent

Cleaning with contaminated cleaning solvent may cause the same results as that of insufficient cleaning due to the high density of liberated halogen.

#### 7. Inspection process

The pressure from measuring terminal pins might bend the PCB when implementing circuit inspection after mounting Varistors on PCB, and as a result, cracking may occur.

- (1) Mounted PC boards shall be supported by an adequate number of supporting pins on the back with bend settings of 90 mm span 0.5 mm max.
- (2) Confirm that the measuring pins have the right tip shape, are equal in height, have the right pressure and are set in the correct positions. The following figures are for your reference to avoid bending the PC board.

| Item                   | Prohibited mounting | Recommended mounting |
|------------------------|---------------------|----------------------|
|                        | Check pin           | Check pin            |
| Bending of<br>PC board | Separated, Crack    | Supporting pin       |

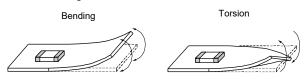
#### 8. Protective coating

Make sure characteristics and reliability when using the resin coating or resin embedding for the purpose of improvement of humidity resistance or gas resistance, or fixing of parts because failures of a thermistors such as 1).2) and 3) may be occurred.

- (1) The solvent which contained in the resin permeate into the Varistors, and it may deteriorate the characteristic.
- (2) When hardening the resin, chemical reaction heat (curing heat generation) happen and it may occurs the infection to the Varistors.
- (3) The lead wire might be cut down and the soldering crack might be happen by expansion or contraction of resin hardening.

#### 9. Dividing / Breaking of PC boards

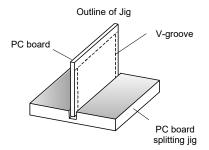
(1) Please be careful not to stress the substrate with bending/twisting when dividing, after mounting components including Varistors. Abnormal and excessive mechanical stress such as bending or torsion shown below can cause cracking in the Varistors.

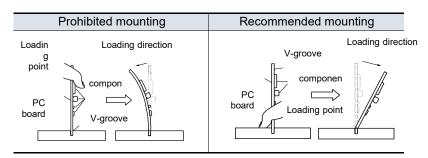


(2) Dividing/Breaking of the PC boards shall be done carefully at moderate speed by using a jig or apparatus to prevent the Varistors on the boards from mechanical damage.



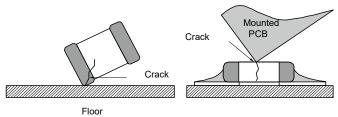
(3) Examples of PCB dividing/breaking jigs: The outline of PC board breaking jig is shown below. When PC board are broken or divided, loading points should be close to the jig to minimize the extent of the bending. Also, planes with no parts mounted on should be used as plane of loading, in order to prevent tensile stress induced by the bending, which may cause cracks of the Varistors or other parts mounted on the PC boards.





#### 10. Mechanical Impact

- (1) The Varistors shall be free from any excessive mechanical impact. The Varistor body is made of ceramics and may be damaged or cracked if dropped. Never use a Varistor which has been dropped; their quality may already be impaired, and in that case, failure rate will increase.
- (2) When handling PC boards with Varistors mounted on them, do not allow the Varistors to collide with another PC board. When mounted PC boards are handled or stored in a stacked state, the corner of a PC board might strike Varistors, and the impact of the strike may cause damage or cracking and can deteriorate the withstand voltage and insulation resistance of the Varistor.



11. Do not reuse this product after removal from the mounting board.

# Precautions for discarding

As to the disposal of the Varisrors, check the method of disposal in each country or region where the modules are incorporated in your products to be used.

#### Other

The various precautions described above are typical. For special mounting conditions, please contact us.

## Applicable laws and regulations, others

- 1. This product not been manufactured with any ozone depleting chemical controlled under the Montreal Protocol.
- 2. This product comply with RoHS(Restriction of the use of certain Hazardous Substance in electrical and electronic equipment) (DIRECTIVE 2011/65/EU and 2015/863/EU).
- 3. All the materials used in this part are registered material under the Law Concerning the Examination and Regulation of Manufacture, etc. of Chemical Substance.
- 4. If you need the notice by letter of "A preliminary judgement on the Laws of Japan foreign exchange and Foreign Trade Control", be sure to let us know.
- 5. These products are not dangerous goods on the transportation as identified by UN (United nations) numbers or UN classification.
- 6. The technical information in this catalog provides example of our products' typical operations and application circuit. We do not guarantee the non-infringement of third party's intellectual property rights and we do not grant any license, Right or interest in our intellectual property.

# **Panasonic**

**INDUSTRY** 

# **Multilayer Varistor**

For ESD pulse

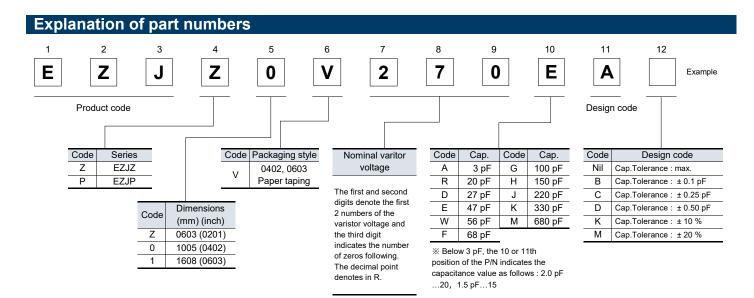
[DC voltage lines/High speed signal lines]

**EZJZ**, **EZJP** series

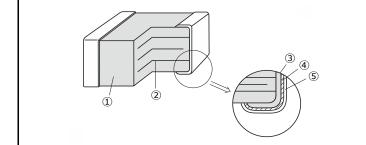


## **Features**

- Excellent ESD suppression due to original advanced material technology
- Having large electrostatic resistance meeting IEC61000-4-2, Level 4 standard
- Having no polarity (bipolar) facilitated replacing Zener Diodes. Capable of replacing 2 Zener Diodes and 1 Capacitor.
- Lead-free plating terminal electrodes enabling great solderability
- Wide range of products is available by adopting multilayer structure, meeting various needs
- Low capacitance versions for DC voltage lines of high speed busses
- Ultra low capacitance for high speed signal line
- Applicable to high-speed signal lines, such as interfaces (e.g. USB2.0, IEEE1394, HDMI, and so on), due to our
  original ultra-low capacitance technology.
- RoHS compliant

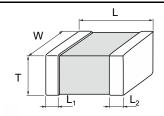


## Construction



| No. | Name                    |                        |  |  |  |
|-----|-------------------------|------------------------|--|--|--|
| 1   | Semiconductive ceramics |                        |  |  |  |
| 2   | Internal                | Internal electrode     |  |  |  |
| 3   |                         | Substrate electrode    |  |  |  |
| 4   | Terminal electrode      | Intermediate electrode |  |  |  |
| (5) |                         | External electrode     |  |  |  |

## **Dimensions in mm (not to scale)**



|           |             |             |                 |                 | Oliit . Iliili                  |
|-----------|-------------|-------------|-----------------|-----------------|---------------------------------|
| Size code | Size (inch) | L           | W               | T               | L <sub>1</sub> , L <sub>2</sub> |
| Z         | 0201        | 0.60 ± 0.03 | $0.30 \pm 0.03$ | $0.30 \pm 0.03$ | 0.15 ± 0.05                     |
| 0         | 0402        | 1.00 ± 0.05 | 0.50 ± 0.05     | 0.50 ± 0.05     | 0.2 ± 0.1                       |
| 1         | 0603        | 1.6 ± 0.1   | 0.8 ± 0.1       | 0.8 ± 0.1       | $0.3 \pm 0.2$                   |



# **Multilayer Varistor**

# Low capacitance type [High speed signal lines]

# **Features**

- Applicable to high-speed signal lines, such as interfaces (e.g. USB 2.0, IEEE1394, HDMI, and so on), due to our original material technology and multilayer technology.
- Capacitance: 0.8 to 2.1 pF typ.

# **Recommended applications**

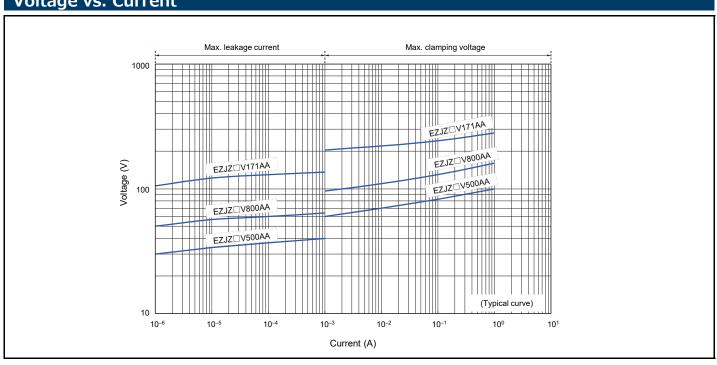
| Mobile phone | Antenna circuit, External IF  |
|--------------|-------------------------------|
| DSC,DVC      | USB2.0, IEEE1394              |
| PC,PDA       | USB2.0, IEEE1394, LAN1000BASE |
| TV,DVD       | USB2.0, IEEE1394, HDMI        |
| Game console | Controller, External IF       |

# Ratings and characteristics

| Size(inch) | Part No.     | Maximum<br>allowable voltage<br>DC (V) | Nominal varistor<br>voltage<br>at 1 mA (V) | Capacitance<br>at 1 MHz<br>(pF) | Maximum ESD<br>IEC61000-4-2 |
|------------|--------------|--|--|---------------------------------|-----------------------------|
|            | EZJZ0V80010  | 10                                     | 80   | 1 max. [0.8 typ.]               |                             |
|            | EZJZ0V80015D | 5                                      | 80   | 1.5±0.5                         |                             |
| 0402       | EZJZ0V500AA  | 5                                      | 50   | 3 max. [2.1 typ.]               |                             |
|            | EZJZ0V800AA  | 18                                     | 80   | 3 max. [2.1 typ.]               | Contact discharge           |
|            | EZJZ0V171AA  | 18                                     | 170  | 3 max. [2.1 typ.]               | : 8 kV                      |
|            | EZJZ1V80010  | 10                                     | 80   | 1 max. [0.8 typ.]               | . O KV                      |
| 0603       | EZJZ1V500AA  | 5                                      | 50   | 3 max. [2.1 typ.]               |                             |
|            | EZJZ1V800AA  | 18                                     | 80   | 3 max. [2.1 typ.]               |                             |
|            | EZJZ1V171AA  | 18                                     | 170  | 3 max. [2.1 typ.]               |                             |

\* Recommend soldering method : Reflow soldering

# Voltage vs. Current

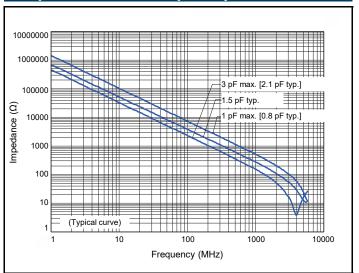


# Low capacitance type [High speed signal lines] / EZJZ, EZJP series

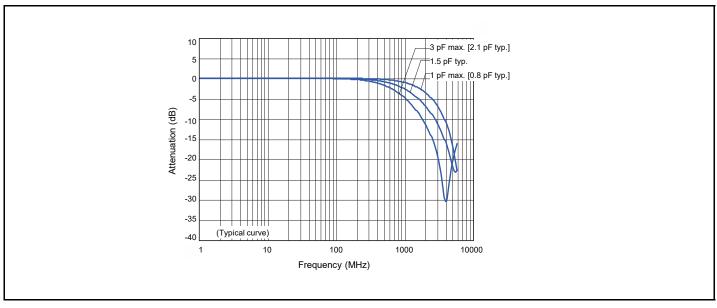
# Capacitance vs. Frequency

# 100 3 pF max. [2.1 pF typ.] 1.5 pF typ. 1 pF max. [0.8 pF typ.] 1 10 100 1000 10000 Frequency (MHz)

# Impedance vs. Frequency



# Attenuation vs. Frequency





# **Multilayer Varistor**

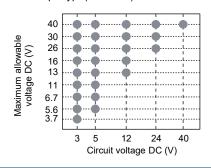
# Low voltage type (Standard type)

# [DC voltage lines/Low speed signal lines]

# **Features**

Wide variety of products is available by adopting multilayer construction, which achieved wide range of usage, such as application to DC voltage lines and signal lines.

Varistor voltage: 6.8 to 65 V (at 1 mA)
Capacitance: 8.5 to 420 pF typ. (at 1 MHz)



| Recommended Applications |  |  |  |
|--------------------------|--|--|--|
| Mobile phone             | SW, LCD, LED, Audio terminal,          |  |  |
|                          | Battery pack, Memory card, External IF |  |  |
| DSC,DVC                  | SW, LCD, LED, USB                      |  |  |
| PC,PDA                   | SW, LCD, LED, USB                      |  |  |
| TV,DVD                   | Audio, Video terminal                  |  |  |
| Audio                    | Audio terminal, Microphone, Receiver   |  |  |
| Game console             | Controller, External IF                |  |  |

|        | Part No.         | Maximum   |                          |                     |           | Maximum      |             |
|--------|------------------|-----------|--------------------------|---------------------|-----------|--------------|-------------|
| Size   |                  | allowable | Nominal varistor voltage | Capacitance         | (pF)      | peak current | Maximum ESD |
| (inch) | Fait No.         | voltage   | at 1 mA (V)              |                     |           | at 8/20 μs,  | IEC61000-   |
|        |                  | DC (V)    | ` '                      | at 1 MHz            | at 1 kHz  | 2 times (A)  |             |
|        | EZJPZV6R8JA      | 3.7       | 6.8                      | 220 max. [150 typ.] | 175 typ.  | 5            | 1           |
| j      | EZJPZV6R8GA      | 3.7       | 6.8                      | 100 max. [85 typ.]  | 100 typ.  | 5            |             |
| ĺ      | EZJPZV080GA      | 5.6       | 8                        | 100 max. [85 typ.]  | 100 typ.  | 5            |             |
|        | EZJPZV120GA      | 7.5       | 12                       | 100 max. [85 typ.]  | 100 typ.  | 5            |             |
| 0201   | EZJPZV120DA      | 7.5       | 12                       | 27 max. [22 typ.]   | 33 typ.   | 1            |             |
| ĺ      | EZJPZV120RA      | 7.5       | 12                       | 20 max. [15 typ.]   | 18 typ.   | 1            |             |
| ĺ      | EZJPZV150RA      | 9         | 15                       | 20 max. [15 typ.]   | 18 typ.   | 1            | ]           |
| ĺ      | EZJPZV270RA      | 16        | 27                       | 20 max. [15 typ.]   | 16.5 typ. | 1            | ]           |
|        | EZJPZV270BA      | 16        | 27                       | 10 max. [8.5 typ.]  | 10 typ.   | 1            |             |
|        | EZJP0V6R8MA      | 3.7       | 6.8                      | 680 max. [420 typ.] | 650 typ.  | 20           |             |
|        | EZJP0V6R8GA      | 3.7       | 6.8                      | 100 max. [85 typ.]  | 100 typ.  | 3            |             |
|        | EZJP0V080MA      | 5.6       | 8                        | 680 max. [420 typ.] | 650 typ.  | 20           |             |
|        | EZJP0V080KA      | 5.6       | 8                        | 330 max. [290 typ.] | 480 typ.  | 15           |             |
|        | EZJP0V080GA      | 5.6       | 8                        | 100 max. [65 typ.]  | 100 typ.  | 3            |             |
| ĺ      | EZJP0V080DA      | 5.6       | 8                        | 27 max. [22 typ.]   | 33 typ.   | 1            | Contact     |
| 0402   | EZJP0V120JA      | 6.7       | 12                       | 220 max. [150 typ.] | 175 typ.  | 10           | discharg    |
| ĺ      | EZJZ0V180HA      | 11        | 18                       | 150 max. [120 typ.] | 140 typ.  | 10           | :8 kV       |
| ĺ      | EZJZ0V220HA      | 13        | 22                       | 150 max. [100 typ.] | 116 typ.  | 10           | 1           |
| j      | EZJP0V270EA      | 16        | 27                       | 47 max. [33 typ.]   | 37 typ.   | 4            | 1           |
| ĺ      | EZJP0V270RA      | 16        | 27                       | 20 max. [15 typ.]   | 16.5 typ. | 1            | 1           |
| ĺ      | EZJZ0V420WA      | 30        | 42                       | 56 max. [40 typ.]   | 45 typ.   | 10           | 1           |
| j      | EZJZ0V650DA      | 40        | 65                       | 27 max. [22 typ.]   | 33 typ.   | 5            | 1           |
|        | EZJP1V120KA      | 6.7       | 12                       | 330 max. [250 typ.] | 290 typ.  | 20           | 1           |
| j      | EZJZ1V180JA      | 11        | 18                       | 220 max. [180 typ.] | 210 typ.  | 20           | 1           |
| ĺ      | EZJZ1V220JA      | 13        | 22                       | 220 max. [160 typ.] | 185 typ.  | 20           | 1           |
| j      | EZJZ1V270GA      | 16        | 27                       | 100 max. [85 typ.]  | 100 typ.  | 20           | 1           |
| 0603   | EZJZ1V270EA      | 16        | 27                       | 47 max. [33 typ.]   | 37 typ.   | 20           | 1           |
| ĺ      | EZJZ1V270RA      | 16        | 27                       | 20 max. [15 typ.]   | 16.5 typ. | 3            | 1           |
|        | EZJZ1V330GA      | 26        | 33                       | 100 max. [85 typ.]  | 100 typ.  | 20           | 1           |
| ĺ      | EZJZ1V420FA      | 30        | 42                       | 68 max. [55 typ.]   | 63 typ.   | 15           | 1           |
|        | == 1= () (0=0= ( |           |                          | . ,, ,              |           | _            | 1           |

 $\bullet$  Operating Temperature Range : -40 to 85  $^{\circ}\!\mathbb{C}$ 

EZJZ1V650DA

\* Recommend soldering method : Reflow soldering

27 max. [22 typ.]

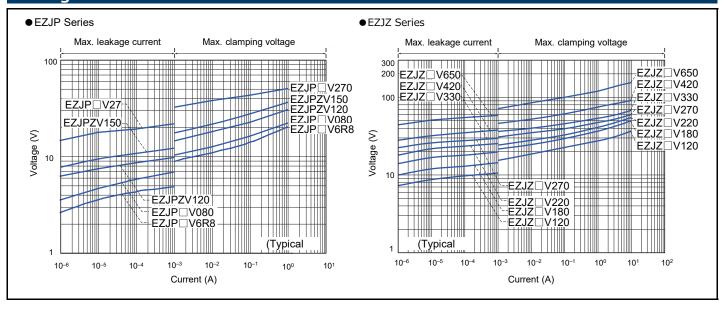
33 typ.

| Maximum allowable voltage | Maximum DC Voltage that can be applied continuously within the operating temperature range                                   |
|---------------------------|--|
| Varistor voltage          | Varistor starting voltage between terminals at DC 1 mA, also known as Breakdown voltage                                      |
| Maximum peak current      | Maximum current that can be withstood under the standard pulse 8/20 μs, 2 times based  |
| Maximum ESD               | Maximum voltage that can be withstood under ESD based on IEC61000-4-2, 10 times (5 times of each positive-negative polarity) |

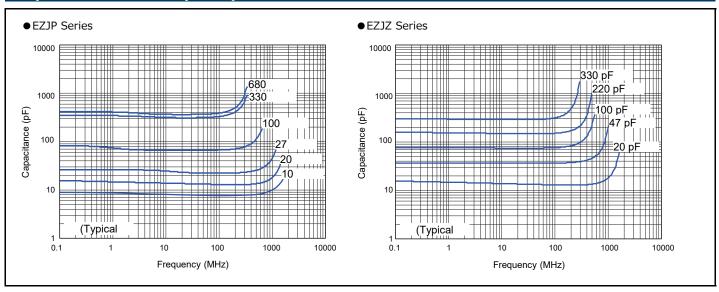
65

# Low voltage type (Standard type) [DC voltage lines/Low speed signal lines] / EZJZ, EZJP series

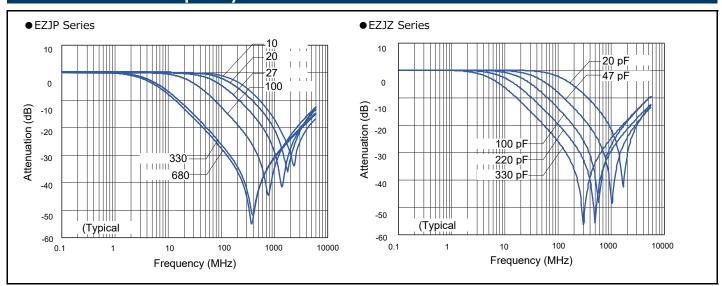
# Voltage vs. Current



# Capacitance vs. Frequency



# **Attenuation vs. Frequency**



#### ■ As for packaging methods, handling precautions please see data files

# **Panasonic**

**INDUSTRY** 

# **Multilayer Varistor**

# For ESD pulse [DC voltage lines]

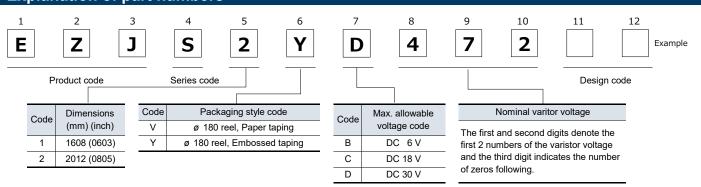
# **EZJS** series



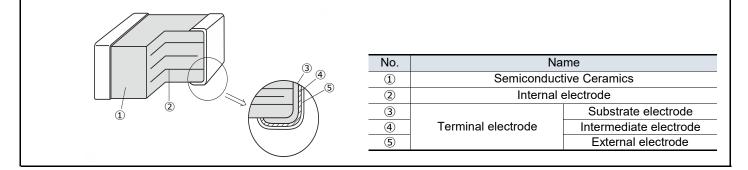
#### **Features**

- Excellent ESD suppression due to original advanced material technology
- Having large electrostatic resistance meeting IEC61000-4-2, Special Level 30 kV standard
- Having no polarity (bipolar) facilitated replacing Zener Diodes. Capable of replacing 2 Zener Diodes and 1 Capacitor.
- Lead-free plating terminal electrodes enabling great solderability
- RoHS compliant

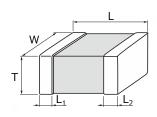
# **Explanation of part numbers**



#### Construction



## **Dimensions in mm (not to scale)**



|           |             |             |             |               | Unit : mm                       |
|-----------|-------------|-------------|-------------|---------------|---------------------------------|
| Size code | Size (inch) | L           | W           | Т             | L <sub>1</sub> , L <sub>2</sub> |
| 1         | 0603        | 1.60 ± 0.15 | 0.8 ± 0.1   | $0.8 \pm 0.1$ | $0.3 \pm 0.2$                   |
| 2         | 0805        | 2.0 ± 0.2   | 1.25 ± 0.20 | 0.8 ± 0.2     | 0.50 ± 0.25                     |
| _         | 0000        | 2.0 ± 0.2   | 1.20 ± 0.20 | 1.25 ± 0.20   | 0.00 ± 0.20                     |

# For ESD pulse [DC voltage lines] / EZJS series

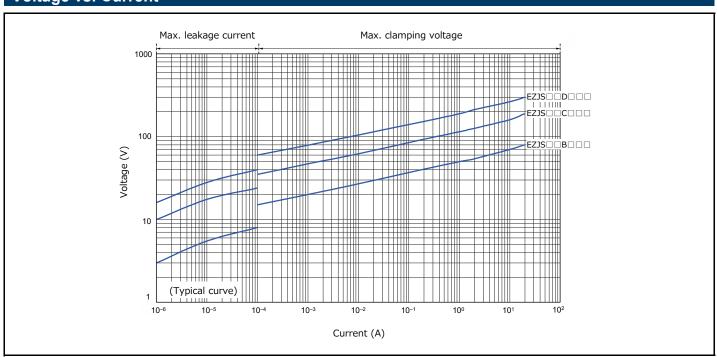
# **Ratings and Characteristics**

| Size (inch) | Part No.   | Maximum<br>allowable voltage<br>DC (V) | Nominal varistor<br>voltage<br>at 0.1 mA (V) | Capacitance<br>at 1 kHz<br>(pF) | Maximum ESD<br>IEC61000-4-2 |
|-------------|------------|--|--|---------------------------------|-----------------------------|
|             | EZJS1VB822 | 6                                      | 12   | 8200 typ.                       |                             |
| 0603        | EZJS1VC392 | 18                                     | 30   | 3900 typ.                       |                             |
|             | EZJS1VD182 | 30                                     | 50   | 1800 typ.                       | Contact discharge :         |
|             | EZJS2VB223 | 6                                      | 12   | 22000 typ.                      | 30 kV                       |
| 0805        | EZJS2YC822 | 18                                     | 30   | 8200 typ.                       |                             |
|             | EZJS2YD472 | 30                                     | 50   | 4700 typ.                       |                             |

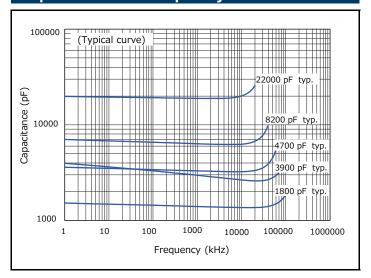
ullet Operating Temperature Range : -40 to 85  $^{\circ}$ C

\* Avoid flow soldering.

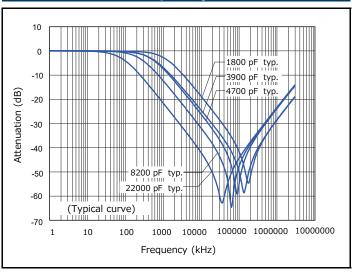
# Voltage vs. Current



## Capacitance vs. Frequency



## **Attenuation vs. Frequency**

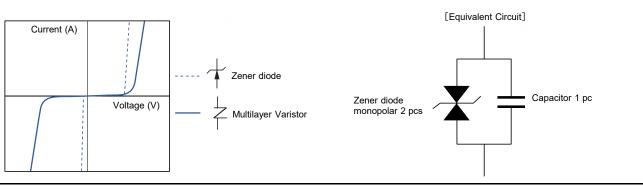


■As for packaging methods, handling precautions please see data files

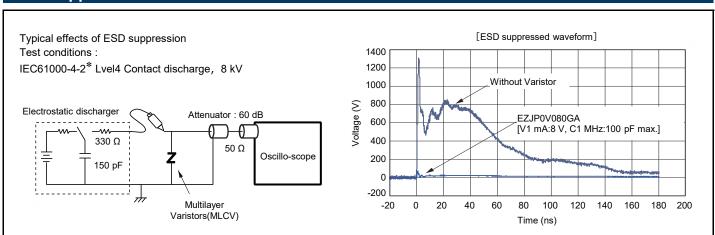
# Multilayer Varistors EZJZ, EZJP, EZJS series / Characteristics

# Varistor characteristics and equivalent circuit

A Multilayer Varistor does not have an electrical polarity like zener diodes and is equivalent to total 3 pcs of 2 zener diodes and 1 capacitor.



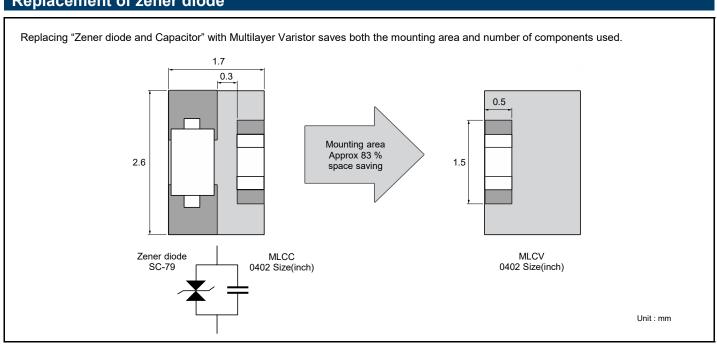
# **ESD Suppressive effects**



International Standard of the ESD testing method (HBM) for electronic equipment ability to \*IEC61000-4-2 ... withstand ESD generated from a human body. It sets 4 levels of severity

| Severity          | Level 1 | Level 2 | Level 3 | Level 4 |
|-------------------|---------|---------|---------|---------|
| Contact discharge | 2 kV    | 4 kV    | 6 kV    | 8 kV    |
| Air discharge     | 2 kV    | 4 kV    | 8 kV    | 15 kV   |

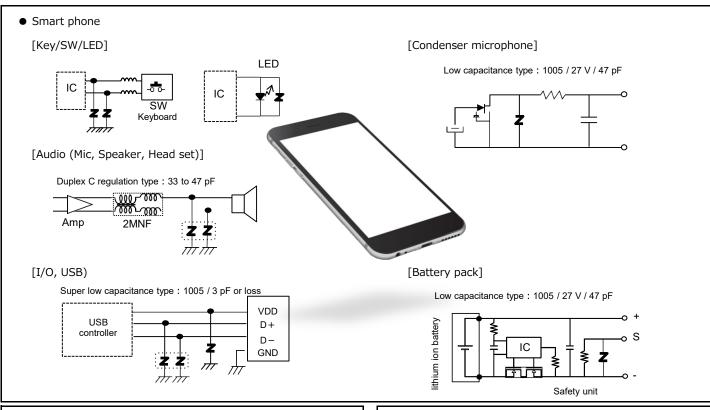
# Replacement of zener diode

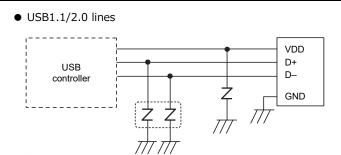


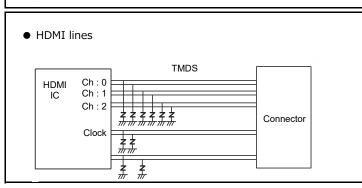
## Multilayer Varistors EZJZ, EZJP, EZJS series / Applications

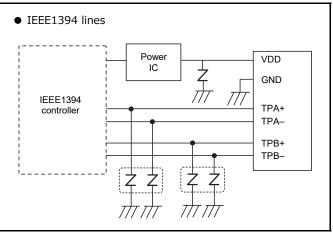
#### **Recommended applications** Circuit **Applications** Series DC 1M 1G (Hz) DC to GHz Ultra low capacitance Antenna, RF circuit, LVDS, Mobile phones, DSC, PC, PDA, (Cap.: 3 pF or less) USB, IEEE1394, HDMI etc. HDD TV(PDP, LC etc.), DVD, EZJZ, EZJP DC to tens of Hz Low capacitance PWR, SW, Audio terminals Game consoles, Audio equipment (Cap.: 20 to 680 pF) LCD, RS232C, etc. DC to several kHz PWR, Photoelectronic sensors, High capacitance **EZJS** PWR, SW, SSR, Motors, Pressure sensors, (Cap.: 1800 to 22000 pF) Proximity switches Audio terminals, etc.

#### **Applications**









# Multilayer Varistors EZJZ, EZJP, EZJS series / Performance and testing

# Performance and testing methods

| Characteristics                            | Specifications              | Testing method  |  |  |  |  |  |  |  |  |
|--|-----------------------------|---|--|--|--|--|--|--|--|--|
| Standard test conditions                   |                             | Electrical characteristics shall be measured under the following conditions. Temp. : 5 to 35 $^{\circ}$ C, Relative humidity : 85 $^{\circ}$ 6 or less  |  |  |  |  |  |  |  |  |
| Varistor voltage                           | To meet the specified value | The Varistor voltage is the voltage $(V_C, \text{or } V_{cmA})$ between both end terminals of a Varistor when specified current (CmA) is applied to it. The measurement shall be made as quickly as possible to avoid heating effects.  |  |  |  |  |  |  |  |  |
| Maximum<br>allowable voltage               | To meet the specified value | The maximum DC voltage that can be applied continuously to a varistor.  |  |  |  |  |  |  |  |  |
| Capacitance                                | To meet the specified value | Capacitance shall be measured at the specified frequency, bias voltage 0 V, and measuring voltage 0.2 to 2.0 Vrms   |  |  |  |  |  |  |  |  |
| Maximum peak<br>current                    | To meet the specified value | The maximum current measured (Varistor voltage tolerance is within $\pm 10$ %) when a standard mpulse current of 8/20 $\mu$ seconds is applied twice with an interval of 5 minutes.   |  |  |  |  |  |  |  |  |
| Maximum ESD                                | To meet the specified value | The maximum ESD measured (while the varistor voltage is within ±30 % of its nominal value) when exposed to ESD 10 times (five times for each positive-negative polarity) based on IEC61000-4-2.   |  |  |  |  |  |  |  |  |
| Solder ability                             | To meet the specified value | The part shall be immersed into a soldering bath under the conditions below. Solder: Sn-3.0Ag-0.5Cu Soldering flux: Ethanol solution of rosin (Concentration approx. 25 wt%) Soldering temp.: $230 \pm 5$ °C Period: $4 \pm 1$ s Soldering position: Immerse both terminal electrodes until they are completely into the soldering  |  |  |  |  |  |  |  |  |
| Resistance to soldering heat               | ΔVc/Vc :<br>within ±10 %    | bath.  After the immersion, leave the part for 24 ±2 hours under the standard condition, then evaluate its characteristics. Soldering conditions are specified below:  Soldering conditions: 270 ℃, 3 s / 260 ℃, 10 s  Soldering position: Immerse both terminal electrodes until they are completely into the soldering bath.  After repeating the cycles stated below for specified number of times, leave the part for 24±2 hours. |  |  |  |  |  |  |  |  |
| Temperature<br>cycling                     | ΔVc/Vc :<br>within ±10 %    | Cycle : 5 cyclesStepTemperaturePeriod1Max. Operating Temp.30±3 min2Ordinary temp.3 min max.3Min. Operating Temp.30±3 min4Ordinary temp.3 min max.   |  |  |  |  |  |  |  |  |
| Biased humidity                            | ΔVc/Vc :<br>within ±10 %    | After conducting the test under the conditions specified below, leave the part 24±2 hours, then evaluate its characteristics.  Temp.: 40 ± 2 °C  Humidity: 90 to 95 %RH  Applied voltage: Maximum allowable voltage (Individually specified)  Period: 500+24/0 h  |  |  |  |  |  |  |  |  |
| High temperature<br>exposure<br>(dry heat) | ΔVc/Vc :<br>within ±10 %    | After conducting the test under the conditions specified below, leave the part 24±2 hours, then evaluate its characteristics.  Temp.: Maximum operating temperature ±3 °C (Individually specified)  Applied voltage: Maximum allowable voltage (Individually specified)  Period: 500+24/0 h   |  |  |  |  |  |  |  |  |

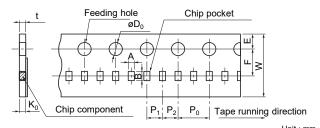
# Multilayer Varistors EZJZ, EZJP, EZJS series / Packaging

# **Packaging methods (Taping)**

#### Standard quantity

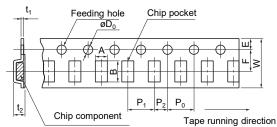
| Series     | Size code<br>(inch size) | Thickness<br>(mm) | Kind of taping          | Pitch<br>(mm) | Quantity<br>(pcs/reel) |
|------------|--------------------------|-------------------|-------------------------|---------------|------------------------|
|            | Z(0201)                  | 0.3               | Pressed carrier taping  | 2             | 15000                  |
| EZJZ, EZJP | 0(0402)                  | 0.5               |                         | 2             | 10000                  |
|            | 1(0603)                  | 0.8               | Punched carrier taping  | 4             | 4000                   |
|            | 1(0603)                  | 0.8               | Functied carrier taping |               | 4000                   |
| EZJS       | 2(0805)                  | 0.8               |                         | 4             | 5000                   |
|            | 2(0003)                  | 1.25              | Embossed carrier taping |               | 2000                   |

#### • 2 mm Pitch (Pressed carrier taping) Size 0201



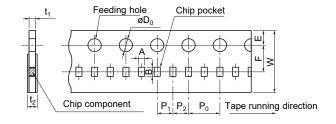
|              |               |               |             |               |               |                |                |                |                  | 0.          |                |
|--------------|---------------|---------------|-------------|---------------|---------------|----------------|----------------|----------------|------------------|-------------|----------------|
| Code         | Α             | В             | W           | F             | Е             | P <sub>1</sub> | P <sub>2</sub> | P <sub>0</sub> | øD <sub>0</sub>  | t           | K <sub>0</sub> |
| EZJZ<br>EZJP | 0.36<br>±0.03 | 0.66<br>±0.03 | 8.0<br>±0.2 | 3.50<br>±0.05 | 1.75<br>±0.10 | 2.00<br>±0.05  | 2.00<br>±0.05  | 4.0<br>±0.1    | 1.5<br>+0.1<br>0 | 0.55<br>max | 0.36<br>±0.03  |

#### • 4 mm pitch (Embossed carrier taping) Size 0805



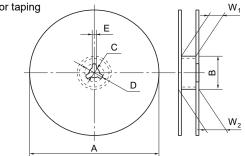
Unit : mm  $\phi D_0$ Code Α В W F Ε  $P_0$  $t_1$  $t_2$ 1.5 1.55 ±0.20 8.0 ±0.2 1.75 ±0.10 2.00 ±0.05 2.35 3.50 0.6 1.5 EZJS ±0.20 ±0.05 max

#### • 2 mm Pitch (Punched carrier taping) Size 0402



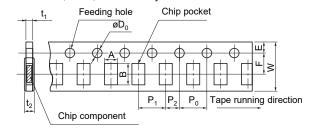
|                      |               |               |             |               |               |                |                |                |                  | Uı             | nit : mm       |
|----------------------|---------------|---------------|-------------|---------------|---------------|----------------|----------------|----------------|------------------|----------------|----------------|
| Code                 | Α             | В             | W           | F             | Е             | P <sub>1</sub> | P <sub>2</sub> | P <sub>0</sub> | øD <sub>0</sub>  | t <sub>1</sub> | t <sub>2</sub> |
| EZJZ<br>EZJP<br>EZJS | 0.62<br>±0.05 | 1.12<br>±0.05 | 8.0<br>±0.2 | 3.50<br>±0.05 | 1.75<br>±0.10 | 2.00<br>±0.05  | 2.00<br>±0.05  | 4.0<br>±0.1    | 1.5<br>+0.1<br>0 | 0.7<br>max     | 1.0<br>max     |

Reel for taping



|                      |                    | T'                    |                      | - 1                  | Unit : mm           |                |                      |
|----------------------|--------------------|-----------------------|----------------------|----------------------|---------------------|----------------|----------------------|
| Code                 | Α                  | В                     | С                    | D                    | E                   | W <sub>1</sub> | W <sub>2</sub>       |
| EZJZ<br>EZJP<br>EZJS | ø180 <sub>-3</sub> | ø60.0 <sup>+1.0</sup> | 13.0 <sub>±0.5</sub> | 21.0 <sub>±0.8</sub> | 2.0 <sub>±0.5</sub> | 9.0 +1.0       | 11.4 <sub>±1.0</sub> |

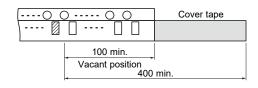
#### ● 4 mm Pitch (Punched carrier taping) Size 0603, 0805, 0504/2 Array



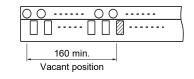
| Size code<br>(insh size) | Α             | В             | W           | F             | E             | P <sub>1</sub> | P <sub>2</sub> | P <sub>0</sub> | øD <sub>0</sub>  | t <sub>1</sub> | t <sub>2</sub> |
|--------------------------|---------------|---------------|-------------|---------------|---------------|----------------|----------------|----------------|------------------|----------------|----------------|
| 1<br>(0603)              | 1.0<br>±0.1   | 1.8<br>±0.1   |             |               |               |                |                |                |                  |                |                |
| S<br>(0504 2 Array)      | 1.18<br>±0.10 | 1.63<br>±0.10 | 8.0<br>±0.2 | 3.50<br>±0.05 | 1.75<br>±0.10 | 4.0<br>±0.1    | 2.00<br>±0.05  | 4.0<br>±0.1    | 1.5<br>+0.1<br>0 | 1.1<br>max     | 1.4<br>max     |
| 2<br>(0805)              | 1.65<br>±0.20 | 2.4<br>±0.2   |             |               |               |                |                |                |                  |                |                |

# Leader part and taped end

Leader part



Tape end



Unit : mm

Unit : mm

# **Safty Precautions**

When using our products, no matter what sort of equipment they might be used for, be sure to confirm the applications and environmental conditions with our specifications in advance.



Panasonic Industry Co., Ltd. Device Solutions Business Division

1006 Kadoma, Kadoma City, Osaka 571-8506 Japan